

OUTCOME BASED EDUCATION WITH CHOICE BASED CREDIT SYSTEM

MASTER OF TECHNOLOGY CAD / CAM

ACADEMIC REGULATIONS, COURSE STRUCTURE AND SYLLABI UNDER AUTONOMOUS STATUS

M. Tech Regular Two Year Degree Program (for the batches admitted from the academic year 2016 - 17)

FAILURE TO READ AND UNDERSTAND THE REGULATIONS IS NOT AN EXCUSE

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"Take up one idea.

Make that one idea you're life-think of it, dream of it, and live on that idea. Let the brain muscles, nerves, every part of your body be full of that idea and just leave every other idea alone. **This is the way to success'' Swami Vivekananda**

PRELIMINARY DEFINITIONS AND NOMENCLATURES

Academic Council: The Academic Council is the highest academic body of the institute and is responsible for the maintenance of standards of instruction, education and examination within the institute. Academic Council is an authority as per UGC regulations and it has the right to take decisions on all academic matters including academic research.

Academic Autonomy: Means freedom to an institute in all aspects of conducting its academic programs, granted by UGC for Promoting Excellence.

Academic Year : It is the period necessary to complete an actual course of study within a year. It comprises two consecutive semesters i.e., Even and Odd semester.

AICTE: Means All India Council for Technical Education, New Delhi.

Autonomous Institute: Means an institute designated as autonomous by University Grants Commission (UGC), New Delhi in concurrence with affiliating University (Jawaharlal Nehru Technological University, Hyderabad) and State Government.

Backlog Course: A course is considered to be a backlog course if the student has obtained a failure grade (F) in that course.

Basic Sciences: The courses offered in the areas of Mathematics, Physics, Chemistry, Biology etc., are considered to be foundational in nature.

Betterment: Betterment is a way that contributes towards improvement of the students' grade in any course(s). It can be done by either (a) re-appearing or (b) re-registering for the course.

Board of Studies (BOS): BOS is an authority as defined in UGC regulations, constituted by Head of the Organization for each of the departments separately. They are responsible for curriculum design and updation in respect of all the programs offered by a department.

Certificate course: It is a course that makes a student gain hands-on experience and skill required for holistic development in a specific area/field.

Choice Based Credit System: The credit based semester system is one which provides flexibility in designing curriculum and assigning credits based on the course content and hours of teaching along with provision of choice for the student in the course selection.

Compulsory course: Course required to be undertaken for the award of the degree as per the program.

Commission: Means University Grants Commission (UGC), New Delhi.

Continuous Internal Examination: It is an examination conducted towards internal assessment.

Course: A course is a subject offered by the University for learning in a particular semester.

Course Outcomes: The essential skills that need to be acquired by every student through a course.

Credit: A credit is a unit that gives weight to the value, level or time requirements of an academic course. The number of 'Contact Hours' in a week of a particular course determines its credit value. One credit is equivalent to one lecture hour per week.

Credit point: It is the product of grade point and number of credits for a course.

Cumulative Grade Point Aver age (CGPA): It is a measure of cumulative performance of a student over all the completed semesters. The CGPA is the ratio of total credit points secured by a student in various courses in all semesters and the sum of the total credits of all courses in all the semesters. It is expressed upto two decimal places.

Curriculum: Curriculum incorporates the planned interaction of students with instructional content, materials, resources and processes for evaluating the attainment of Program Educational Objectives.

Degree with Specialization: A student who fulfills all the program requirements of her/his discipline and successfully completes a specified set of professional elective courses in a specialized area is eligible to receive a degree with specialization like Structural Engineering, Embedded Systems, CSE, etc.

Department: An academic entity that conducts relevant curricular and co-curricular activities, involving both teaching and non-teaching staff and other resources in the process of study for a degree.

Detention in a course: Student who does not obtain minimum prescribed attendance in a course shall be detained in that particular course.

Dropping from the Semester: A student who doesn't want to register for any semester can apply in writing in prescribed format before commencement of that semester.

Elective Course: A course that can be chosen from a set of courses. An elective can be Professional Elective and/or Open Elective.

Evaluation: Evaluation is the process of judging the academic performance of the student in her/his courses. It is done through a combination of continuous internal assessment and semester end examinations.

Grade: It is an index of the performance of the students in a said course. Grades are indicated by alphabets.

Grade Point: It is a numerical weight allotted to each letter grade on a 10 point scale.

Institute: Means Institute of Aeronautical Engineering, Hyderabad unless indicated otherwise by the context.

Massive Open Online Course (MOOC): MOOC courses inculcate the habit of self learning. MOOC courses would be additional choices in all the elective group courses.

Pre-requisite: A course, the knowledge of which is required for registration into higher level course.

Core: The courses that are essential constituents of each engineering discipline are categorized as professional core courses for that discipline.

Professional Elective: A course that is discipline centric. An appropriate choice of minimum number of such electives as specified in the program will lead to a degree with specialization.

Program: Means, Master of Technology (M.Tech) degree program / UG degree program: B.Tech.

Program Educational Objectives: The broad career, professional and personal goals that every student will achieve through a strategic and sequential action plan.

Project work: It is a design or research based work to be taken up by a student during his/her second year to achieve a particular aim. It is a credit based course and is to be planned carefully by the student.

Re-Appearing: A student can reappear only in the semester end examination for the theory component of a course, subject to the regulations contained herein.

Registration: Process of enrolling into a set of courses in a semester of a Program.

Regulations: The regulations, common to all M.Tech programs offered by Institute are designated as "IARE-R16" and are binding on all the stakeholders.

Semester: It is a period of study consisting of 15 to 18 weeks of academic work equivalent to normally 90 working days. The odd semester starts usually in July and even semester in December.

Semester End Examinations: It is an examination conducted for all courses offered in a semester at the end of the semester.

S/he: Means "she" and "he" both.

Student Outcomes: The essential skill sets that need to be acquired by every student during her/his program of study. These skill sets are in the areas of employability, entrepreneurial, social and behavioral.

University: Means the Jawaharlal Nehru Technological University Hyderabad, Hyderabad.

Withdraw from a Course: Withdrawing from a course means that a student can drop from a course within the first two weeks of the odd or even semester (deadlines are different for summer sessions). However s/he can choose a substitute course in place of it by exercising the option within 5 working days from the date of withdrawal.

Words 'he', 'him', 'his', occur, they imply 'she', 'her', 'hers' also.

FOREWORD

The autonomy is conferred to Institute of Aeronautical Engineering (IARE), Hyderabad by University Grants Commission (UGC), New Delhi based on its performance as well as future commitment and competency to impart quality education. It is a mark of its ability to function independently in accordance with the set norms of the monitoring bodies like J N T University Hyderabad (JNTUH), Hyderabad and AICTE. It reflects the confidence of the affiliating University in the autonomous institution to uphold and maintain standards it expects to deliver on its own behalf and thus awards degrees on behalf of the college. Thus, an autonomous institution is given the freedom to have its own **curriculum, examination system** and **monitoring mechanism**, independent of the affiliating University but under its observance.

IARE is proud to win the credence of all the above bodies monitoring the quality in education and has gladly accepted the responsibility of sustaining, if not improving upon the standards and ethics for which it has been striving for more than a decade in reaching its present standing in the arena of contemporary technical education. As a follow up, statutory bodies like Academic Council and Boards of Studies are constituted with the guidance of the Governing Body of the institute and recommendations of the JNTUH to frame the regulations, course structure and syllabi under autonomous status.

The autonomous regulations, course structure and syllabi have been prepared after prolonged and detailed interaction with several expertise solicited from academics, industry and research, in accordance with the vision and mission of the institute to order to produce a quality engineering graduate to the society.

All the faculty, parents and students are requested to go through all the rules and regulations carefully. Any clarifications needed are to be sought at appropriate time and with principal of the college, without presumptions, to avoid unwanted subsequent inconveniences and embarrassments. The Cooperation of all the stake holders is sought for the successful implementation of the autonomous system in the larger interests of the college and brighter prospects of engineering graduates.

PRINCIPAL



ACADEMIC REGULATIONS

M. Tech. Regular Two Year Degree Program (for the batches admitted from the academic year 2016 - 17)

For pursuing two year postgraduate Master Degree program of study in Engineering (M.Tech) offered by Institute of Aeronautical Engineering under Autonomous status and herein after referred to as IARE.

1.0 CHOICE BASED CREDIT SYSTEM

The Indian Higher Education Institutions (HEI's) are changing from the conventional course structure to Choice Based Credit System (CBCS) along with introduction to semester system at first year itself. The semester system helps in accelerating the teaching learning process and enables vertical and horizontal mobility in learning.

The credit based semester system provides flexibility in designing curriculum and assigning credits based on the course content and hours of teaching. The choice based credit system provides a 'cafeteria' type approach in which the students can take courses of their choice, learn at their own pace, undergo additional courses and acquire more than the required credits and adopt an interdisciplinary approach to learning.

Choice Based Credit System (CBCS) is a flexible system of learning and provides choice for students to select from the prescribed elective courses. A course defines learning objectives and learning outcomes and comprises of lectures / tutorials / laboratory work / field work / project work / comprehensive examination / viva / seminars / assignments / presentations / self-study etc. or a combination of some of these.

Under the CBCS, the requirement for awarding a degree is prescribed in terms of number of credits to be completed by the students.

The CBCS permits students to:

- 1. Choose electives from a wide range of elective courses offered by the departments of theInstitute.
- 2. Undergo additional courses of interest.
- 3. Adopt an inter-disciplinary approach in learning.
- 4. Make the best use of expertise of the available faculty.

2.0 MEDIUM OF INSTRUCTION

The medium of instruction shall be English for all courses, examinations, seminar presentations and project work. The curriculum will comprise courses of study as given in course curriculum in accordance with the prescribed syllabi.

3.0 ELIGIBILITY FOR ADMISSION

The admissions for category A and B seats shall be as per the guidelines of Telangana State Councilfor Higher Education (TSCHE) in consonance with government reservation policy.

- a) Under Category A: 70% of the seats are filled based on GATE/PGECET ranks.
- b) Under Category B: 30% seats are filled on merit basis as per guidelines of TSCHE.

4.0 UNIQUE COURSE IDENTIFICATION CODE

Every specialization of the M.Tech programme will be placed in one of the seven groups as listed in the Table 1.

S. No	Specialization	Offering Department	Code
1	Structural Engineering	Civil Engineering	ST
2	Power Electronics and Electrical Drives	Electrical and Electronics Engineering	PE
3	CAD / CAM	Mechanical Engineering	CC
4	Embedded Systems	Electronics and Communication Engineering	ES
5	Computer Science and Engineering	Computer Science and Engineering	CS
6	Software Engineering	Information Technology	SE
7	Aerospace Engineering	Aeronautical Engineering	AE

	Table 1	l: Grou	up of (Courses
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5.0 TYPES OF COURSES

Courses in a programme may be of two kinds: Core and Elective.

Core Course:

There may be a core course in every semester. This is the course which is to be compulsorily studied by a student as a core requirement to complete the requirement of a programme in said discipline of study.

Elective Course:

Electives provide breadth of experience in respective branch and applications areas. Electivecourse is a course which can be chosen from a pool of courses. It may be:

- Supportive to the discipline of study
- Providing an expanded scope
- Enabling an exposure to some other discipline/domain
- Nurturing student's proficiency/skill.

An elective may be discipline centric (Professional Elective) focusing on those courses which add generic proficiency to the students or may be chosen from supportive/general discipline called as "Open Elective".

There shall be four professional elective groups out of which students can choose not more than two courses from each group. Overall, students can opt for four professional elective courses which suit their project work in consultation with the faculty advisor/mentor. In addition, one course from each of the two open electives has to be selected. A student may also opt for more elective courses in his/her area of interest.

6.0 SEMESTER STRUCTURE

The institute shall follow semester pattern. An academic year shall consist of a first semester and a second semester and the summer term. Each semester shall be of 23 weeks (Table 2) duration and this period includes time for course work, examination preparation and conduct of examinations. Each main semester shall have a minimum of 90 working days; out of which number of contact days for teaching / practical shall be 75 and 15 days shall be for examination preparation. The duration for each semester shall be a minimum of 17 weeks of instruction. The Academic Calendar is declared at the beginning of the academic year as given in Table 2.

	I Spell Instruction Period	9 weeks	
	I Mid Examinations 1 week		
FIRST SEMESTER	II Spell Instruction Period 8 weeks		21 weeks
(23 weeks)	II Mid Examinations	1 week	
	Preparation and Practical Examinations	2 weeks	
	Semester End Examinations		2 weeks
Semester Break and Supplementary Exams			2 weeks
	I Spell Instruction Period	9 weeks	
	I Mid Examinations	1 week	
SECOND SEMESTER	II Spell Instruction Period 8 weeks		21 weeks
(23 weeks)	II Mid Examinations 1 Week		
	Preparation & Practical Examinations 2 we		
	Semester End Examinations	2 weeks	
Summer Vacation			
THIRD SEMESTER Project Work Phase - I			18 weeks
FOURTH SEMESTER Project Work Phase - II			18 weeks

Table 2: Academic Calendar

7.0 PROGRAM DURATION

A student shall be declared eligible for the award of M.Tech degree, if s/he pursues a course of study and completes it successfully in not less than two academic years and not more than four academic years. A student, who fails to fulfill all the academic requirements for the award of the degree within four academic years from the year of his/her admission, shall forfeit his/her seat in M.Tech course.

- a) A student will be eligible for the award of M.Tech degree on securing a minimum of 5.0/10.0 CGPA.
- b) In the event of non-completion of project work and/or non-submission of the project report by the end of the fourth semester, the candidate shall re-register by paying the semester fee for the project. In such a case, the candidate will not be permitted to submit the report earlier than three months and not later than six months from the date of registration.

8.0 CURRICULUM AND COURSE STRUCTURE

The curriculum shall comprise Core Courses, Elective Courses, Laboratory Course, Comprehensive Examination, Internship and Project Work. The list of elective courses may include subjects from allied disciplines also.

Each Theory and Laboratory course carries credits based on the number of hours/week as follows:

- Lecture Hours (Theory): 1 credit per lecture hour per week.
- Laboratory Hours (Practical): 1 credit for 2 practical hours, 2 credits for 3 or 4 practical hours per week.
- **Project Work:** 1 credit for 4 hours of project work per week.

8.1 Credit distribution for courses offered is shown in Table 3.

S. No	Course	Hours	Credits
1	Core Courses	3	3
2	Elective Courses	3	3
3	MOOC Courses	-	2
4	Laboratory Courses	3	2
5	Seminar and Technical Writing	3	2
6	Comprehensive Examination	-	2
7	Project Work	128	30

Table 3: Credit distribution

8.2 Course wise break-up for the total credits:

Total Theory Courses (12) Core Courses (06) + Professional Electives (04) + Open Electives (02)	06 @ 3 credits + 06 @ 3 credits	36	
Total Laboratory Courses (03)	03 @ 2 credits	06	
MOOC Courses (02)	02 @ 2 credits	04	
Seminar and Technical Writing (01)	1 @ 2 credits	02	
Comprehensive Examination (01)	1 @ 2 credits	02	
Project Work	1 @ 30 credits	30	
TOTAL CREDITS			

9.0 EVALUATION METHODOLOGY

9.1 Theory Course:

Each theory course will be evaluated for a total of 100 marks, with 30 marks for Continuous Internal Evaluation (CIA) and 70 marks for Semester End Examination (SEE). Out of 30 marks allotted for CIE during the semester, marks are awarded by taking average of two sessional examinations.

9.1.1 Semester End Examination (SEE):

The SEE shall be conducted for 70 marks of 3 hours duration. The syllabus for the theory courses shall be divided into FIVE units and each unit carries equal weightage in terms of marks distribution. The question paper pattern shall be as defined below. Two full questions with 'either' 'or' choice will be drawn from each unit. Each question carries 14 marks. There could be a maximum of three sub divisions in a question.

50 %	To test the objectiveness of the concept
30 %	To test the analytical skill of the concept
20 %	To test the application skill of the concept

The emphasis on the questions is broadly based on the following criteria:

9.1.2 Continuous Internal Assessment (CIA):

For each theory course the CIA shall be conducted by the faculty/teacher handling the course as given in Table 4. CIA is conducted for a total of 30 marks, with 25 marks for Continuous Internal Examination (CIE) and 05 marks for Technical Seminar and TermPaper.

Table 4: Assessment pattern for Theory Courses

COMPONENT	T		
Type of	CIE Exam	Technical Seminar and	TOTAL MARKS
Assessment	(Sessional)	Term Paper	
Max. CIA	25	5	30

Continuous Internal Examination (CIE):

Two CIE exams shall be conducted at the end of the 9th and 17th week of the semester respectively. The CIE exam is conducted for 25 marks of 2 hours duration, consisting of 5 one mark compulsory questions in part-A and 4 questions in part-B. The student has to answer any 4 questions out of five questions, each carrying 5 marks. Marks are awarded by taking average of marks scored in two CIE exams.

Technical Seminar and Term Paper:

Two seminar presentations are conducted during I year I semester and II semester. For seminar, a student under the supervision of a concerned faculty member, shall identify a topic in each course and prepare the term paper with overview of topic. The evaluation of Technical seminar and term paper is for maximum of 5 marks. Marks are awarded by taking average of marks scored in two Seminar Evaluations.

9.2 Laboratory Course:

Each lab will be evaluated for a total of 100 marks consisting of 30 marks for internal assessment and 70 marks for semester end lab examination. Out of 30 marks of internal assessment, continuous lab assessment will be done for 20 marks for the day to day performance and 10 marks for the final internal lab assessment. The semester end lab examination for 70 marks shall be conducted by two examiners, one of them being a internal examiner and another is external examiner, both nominated by the Principal from the panel of experts recommended by Chairman, BOS.

All the drawing related courses are evaluated in line with lab courses. The distribution shall be 30 marks for internal evaluation (20 marks for day–to–day work, and 10 marks for internal tests) and 70 marks for semester end lab examination. There shall be ONE internal test for 10 marks each in a semester.

9.3 MOOC Courses:

Meeting with the global requirements, to inculcate the habit of self learning and in compliance with UGC guidelines, MOOC (Massive Open Online Course) courses have been introduced as electives.

9.3.1 The proposed MOOC Courses would be additional choices in all the elective groups subject to the vailability during the respective semesters and respective departments will declare the list of the courses at the beginning of the semester. Course content for the selected MOOC Courses shall be drawn from respective MOOCs links or shall be supplied by the department. Course will be mentored by faculty members and Assessment and evaluation of the courses shall be done by the department.

9.3.2 There shall be one Mid Sessional Examination (Quiz exam for 30 marks) after 8 weeks of the commencement of the course and semester end evaluation (Descriptive exam for 70 marks) shall be done along with other regular courses.

9.3.3 Two credits will be awarded upon successful completion of each MOOC Course.

9.3.4 Students interested in doing MOOC Courses shall register the course title at their department office at the start of the semester against the courses that are announced by the department.

9.4 Project work

Normally, the project work should be carried out at Host Institute (Institute of Aeronautical Engineering). However, it can also be carried out in any of the recognized Educational Institutions, National Laboratories, Research Institutions, Industrial Organizations, Service Organizations or Government Organizations with the prior permission from the guide and concerned Head of the Department. A student shall submit the outcome of the project work in the form of a dissertation.

- 9.4.1 The student shall submit the project work synopsis at the end of III semester for Phase-I of project evaluation. The Phase-I of project work shall be evaluated by Project Review Committee (PRC) at the end of the third semester for a maximum of 100 marks. Head of the Department HOD) shall constitute a PRC comprising of senior faculty of the specialization, Guide and Head of the Department.
- 9.4.2 The first phase of project work is to be carried out in IV semester for Phase –II of Project work. The student will be allowed to appear for final viva voce examination at the end of IV semester only if s/he has submitted s/he project work in the form of paper for presentation / publication in a conference/journal and produce the proof of acceptance of the paper from the organizers/publishers.

9.4.3 The student shall submit the project work in the form of dissertation at least four weeks ahead of the completion of the program. Head of the Department shall constitute an Internal Evaluation Committee (IEC) comprising of the Chairman BOS (PG), HOD andGuide. As per convenes of all meeting for open pre-submission seminar evaluation of the student. If the open pre-submission seminar by a student is not satisfactory, another seminar shall be scheduled within two weeks.

	S.No	Project Phases	Mode	Evaluation Committee	Marks
	1	Continuous evaluation at the end of III Semester		30	
	2	Phase - I 2	Evaluation at the end of III Semester	Project Review Committee (PRC) comprising of senior faculty of the specialization, guide and HOD.	70
Total(Phase – I)					100
	3	Dhase II	An open pre- submission seminar by the student	The Internal Evaluation Committee (IEC) comprising of the Chairman, BOS (PG), HOD and guide wherein the HOD convenes its meeting.	30
	4	Phase - II	End Semester Examination (An open seminar followed by viva- voce)	The External Evaluation Committee (EEC) comprising of External Examiner, HOD and guide wherein the HOD shall be the chairman of the committee.	70
			Total(Phase	II)	100

The evaluation of the project work and the marks allotted are as under:

9.4.4 As soon as a student submits his project work, Principal shall appoint the External Examiner among the panel of examiners recommended by the Chairman, BOS (PG).

9.4.5 The Principal shall schedule the End Semester Examination in project work soon after the completion of the study of program and a student can appear for the same provided s/he has earned successfully all the requisite credits. The student shall produce the dissertation duly certified by the guide and HOD during the Examination.

9.4.6 The project reports of M. Tech students who have not completed their course work successfully will be evaluated in that semester itself and the result sent confidentially to the Controller of Examinations. The results of the project work evaluation will b declared by the Controller of Examinations only after the successful completion of the courses by those students.

9.5 Comprehensive Examination

The comprehensive examination is aimed at assessing the student's understanding of various Foundation, Skill and Core courses studied by the end of II semester and is intended to test the student's grasp of the chosen field of study. The comprehensive examination is an online test evaluated for 100 marks.

10.0 ATTENDANCE REQUIREMENTS AND DETENTION POLICY

- 10.1 It is desirable for a candidate to put on 100% attendance in each course. In every course (theory/laboratory), student has to maintain a minimum of 80% attendance including the days of attendance in sports, games, NCC and NSS activities to be eligible for appearing in Semester End Examination of the course.
- 10.2 For cases of medical issues, deficiency of attendance in each course to the extent of 15% may be condoned by the Institute Academic Committee (CAC) on the recommendation of Head of the Department if his/her attendance is between 80% to 65% in every course, subjected to submission of medical certificate and other needful documents to the concerned department.
- 10.3 The basis for the calculation of the attendance shall be the period prescribed by the institute by its calendar of events. For late admission, attendance is reckoned from the date of admission to the program.
- 10.4 However, in case of a student having less than 65% attendance in any course, s/he shall be detained in the course and in no case such process will be relaxed.
- 10.5 Students whose shortage of attendance is not condoned in any subject are not eligible to write their semester end examination of that courses and their registration shall stand cancelled.
- 10.6 A prescribed fee shall be payable towards Condonation of shortage of attendance
- 10.7 A candidate shall put in a minimum required attendance at least in three (3) theory courses for getting promoted to next higher class / semester. Otherwise, s/he shall be declared detained and has to repeat semester.
- 10.8 A student shall not be promoted to the next semester unless he satisfies the attendance requirement of the present semester, as applicable. They may seek readmission into that semester when offered next. If any candidate fulfills the attendance requirement in the present semester, s/he shall not be eligible for readmission into the same class.

11.0 CONDUCT OF SEMESTER END EXAMINATIONS AND EVALUATION

- 11.1 Semester end examination shall be conducted by the Controller of Examinations (COE) by inviting Question Papers from the External Examiners.
- 11.2 Question papers may be moderated for the coverage of syllabus, pattern of questions by Semester End Examination Committee chaired by Head of the Department one day before the commencement of semester end examinations.
- 11.3 Internal Examiner shall prepare a detailed scheme of valuation.
- 11.4 The answer papers of semester end examination should be evaluated by the internal examiner immediately after the completion of exam and the award sheet should be submitted to COE in a sealed cover before the same papers are kept for second evaluation by external examiner.
- 11.5 In case of difference is more than 15% of marks, the answer paper shall be re-evaluated by a third examiner appointed by the Examination Committee and marks awarded by him shallbe taken as final.
- 11.6 HOD shall invite 3-9 external examiners to evaluate all the end semester answer scripts ona prescribed date(s). Practical laboratory exams are conducted involving external examiners.
- 11.7 Examination Control Committee shall consolidate the marks awarded by internal and external examiners to award grades.

12.0 SCHEME FOR THE A WARD OF GRADE

12.1 A student shall be deemed to have satisfied the minimum academic requirements and earn the credits for each theory course, if s/he secures:

- i. Not less than 40% marks for each theory course in the semester end examination, and
- ii. A minimum of 50% marks for each theory course considering both CIA and SEE

12.2 A student shall be deemed to have satisfied the minimum academic requirements and earn the credits for each Laboratory / Seminar and Technical Writing / Project, if s/he secures

- i. Not less than 40% marks for each Laboratory / Seminar and Technical Writing / Project course in the semester end examination,
- ii. A minimum of 50% marks for each Laboratory / Seminar and Technical Writing / Project course considering both internal and semester end examination.

12.3 If a candidate fails to secure a pass in a particular course, it is mandatory that s/he shall register and reappear for the examination in that course during the next semester when examination is conducted in that course. It is mandatory that s/he should continue to register and reappear for the examination till s/he secures a pass.

13.0 LETTER GRADES AND GRADE POINTS

13.1 Performances of students in each course are expressed in terms of marks as well as in Letter Grades based on absolute grading system. The UGC recommends a 10 point grading system with the following letter grades as given below:

Range of Marks	Grade Point	Letter Grade
100 - 80	10	S (Superior)
70 - 79	9	A+ (Excellent)
60 - 69	8	A (Very Good)
55 – 59	7	B+ (Good)
50-54	6	B (Average)
Below 50	0	F (Fail)
Absent	0	Ab (Absent)
Authorized Break of Study	0	ABS

- 13.2 A student is deemed to have passed and acquired to correspondent credits in particular course if s/he obtains any one of the following grades: "S", "A+", "A", "B+", "B".
- 13.3 A student obtaining Grade F shall be declared as failed and will be required to reappear in he examination.
- 13.3 At the end of each semester, the institute issues grade sheet indicating the SGPA and CGPA of the student. However, grade sheet will not be issued to the student if s/he has any outstanding dues.

14.0 COMPUTATION OF SGPA AND CGPA

The UGC recommends to compute the Semester Grade Point Average (SGPA) and Cumulative Grade Point Average (CGPA). The credit points earned by a student are used for calculating the Semester Grade Point Average (SGPA) and the Cumulative Grade Point Average (CGPA), both of which are important performance indices of the student. SGPA is equal to the sum of all the total points earned by the student in a given semester divided by the number of credits registered by the student in that semester. CGPA gives the sum of all the total points earned in all the previous semesters and the current semester divided by the number

of credits registered in all these semesters. Thus,

$$SGPA = \sum_{i=1}^{i} (C_i G_i) / \sum_{i=1}^{i} C_i$$

Where, C_i is the number of credits of the *i*th course and G_i is the grade point scored by the student in the *i*th course and *n* represent the number of courses in which a students is registered in the concerned semester.

$$CGPA = \sum_{j=1}^{m} (C_j S_j) / \sum_{j=1}^{m} C_j$$

Where, S_j is the SGPA of the j^{th} semester and C_j is the total number of credits upto the semester and m represent the number of semesters completed in which a student registered upto the semester.

The SGPA and CGPA shall be rounded off to 2 decimal points and reported in the transcripts.

15.0 ILLUSTRATION OF COMPUTATION OF SGPA AND CGPA 15.1 Illustration for SGPA

Course Name	Course Credits	Grade letter	Grade point	Credit Point (Credit x Grade)
Course 1	3	А	8	3 x 8 = 24
Course 2	4	B+	7	4 x 7 = 28
Course 3	3	В	6	3 x 6 = 18
Course 4	3	0	10	$3 \ge 10 = 30$
Course 5	3	С	5	3 x 5 = 15
Course 6	4	В	6	4 x 6 = 24
	20			139

Thus,
$$SGPA = 139 / 20 = 6.95$$

15.2 Illustration for CGPA

Semester 1	Semester 2	Semester 3	Semester 4
Credit: 20	Credit: 22	Credit: 25	Credit: 26
SGPA: 6.9	SGPA: 7.8	SGPA: 5.6	SGPA: 6.0

Thus,
$$CGPA = \frac{20x6.9 + 22x7.8 + 25x5.6 + 26x6.0}{93} = 6.51$$

16.0 PHOTOCOPY / REVALUATION

A student, who seeks the revaluation of the answer script, is directed to apply for the photocopy of his/her semester examination answer paper(s) in the theory course(s) within 2 working days from the declaration of results in the prescribed format to the Controller of Examinations through the Head of the Department. On receiving the photocopy, the student can consult with a competent member of faculty and seek the opinion for revaluation. Based on the recommendations, the student can register for the revaluation with prescribed fee. The Controller of Examinations shall arrange for the revaluation and declare the results. Revaluation is not permitted to the courses other than theory courses.

17.0 GRADUATION REQUIREMENTS

The following academic requirements shall be met for the award of M. Tech degree.

- 17.1 Student shall register and acquire minimum attendance in all courses and secure 80 credits.
- 17.2 A student who fails to earn 80 credits within four consecutive academic years from the year of his/her admission with a minimum CGPA of 5.0, shall forfeit his/her degree and his/her admission stands cancelled.

18.0 AWARD OF DEGREE

Classification of degree will be as follows:

CGPA ≥ 7.5	$CGPA \ge 6.5$ and < 7.5	$CGPA \ge 5.5$ and < 6.5	$CGPA \ge 5.0$ and < 5.5	CGPA < 5.0
First Class with Distinction	First Class	Second Class	Pass Class	Fail

- a) In case a student takes more than one attempt in clearing a course, the final marks secured shall be indicated by * mark in the grade sheet.
- b) All the candidates who register for the semester end examination will be issued grade sheet by the Institute. Apart from the semester wise grade sheet, the institute will issue the provisional certificate subject to the fulfillment of all the academic requirements.

19.0 IMPROVEMENT OF GRADE:

A candidate, after becoming eligible for the award of the degree, may reappear for the final examination in any of the theory courses as and when conducted for the purpose of improving the aggregate and the grade. But this reappearance shall be within a period of two academic years after becoming eligible for the award of the degree.

However, this facility shall not be availed of by a candidate who has taken the Original Degree Certificate. Candidates shall not be permitted to reappear either for CIE in any course or for Semester End Examination (SEE) in laboratory courses (including Project Viva-voce) for the purpose of improvement.

20.0 TERMINATION FROM THE PROGRAM

The admission of a student to the program may be terminated and the student may be asked toleave the institute in the following circumstances:

- a) The student fails to satisfy the requirements of the program within the maximum period stipulated for that program.
- b) The student fails to satisfy the norms of discipline specified by the institute from time to time.

21.0 WITH-HOLDING OF RESULTS

If the candidate has not paid any dues to the institute / if any case of indiscipline / malpractice is pending against him/her, the results of the candidate will be withheld. The issue of the degree is liable to be withheld in such cases.

22.0 GRADUATION DAY

The institute shall have its own annual Graduation Day for the award of Degrees to students completing the prescribed academic requirements in each case, in consultation with the University and by following the provisions in the Statute.

The institute shall institute prizes and medals to meritorious students annually on GraduationDay. This will greatly encourage the students to strive for excellence in their academic work.

23.0 DISCIPLINE

Every student is required to observe discipline and decorum both inside and outside the institute and not to indulge in any activity which will tend to bring down the honor of the institute. If a student indulges in malpractice in any of the theory / practical examination, continuous assessment examinations he/she shall be liable for punitive action as prescribed by the Institute from time to time.

24.0 GRIEVANCE REDRESSAL COMMITTEE

The institute shall form a Grievance Redressal Committee for each course in each department with the Course Teacher and the HOD as the members. This Committee shall solve all grievances related to the course under consideration.

25.0 TRANSITORY REGULATIONS

- 25.1 A student who has been detained in any semester of previous regulations for not satisfying the attendance requirements shall be permitted to join in the corresponding semester of this regulation.
- 25.2 Semester End Examination in each course under the regulations that precede immediatelythese regulations shall be conducted three times after the conduct of last regular examination under those regulations. Thereafter, the failed students, if any, shall take examination in the equivalent papers of these regulations as suggested by the Chairman, BOS concerned.

26.0 REVISION OF REGULATIONS AND CURRICULUM

The Institute from time to time may revise, amend or change the regulations, scheme of examinations and syllabi if found necessary and on approval by the Academic Council and the Governing Body shall come into force and shall be binding on the students, faculty, staff, all authorities of the Institute and others concerned.

FAILURE TO READ AND UNDERSTAND THE REGULATIONS IS NOT AN EXCUSE



INSTITUTE OF AERONAUTICAL ENGINEERING

(Autonomous)

CAD / CAM

COURSE STRUCTURE

I SEMESTER

Course Code	Course Name	ubject Area	Category	Pe	erio per vee	ds k	redits	So Exa Ma	cheme amina ax. Ma	e of ition arks
		S 1		L	T	Р	C	CIA	SEE	Total
THEORY										
BCC001	Advanced CAD	PC	Core	3	-	-	3	30	70	100
BCC002	Numerical Method for Partial Differential Equations	PC	Core	3	-	-	3	30	70	100
BCC003	Rapid Prototype Technologies	PC	Core	3	-	-	3	30	70	100
	Professional Elective – I	PE	Elective	3	-	-	3	30	70	100
	Professional Elective – II	PE	Elective	3	-	-	3	30	70	100
	Open Elective – I	OE	Elective	3	-	-	3	30	70	100
BCC301	MOOC - I (Massive Open Online Course)	PE	Elective	-	-	3	2	30	70	100
PRACTIC	AL									
BCC101	Computer Aided Design Laboratory	PC	Core	-	-	3	2	30	70	100
	TOTAL	•		18	00	06	22	240	560	800

II SEMESTER

Course Code	Course Name	ubject Area	Category	Pe	erio per vee	ds · k	redits	So Exa Ma	cheme amina ax. Ma	e of ation arks
		Ś		L	Т	Р	0	CIA	SEE	Total
THEORY										
BCC004	Design of Hydraulic and Pneumatic System	PC	Core	3	-	-	3	30	70	100
BCC005	Computer Aided Manufacturing	PC	Core	3	-	-	3	30	70	100
BCC006	Flexible Manufacturing System	PC	Core	3	-	-	3	30	70	100
	Professional Elective –III	PE	Elective	3	-	-	3	30	70	100
	Professional Elective –IV	PE	Elective	3	-	-	3	30	70	100
	Open Elective –II	OE	Elective	3	-	-	3	30	70	100
PRACTIC	AL									
BCC102	Computer Aided Machining and Robotics Laboratory	PC	Core	-	-	3	2	30	70	100
BCC103	Application Development Mini Project Laboratory	-	Core	-	-	3	2	30	70	100
	TOTAL			18	00	06	22	240	560	800

III SEMESTER

Course	Course Name	lbject Area	Category	Pe	erio pei vee	ods : k	redits	So Exa Ma	hemo mina x. M	e of ation arks
coue		Su A		L	Т	Р	Ū	CIA	SEE	Tota
THEORY										
BCC401	Seminar and Technical Writing	PC	Core	-	-	3	2	30	70	100
BCC302	MOOC-II (Massive Open Online Course)	PE	Elective	-	-	3	2	30	70	100
PRACTIC	CAL									
BCC501	Comprehensive Examination	-	Core	-	-	-	2	30	70	100
BCC601	Project Work (Phase -I)	-	Core	-	-	-	10	100	-	100
	TOTAL	•		00	00	06	16	190	210	400

IV SEMESTER

Course Code	Course Name	ubject Area	Category	Pe	erio pei vee	ods : k	Credits	So Exa Ma	chem mina x. M	e of ation arks
		\mathbf{v}		L	Т	Р	0	CIA	SEE	Total
BCC602	Project Work (Phase -II)	-	Core	-	1	-	20	30	70	100
	TOTAL			00	00	00	20	30	70	100

PROFESSIONAL ELECTIVES

GROUP 1: GEOMETRICAL DIMENSIONING AND TOLERANCING

Course Code	Course Title
BCC201	Precision Engineering
BCC202	Design for Manufacturing and Assembly
BCC203	Automation in Manufacturing
BCC204	Industrial Robotics

GROUP 2: SELECTION OF ENGINEERING MATERIALS

Course Code	Course Title
BCC205	Special Manufacturing Process
BCC206	Advanced Mechanics of Solids
BCC207	Design Optimization
BCC208	Computer Aided Process Planning

GROUP 3: PRODUCTION PLANNINGAND CONTROL

Course Code	Course Title
BCC209	Advanced Automatic Control
BCC210	Design for Manufacturing MEMS and Micro
	Systems
BCC211	Intelligent Manufacturing Systems
BCC212	Expert System Design

GROUP 4: STRESS ANALYS IS

Course Code	Course Title
BCC213	Stress Analysis and Vibration
BCC214	Computer Aided Analysis of Mechanical Systems
BCC215	Simulation Modeling of Manufacturing
BCC216	Data Communication in CAD/CAM

OPEN ELECTIVES-I

Course Code	Course Title
BST701	Disaster Management
BPE701	Renewable Energy Systems
BCC701	Automotive Design*
BES001	Embedded C
BCS701	Advanced JAVA Programming and Web Services
BAE701	Introduction to Aerospace Engineering
Note: * indicate	s that subject not offered to the students of
Mechanical Eng	gineering Department.

OPEN ELECTIVES-II

Course Code	Course Title
BST702	Geo Spatial Techniques
BPE702	Solar Photo Voltaic Energy Conversion
BCC702	Computer Graphics*
BES702	Microcontrollers for Embedded System Design
BCS702	Linux Programming
BCS703	Research Methodology
BAE702	Industrial Aerodynamics and Wind Energy
Note: * indicate	s that subject not offered to the students of
Mechanical Eng	gineering Department.

SYLLABUS (I – III SEMESTERS)

ADVANCED CAD

Course .	Code	Category	He	ours / V	Week	Credits	Μ	aximum	Marks
BCCO	01	Com	L	Т	Р	C	CIA	SEE	Total
BCCU	101	Core	3	-	-	3	30	70	100
Contact Clas	sses: 45	Tutorial Class	es: Nil	Pra	ctical C	lasses: Nil	Tot	al classe	s: 45
OBJECTIV The course s I. Understa II. Applying III. Create su	ES: should ena nd of basic the CAD urface and g	ble the students t trends in design a tools for designing geometric models.	o: and mode g.	eling ap	oplicable	e to CAD/CA	.М.		
UNIT-I	PRINCI	PLES OF COMP	UTER	GRAP	HICS			Cla	asses: 09
Principles of circle algorit ransformatic	computer hm, ellipse on, hidden	graphics : Introc e, transformation is surface removal, re	luction, in graph eflection	graphic ics, coc , shadir	c primit ordinate ng and g	ives, point p systems, vie eneration of c	lotting, li w port, 2 character.	ines, Bread 2D and 3	senham' D
UNIT-II	CAD TO	OOLS						Cle	
Definition of nput and our	f CAD To	ols, Types of syst	tem, CA ard fund	D/CAN	A system areas of	m evaluation	criteria, eling and	brief trea	itment o
Definition of input and our documentation representation curves hermi	F CAD To tput device on, efficie n of curve te cubic sp	ols, Types of systems. Graphics stand ent use of CAE es, wire frame mo lines Bezier curve	tem, CA ard, fund) softw dels wir s Bezier	D/CAN ctional are; C e fram splines	A system areas of Geometri e entities rationa	m evaluation f CAD, Mod ic modeling es parametric l curves.	criteria, eling and : Types represen	brief trea viewing, of mat tation of	tment o softwar hematica syntheti
Definition of input and our documentation representation curves hermine UNIT-III	F CAD To tput device on, efficie n of curve te cubic sp	ols, Types of systems. Graphics stand ent use of CAE es, wire frame mo lines Bezier curve CE MODELING	tem, CA ard, fund) softw dels wir s Bezier	D/CAN ctional are; C e fram splines	M system areas of Geometrice e entities rationa	m evaluation f CAD, Mod ic modeling es parametric l curves.	criteria, eling and : Types represen	brief trea viewing, of mat tation of	ttment o softwar hematica syntheti
Definition of input and our documentation representation curves hermin UNIT-III Mathematica Parametric re cylinder.	F CAD To tput device on, efficie n of curve te cubic sp SURFA I representation	ols, Types of syst es. Graphics stand ent use of CAE es, wire frame mo lines Bezier curve CE MODELING ation surfaces, surf on of surfaces, pla	tem, CA ard, fund D softw dels wir s Bezier ace mod ace mod	D/CAN ctional are; C e fram splines el, surf ce, rule	A system areas of Geometrie e entities rationa face entities ace entities	m evaluation f CAD, Mod- ic modeling es parametric l curves. ties surface re e, surface of	criteria, eling and : Types represent epresentat revolutio	brief trea viewing, of mat tation of Cla tion.	timent o softwar hematic: syntheti
Definition of input and ou documentation representation curves hermin UNIT-III Mathematica Parametric re cylinder. UNIT-IV	F CAD To tput device on, efficie n of curve te cubic sp SURFA I representation PARAM	ols, Types of system es. Graphics stand ent use of CAE es, wire frame mo lines Bezier curve CE MODELING ation surfaces, surf on of surfaces, pla	tem, CA ard, fund D softw dels wir s Bezier ace mod ne surfa	D/CAN ctional are; C e fram splines el, surf ce, rule	M system areas o Geometri e entities rationa ace entities ace entities of sym	m evaluation f CAD, Mod- ic modeling es parametric l curves. ties surface re e, surface of THETIC S	criteria, eling and : Types represent epresentat revolutio	brief treaviewing, of mat tation of Cla tion. n, tabulat	attment o softwar hematica syntheti asses: 09 ed
Definition of input and ou documentation representation curves hermine UNIT-III Mathematica Parametric re- cylinder. UNIT-IV Parametric re- surface, COO Segmentation	CAD To tput device on, efficie n of curve te cubic sp SURFA I representation PARAM epresentation DNs surfa n, Trimmin	ols, Types of system es. Graphics stand ent use of CAE es, wire frame mo- lines Bezier curve CE MODELING ation surfaces, surf on of surfaces, pla IETRIC REPRES on of synthetic surf ce, Blending surf g, Intersection, Tra	tem, CA ard, fund D softw dels wir s Bezier ace mod ane surfa sentar Sentar Faces: :	D/CAN ctional are; C e fram splines el, surf ce, rulo FION (Hermit llpturec ations (A system areas o Geometri e entities rationa ace entities ace entities surfac OF SYN e Bicub l surfac both 2D	m evaluation f CAD, Mod- ic modeling es parametric l curves. ties surface re e, surface of THETIC SI ic surface, B ic surface r o and 3D).	criteria, eling and : Types representat revolutio URFACF ezier surf nanipulat	brief treaviewing, of mat tation of Clation. n, tabulat ace, Bezi ion; Di	ed er Splind splaying
Definition of input and our documentation representation curves hermine UNIT-III Mathematica Parametric re- cylinder. UNIT-IV Parametric re- surface, COO Segmentation UNIT-V	F CAD To tput device on, efficie n of curve te cubic sp SURFA I representation PARAN epresentation DNs surfa n, Trimmin	ols, Types of syst es. Graphics stand ent use of CAE es, wire frame mo lines Bezier curve CE MODELING ation surfaces, surf on of surfaces, pla IETRIC REPRES on of synthetic surf ce, Blending surf g, Intersection, Tra GEON	tem, CA ard, fund Softw dels wir s Bezier ace mod ine surfa senTAT faces: : face Scu ansforma	D/CAN ctional are; C e fram splines el, surf ce, rule CION (Hermit llpturec ations (A system areas o Geometri e entities rationa ace entities cace entities ace entities e surfac OF SYN e Bicub l surfac both 2D	m evaluation f CAD, Mod- ic modeling es parametric l curves. ties surface re e, surface of THETIC SI ic surface, B re, Surface r and 3D). G-3D	criteria, eling and : Types representat revolutio URFACF ezier surf nanipulat	brief treaviewing, of mat tation of Cla tion. n, tabulat Cla Cla	ed esses: 09 esses: 09 esses: 09 esses: 09 esses: 09 esses: 09

Text	Boo	ks:

1. Ibrhim Zeid, "Mastering CAD/CAM", Tata McGraw Hill, 2nd Edition, 2013.

2.P. N. Rao, "CAD/CAM Principles and Applications", Tata McGraw Hill, 3rd Edition, 2010.

3. M. P. Groover, E. Zimmers, "CAD/ CAM Computer- Aided Design and Manufacturing", Pearson, 1st Edition, 2003.

4. R. Alavala Chennakesava, "CAD/ CAM Concepts and Applications", PHI, 1st Edition, 2013.

Reference Books:

1. Farid Amirouche, "Principles of Computer-Aided Design and Manufacturing, Pearson, 2nd Edition, 2004.

- 2. P. Radha Krishnan, "CAD/ CAM/ CIM", New Age International, 4th Edition, 2016.
- 3. Warren. S. Seames, "Computer Numerical Control Concepts and Programming", Delmar Cengage Learning, 4th Edition, 2013.

Web References:

1.http://nptel.ac.in/courses/112102101/

2. http://www.journals.elsevier.com/computer-aided-design

3. https://www.elsevier.com/books/surface-modeling-for-cad-cam/choi/978-0-444-88482-4

E-Text Books:

1.http://sbmpme.blogspot.in/2011/01/cad-cam-cim-p-radhakrishnan.html 2.https://www.scribd.com/doc/228624725/cad.cam.text.book.by_P_N_PAC

2. https://www.scribd.com/doc/228624725/cad-cam-text-book-by-P-N-RAO

NUMERICAL METHODS FOR PARTIAL DIFFERENTIAL EQUATIONS

I Semester	: CAD/CA	М									
Course	Code	Category	Hours / Week Credits				Maximum Marks				
BCC	002	Core	L	Т	Р	C	CIA	SEE	Total		
Contact Cl	asses: 45	Tutorial Classe	3 s: Nil	- Practi	- ical Clas	3 ses: Nil	30 Tota	70 al Classe	100 s: 45		
OBJECTIVES: The course should enable the students to: I. Analyze finite difference approximation. II. Determine partial differential equations. III. Apply partial differential equations with approximation.											
UNIT-I	PARAB	OLIC EQUATION	NS					Clas	ses: 08		
Introduction approximation conditions.	n to finite ion to one	difference formula; dimensional equatio	; Parabol n, Crank-	ic equati Nicholso	ons: Intron	roduction, it method,	explicit derivation	finite dif n for bou	ference ndary		
UNIT-II	CONVE	RGENCE STABI	LITY AN	D CON	SISTEN	CY		Clas	ses: 10		
ADI: Alter coordinates convergenc global round UNIT-III	nate directi ; Converge e analysis, ding error, HYPERI	ence stability and co stability analysis by local truncation error BOLIC EQUATIO	method, onsistency a matrix 1 or Lax`s e NS	rinite di v: Definit method, e equation t	ions of l bigen val	ocal trunca ue, Von No	ewmann	spherica r and con stability r	ses: 08		
Analytical s wenderoff e CFI conditi	explicit met	thod. roff`s implicit appr	near equa	n, propag	ation of	discontinu	along a c	rical solu	tion by		
the method	of characte	eristics.									
UNIT-IV	ELLIPT	IC EQUATIONS						Clas	ses: 10		
Introductio analysis of	on, finite d the discreti	ifferences in polar zation error of the fi	co-ordinative point	ates, form approxim	ulas for ation to	· derivative polman`s e	e near a o equation o	curved bo over a rect	oundary tangle.		
UNIT-V	SYSTEM	ATIC ITERATIV	'E METI	HODS				Clas	ses: 09		
Systematic iterative methods for large linear systems, necessary and sufficient condition for convergence of iterative methods, stones implicit methods, finite element method: Weighted residual method, variations methods, division of the region into elements linear element, Galerkin formulation.											
Text Books	s:										
 G. D. Sm University, Joe D. He 2001. 	nith, "Nume Clarandon offman, "N	erical Solution of pa Press Oxford, 3rd E Jumerical Methods f	rtial diffe Edition, 19 For Engine	erential eq 985. eers and s	uations,	finite Diffe 3", Tata Mc	erences m Graw Hil	nethods", ll, 2 nd Edi	Brunel tion,		

Reference Books:

- 1. A. R. Mitchel and D. F. Griffiths, "The Finite Difference Methods in Partial Differential equation", John Wiley, 1st Edition, 1980.
- 2. Larry J. Segerlind, "Applied Finite Element Analysis", John Wiley, 2nd Edition, 1984.

Web References:

- 1. http://ocw.mit.edu/courses/aeronautics-and-astronautics/16-920j-numerical-methods-for-partial-differential-equations-sma-5212-spring-2003/lecture-notes/
- 2. https://espace.library.uq.edu.au/view/UQ:239427/Lectures_Book.pdf
- 3. http://cms.unipune.ac.in/programmes/2006-07/modules/0613-2/resources/NSPDE.pdf

E-Text Books:

- 1. http://www.e-booksdirectory.com/details.php?ebook=10166
- 2. http://www.e-booksdirectory.com/details.php?ebook=7400re

RAPID PROTOTYPE TECHNOLOGIES

I Semester: CAD/CAM											
Course	Code	Category	Но	ours / Wee	ek	Credits	Maximum Marks				
BCC	2003	Core	L	Т	Р	C	CIA	SEE	Total		
Contact C	lasses: 45	Tutorial Cla	sses: Nil	- Practio	- cal Clas	sses: Nil	30 Total C	/0 21asses: 4	5 100		
OBJECTI The course I. Applyi II. Organi III. Identif IV. Applic	 OBJECTIVES: The course should enable the students to: I. Applying of measurement and scaling technique for prototype manufacturing. II. Organize the data collection. III. Identify the application for rapid prototyping. IV. Application for powder based rapid prototyping systems. 										
UNIT-I	INTROD	OUCTION TO R	RAPID PR	ROTOTY	PING			Classes	: 09		
Introductio Advantages Rapid Prote	n: Prototyp s and Limit otyping Pro	ing fundamenta ations of Rapid cess Chain: Fund	ls, Histori Prototypin amental A	cal devel ig, Commo utomated	opment, only use Process	, Fundamer ed Terms, C es, Process	ntals of Ra Classificatio Chain.	apid Prot on of RP	otyping, process,		
UNIT-II	TYPES (OF PROTOTYP	PING SYS	STEMS				Classes	: 09		
specification laser and la (SGC): m disadvantag (LOM): M disadvantag working pri	Liquid-based Rapid Prototyping Systems: Stereo lithography Apparatus (SLA): Models and specifications, process, working principle, photopolymers, photo polymerization, layering technology, laser and laser scanning, applications, advantages and disadvantages, case studies. solid ground curing (SGC): models and specifications, process, working principle, applications, advantages and disadvantages, case studies; solid-based Rapid Prototyping Systems: Laminated Object Manufacturing (LOM): Models and specifications, Process, working principle, Applications, Advantages and disadvantages, Case studies. Fused Deposition Modeling (FDM): Models and specifications, Process, working principle, Applications, Process, working principle, Case studies.										
UNIT-III	POWDE TOOLIN	R BASED RAP	ID PROT	OTYPIN	G SYS	FEMS ANI	D	Classes	: 09		
 Powder Based Rapid Prototyping Systems: Selective laser sintering (SLS): Models and specifications, Process, working principle, Applications, Advantages and Disadvantages, Case studies. Three dimensional Printing (3DP): Models and specifications, Process, working principle, Applications, Advantages and Disadvantages, Case studies. Rapid Tooling: Introduction to Rapid Tooling (RT), Conventional Tooling Vs. RT, Need for RT. Rapid Tooling Classification: Indirect Rapid Tooling Methods: Spray Metal Deposition, RTV Epoxy Tools, Ceramic tools, Investment Casting, Spin Casting, Die casting, Sand Casting, 3D Keltool process. Direct 											
Metal Tool	ing using3I	DP.			,	,		Class	00:00		
Rapid Prote	otvning Dat	a Formats' STL1	Format ST	TL File Pr	oblems	Consequer	ce of Build	ding Vali	d and		
Invalid Tes Rapid Proto Expert, 3 D	sellated Mo otyping Sof View, Vel	dels, STL file Re tware's: Features ocity 2, Rhino, S	pairs: Gene of various STL View	eric Soluti s RP softw 3 Data E	on, Othe vare's li xpert an	er Translator ike Magic's d 3 D docto	rs, Newly I s, Mimics, F or.	Proposed Solid Vie	Formats. w, View		

UNIT-V RAPID PROTOTYPING APPLICATIONS	Classes: 09							
RP Applications: Application, Material Relationship, Application in Design, Application in Engineering, Analysis and Planning, Aerospace Industry, Automotive Industry, Jewelry Industry, Coin Industry, GIS application, Arts and Architecture. RP Medical and Bioengineering Applications: Planning and simulation of complex surgery, Customized Implants & Prosthesis, Design and Production of Medical Devices, Forensic Science and Anthropology, Visualization of Biomolecules.								
Text Book:								
 Chua C.K., Leong K.F, LIM C.S, "Rapid prototyping: Principles and Applications", World Scientific publications, 3rd Edition, 2010. 								
Reference Books:								
 D.T Pham, S. S. Dony, "Rapid Manufacturing", Springer, 1st Edition, 2001. Paul F Jacobs, "Rapid Prototyping & Manufacturing", Wohlers Associates, 2000 ASME Press, 1st Edition, 1996. 								
Web References:								
1. http://nptel.ac.in/courses/112107077/38								
2. http://web.iitd.ac.in/~pmpandey/MEL120_html/RP_document.pdf								
E-Text Books:								
1.https://books.google.co.in/books?id=4OYcyiDUpsQC&redir_esc=y 2.http://store.elsevier.com/Direct-Write-Technologies-for-Rapid-Prototyping-Applications/isbn- 9780121742317/								

COMPUTER AIDED DESIGN LABORATORY

I Semester	: CAD/CA	М							
Course	e Code	Category	He	ours / V	Veek	Credits	Μ	aximum	Marks
BCC	101	Core	L	Т	Р	С	CIA	SEE	Total
			-	-	3	2	30	70	100
Contact C	lasses: Nil	Tutorial Classes:	Nil	Pra	ctical C	lasses: 36	Tot	al Classe	s: 36
OBJECTIVES: The course should enable the students to: I. Basic understanding of modern trends in design and manufacturing using CAD/CAM. II. Advanced aspects of enabling computer aided technologies used in design. III. Application of thermal analysis software.									
Week 1	Introduct	LIS		EAPE	KINEN	15			
VVeeK-1	f working d	rowing creating case	noter:	oonatra	ining th	o profile an	tracting	nort uci	ng toolo
creating pa and views,	ttern of hole	t and dimensions.	g, mirro	oring, 1	nanagin	g the specifi	cation tre	e. Creatin	ng tools, ng sheets
Week-2	Assembly	of Part Drawing							
creating an creating wi	assembly, re frame and	moving components, l surface geometry us	assem	bling e erative	existing shape d	components, lesign and sw	, creating eep tools	bill of m	naterials,
Week-3	Generatio	on of Surfaces							
Generation drawing fro	of Fergusor om other sof	n's cubic surface patch tware.	hes, Be	zier su	face pat	ches. Coons	patch, im	port and e	export of
Week-4	Analysis	of Model							
Linear stati and consist response, n static analy	ic analysis, a ent mass ma node superp rsis, non-line	automatic calculation atrices. Buckling anal osition method, overa ear dynamic analysis.	of rigic ysis, ja all struc Steady	l body cobi in ctural a state h	modes, verse ite nd damj eat trans	uses specifie eration techni ping, linear c sfer analysis	d eigen v iques, stea lynamic a problems	alue shift, ady state l nalysis, n	lumped narmonic on linear
Week-5	Thermal	Analysis							
Transient h multipoint solver. Res	heat transfe constraint f ults and ana	r analysis. Familiar amiliarity with differ lysis. Design optimiz	ity wit rent typ ation.	h elen bes of	nent lib loads. S	orary. Definition tech	ing Bour niques, d	ndary con irect and	ditions, iterative
Reference	Books:								
 Farid An 2004. P. Radha Warren. Learning, 4 2013. 	mirouche, " Krishnan, " S. Seames, th Edition,	Principles of Comput 'CAD/ CAM/ CIM'', I ''Computer Numeric	ter-Aid New Ag al Con	ed Des ge Inter trol Co	ign and rnationa ncepts a	Manufacturi l, 4 th Edition, and Program	ing, Pears , 2016. ming", D	son, 2 nd Ed	dition, ngage

E-Text Books:

1.http://sbmpme.blogspot.in/2011/ 01/cad-cam-cim-p-radhakrishnan.html 2.https://www.scribd.com/doc/228624725/cad-cam-te_xt_-book-by-P-N-RAO

SOFTWARE AND HARDWARE REQUIRED FOR A BATCH OF 18 STUDENTS

SOFTWARE: AutoCAD 2016, CATIA R2016, ANSYS.

HARDWARE: 500 GB HDD, 8GB RAM.

DESIGN OF HYDRAULIC AND PNEUMATIC SYSTEMS

II Semester:	CAD/CA	AM										
Course (Code	Category	H	ours /	Week	Credits	N	laximum	Marks			
BCCO	04	Corro	L	Т	Р	С	CIE	SEE	Total			
вссо	04	Core	3	-	-	3	30	70	100			
Contact Cla	sses: 45	Tutorial Classes: N	Nil	P	ractical Cl	asses: Nil	Tot	Total Classes: 45				
OBJECTIVES: The course should enable the students to: I. Understand of basic hydraulic circuits and maintenance. II. Design of hydraulic, pneumatic pumps and circuits. III. Apply of pneumatic and hydraulic systems, automation in industrial equipment.												
UNIT-I OIL AND HYDRAULIC SYSTEMS Classes: 09												
Introduction, principle, flu physical unit hydraulic flu in the circuits in automatio	Introduction, history of fluid power, Pascal's law, Bramah's Press, Bernoulli's principle, Toricelli principle, flu id principle, fluid properties, viscosity, effect of temperature, dust and decay of oils, basic systems of hydraulic, physical units of fluid power, units of measurement, types of hydraulic flu id and selection criteria, properties of hydraulic flu id, physical characteristic, maintenance of hydraulic oils, oil hydraulic element and their representation in the circuits, comparison of mechanical, electrical, hydraulic and pneumatic systems for force and motion, analysis in automation.											
UNIT-II	HYDRA	ULIC PUMPS						Cl	asses: 09			
Classification of pumps, gear pump, types of gear pumps, screw pump, vane pump, types of vane pumps, piston pump, bent axis in line piston pump, internal and e xte rnal gear pumps, selection and sizing specification of pumps, specification of pumps, pump and pressure pulsation, flow rate and power of hydraulic pump, power and pump efficiencies, pressure, flow efficiencies, oil compatibility, size, noise, pump ripple, checklist; Actuato rs, design of linear actuator, cushioning, seals, mounting details, piston rod diameter and its effect on the pressure, servo controlled valves, hydraulic balanced circuits, sequencing and synchronizing circuits, rotary actuators.												
UNIT-III	HYDRA	ULIC POWER PACK						Cl	asses: 09			
Element of p Selection, po systems for h	oower pack wer pack s hydraulic j	c, design of hydraulic pow size and capacity, importan power pack.	ver pack	, line essure	pressure, d relief valve	ischarge and r and safety sys	notor. stems, heati	ng and coo	oling			
UNIT-IV	HYDRA	ULIC CIRCUITS AND	ACCU	MUL	ATOR			Cl	asses: 09			
Hydaulic circuits, manual or automatic hydraulic system, regenerative circuit, use of check valves in hydraulic circuit, selection of pump, standard in circuit circuit diagram representation, sequencing and synchronizing circuits; accumulator, low cost automation; meter-in circuit, meter-out circuit, bleed-off circuit, direction control valves, solenoid valves, flow control and pressure control valves, pressure compensation, accumulator.												
UNIT-V	AUTOM	IATION						Cl	asses: 09			
Hydraulic an automation, 1	nd pneuma micro cont	tic equipment in automation to the second seco	ion, low oublesho	cost a ooting	automation, of hydrauli	relay circuit, c and pneuma	programm tic circuit.	able logic	circuit,			

Text Books:

1. S. R. Majumdar, "Oil Hydraulic Systems", Tata McGraw Hill, 1st Edition, 2013.

2. S. R. Majumdar, "Pneumatic Systems, Principles & maintaianance", Tata McGraw Hill, 1st Edition, 2013.

Reference Books:

Andrew Parr, "Hydraulic & Pneumatic", Butterworth-Heinemann Ltd, 2nd Edition, 2013.
 Antony Esponssito, "Fluid Power with applications", Prentice Hall, 5th Edition, 2015.

Web References:

1. http://nptel.ac.in/courses/112105046

- 2. http://www.nptel.ac.in/courses/112106175/Module%201/ Lecture%201.pdf
- 3. http://hydraulicspneumatics.com/fluid-power-basics

E-Text Books:

1.https://www.google.co.in/?gfe_rd=cr&ei=weV5V8HrNKLR8AeNgr7g Bw&gws_rd=ssl#q=hydraulic+and+pne umatics+andrew+parr+pdf

2. https://books.google.co.in/books/about/Oil_Hydraulic_Systems.html? id=NBMtphgTmxg C&redir_esc=y

 $3.\ http://www.faa.gov/regulations_policies/handbooks_manuals/aircraft/a\ mt_airframe_handbook/media/ama_ch1$

2.pdf

COMPUTER AIDED MANUFACTURING

II Semester:	CAD/C	AM							
Course C	Code	Category	Ho	ours / V	Veek	Credits	Ν	Maximum	Marks
BCCM	05	Coro	L	Т	P	С	CIA	SEE	Total
BCCM	03	Core	3	-	-	3	30	70	100
Contact Clas	sses: 45	Tutorial Classo	es: Nil	Prac	tical Cl	asses: Nil	То	otal Classes	s: 45
OBJECTIVES: The course should enable the students to: I. Applying CNC programming for manufacturing. II. Development of automatic programming techniques. III. Applying the computer aided concepts in computer aided process planning.									
UNIT-I C	OMPUT	ER AIDED PRO	GRAM	MING				Cla	asses: 09
General infor programming CAD/CAM s	mation, A g on CAD oftware, a	PT programming /CAM systems, th automatic tool path	, exampl 1e design h genera	les Apt n and ir tion.	program nplemen	ming proble tation of po	ems (2D r st process	nachining o sors; Introd	only), NC luction to
UNIT-II T	OOLING	FOR CNC MA	CHINE	S				Cla	asses: 09
Interchangeal quick change type of DNC adaptive cont	ble toolin tooling s system rol with c	g system, preset a system, automatic s, advantages and constrains, adaptive	nd quali head ch d disady e control	ified too angers; vantage l of mac	ols, coola DNC sy s of DN chining p	ant fed toolin stems and a JC, adaptive processes like	ng system idaptive c e control e turning,	n, modular f control: Intr with opti grinding.	fixturing, oduction, mization,
UNIT-III	POST P	PROCESSORS F	OR CN	С				Cla	asses: 09
Introduction processor, the Communicati	Introduction to post processors: The necessity of a post processor, the general structure of a post processor, the functions of a post processor, DAPP based post processor.								
based post pr	ocessor.								
UNIT-IV	MICRO) CONTROLLE	RS					Cla	asses: 09
Introduction to microcontrollers: Hardware components, I/O pins, ports, external memory: counters, timers and serial data I/O interrupts, selection of micro controllers embedded controllers, applications and programming of micro controllers; Programming logic controllers: Introduction, hardware components of PLC, System, basic structure, principle of operations, programming mnemonics timers, internal relays and counters, applications of PLC's in CNC Machines.									
UNIT-V C	OMPUT	ER AIDED PRO	CESS P	PLANN	ING			Cla	asses: 09
Hybrid CAA limitations of system: Artifi	P system CMM, control	, computer aided omputer aided tes al networks, artific	inspect ting, opt cial intel	ion and ical ins ligence	l quality pection in CAD	control, co methods, art , experts sys	ordinate i ificial int stems and	measuring elligence an its structur	machine, nd expert es.

Text Books:

- 1. Yoram Koren, "Computer Control of Manufacturing System", Tata Mcgraw Hill, 1st Edition, 1983.
- 2. K. Lalit Narayan, K. Mallikarjuna Rao, "Computer Aided Manufacturing", 1st Edition, 2008.

Reference Books:

1. Mikell. P. Grover, Emory W. Zimmer, "CAD/CAM", PHI, 1st Edition, 2010.

Web References:

1. http://nptel.ac.in/courses/112105046

2.http://nptel.ac.in/courses/Webcoursecontents/IITDelhi/Computer%20Aided%20Design%20&%20Ma nufacturingI/index.ht

mhttp://www.nptel.ac.in/courses/112106175/Module%201/Lecture%201.pdf

E-Text Books:

1.https://www.google.co.in/?gfe_rd=cr&ei=weV5V8HrNKLR8AeNgr7gBw&gws_rd=ssl#q=hydraulic +and+pneumatics+andrew+parr+pdf

2.https://books.google.co.in/books/about/Oil_Hydraulic_Systems.html?id=NBMtphgTmxgC&redir_es c=y

3. http://www.faa.gov/regulations_policies/handbooks_manuals/aircraft/amt_airframe_handbook/media /ama_ch12.pdf

FLEXIBLE MANUFACTURING SYSTEMS

II Semester: CAD/CAM												
Cours	e Code	Category	Ho	ours / V	Veek	Credits	Ma	Maximum Marks				
BCO	2006	Coro	L	Т	Р	С	CIA	SEE	Total			
DCC	.000	Core	3	-	-	3	30	70	100			
Contact C	lasses: 45	Tutorial Classes	: Nil	Prac	ctical C	lasses: Nil	Tota	l Classes	s: 45			
OBJECTIVES: The course should enable the students to: I. Understanding of modern trends in design and manufacturing using CAD/CAM. II. Apply performance analysis techniques. III. Understand preventive maintenance procedures in manufacturing.												
UNIT-I	FLEXIBL	E MANUFACTUR	ING S	YSTEN	/IS:			Cla	sses: 09			
Introductio concerning product, sn	n: Definition systems and hall batch ma	s of manufacturing v d system design pro- nufacturing	with inj cedure,	put-outj modes	put mod of mai	lel, definition nufacturing –	of system job/batch	, basic p /flow an	oroblems d multi-			
UNIT-II	SYSTEM	MODELING ISSU	ES					Cla	sses: 09			
System mo Forward vs states and c	deling issues backward s leadlocks; C	s: Centralized versus scheduling approache onflicts; Concurrenc	distributes with y, and s	uted con finite/in synchro	ntrol; R nfinite c nization	eal-time vs d capacity loadi n.	iscrete eve ng; Model	nt contro ing of ab	ol; sorbing			
UNIT-	SYSTEM	MODELING TOO	LS AN	D TEC	HNIQ	UES		Cla	sses: 09			
III Statistical model in the filter filt												
UNIT-IV	PERFORM	MANCE ANALYSI	S					Cla	sses: 09			
Performanc	e Analysis:	Transient analysis of	manuf	acturin	g syster	ns, analysis.						
UNIT-V	PREVENT	FIVE MAINTAINA	NCE					Cla	sses: 09			
Preventive	maintenance	e, Karban system, im	plemen	tation i	ssues.							
Text Book	s:											
 N. K. Jha Talichi O Pvt. Ltd, 1st Editio H K Shir 	 Text Books: N. K. Jha, "Hand Book of Flexible Manufacturing Systems", Academic Press, 1st Edition, 2013. Talichi Ohno, "Production System beyond Large Scale Production", Toyota Productivity Press India Pvt. Ltd, 1st Edition, 2010. H K Shiyanand, "Flexible Manufacturing Systems", New Age International, 1st Edition, 2006 											

Reference Books:

1. Farid Amirouche, "Principles of Computer-Aided Design and Manufacturing, 2nd Edition, 2004.

2. P. Radha Krishnan, "CAD/ CAM/ CIM", New Age International, 4th Edition, 2016.

Web References:

1. http://www.ignou.ac.in/upload/UNIT6-55.pdf

2. http://www.journals.elsevier.com/computer-aided-design

3. https://www.elsevier.com/books/surface-modeling-for-cad-cam/choi/978-0-444-88482-4

E-Text Books:

1. http://engineeringstudymaterial.net/ebook/flexible-manufacturing-system/

2. http://www.sciencedirect.com/science/book/9780123853103
COMPUTER AIDED MANUFACTURING LABORATORY

II Semester: CAD/CA	M									
Course Code	Category	He	ours / '	Week	Credits	Μ	laximum	Marks		
		L	Т	Р	С	CIA	SEE	Total		
BCC102	Core	-	-	3	2	30	70	100		
Contact Classes: Nil	Tutorial Classes	s: Nil	Pra	ctical C	Classes: 36	Total Classes: 36				
OBJECTIVES:										
The course should ena	able the students to	:								
I. Create the part mo	del using CAM soft	ware.								
II. Generate computer	r numerically part pr	ogram i	for con	nputer n	umerically co	ontrol turi	ning and r	nilling		
operation.				~						
III. Demonstrate the to	ool path for turning o	operatio	n using	g CAM s	software.					
		ST OF	EXPE	RIME	NTS					
Week-1 INTRODU	JCTION TO COM	PUTE	R AID	ED MA	CHINING	<u> </u>				
Tool planning and selec	ction of sequences of	t operat	tion, to	ol setting	g on machine	e-practice	•			
Week-2 PART PR	OGRAM									
Practice in part program	nming and operation	n of CN	C turni	ing mach	nines, sub rou	itines and	l use of cy	cles.		
Week-3 PART PR	OGRAM									
Practice in part program	n and operation of a	machin	e cente	er, joinin	ig and selecti	on of seq	uence of			
operation, tool setting o	on machine.									
Week-4 NUMERIC	CAL CONTROL P	ROGR	AMM	ING						
Generate APT based N	C programming and	tool sii	nulatio	on for dr	illing operati	on.				
Week-5 NUMERIC	CAL CONTROL P	ROGR	AMM	ING						
Practice in APT based N	NC programming an	d tool s	imulati	ion for f	acing operati	on.				
Week-6 NUMERIC	CAL CONTROL P	ROGR	AMM	ING						
Generate of NC code ge	eneration and tool pa	ath simu	ilation	for profi	ile milling op	peration u	sing CAM	1		
software.										
Week-7 NUMERIC	CAL CONTROL P	ROGR	AMM	ING						
Develop NC code and t	ool path simulation	for thre	ad ope	ration us	sing CAM so	oftware.				
Week-8 ROBOTIC	CS SIMULATION									
Practice of robotic lang	uages, 3-D Robot Si	imulatio	on for c	operation	n of pick-plac	e robot.				
Reference Books:										
1. Farid Amirouche, "F	Principles of Compu	iter-Aid	led De	sign and	Manufactur	ing, Pears	son, 2 nd E	dition,		
2004. 2 P Radha Krishnan "	CAD/ CAM/ CIM"	New A	oe Int	ernation	al 4 th Edition	1 2016				
3 Warren S Seames	"Computer Numeri	cal Con	trol Co	oncents	and Program	n, 2010. mino" D	elmar Cer	ngage		
Learning, 4 th Edition, 20	013.					_E , D				
E-Text Books:										
1.http://sbmpme.blogsp	oot.in/2011/01/cad-c	am-cin	n-p-rad	hakrishr	an.html					
2.https://www.scribd.co	om/doc/228624725/	cad-car	n-text-	book-by	-P-N-RAO					

PRECISION ENGINEERING

Group I: CA	AD/CAM								
Course (Code	Category	H	ours / W	'eek	Credits	Ma	ximum N	Aarks
BCC2	01	Flective	3 C				CIA	SEE	Total
DCC2	UI .	Elective	3	-	-	3	30	70	100
Contact Cla	sses: 45	Tutorials Class	es: Nil	Prac	tical Cla	sses: Nil	Tota	l Classes	: 45
OBJECTIV The courses I. Underst II. Applyin III. Underst	ES: should en anding the g the tole anding the	able the students t e basics of tolerance rance analysis and t e basics fundamenta	o: es. olerance ils of nanc	charting otechnolo	techniqu ogy.	e for a proce	ss.		
UNIT-I	CONCE CONVE	CPT OF ACCURA	CYAND	TOLER	ANCE 2	ZONE		Class	es: 09
accuracies, a measurement conversions, surfaces as d controls logic	accuracy of t system surfaces, latum feat cal approa	of numerical contro and velocity lag features, features tures, equalizing da ach to tolerancing.	ol system s; geome of size, tums datu	s, errors etric dim datum fe im featur	due to nensionir eatures, re of rep	numerical in ng and tole datum Oddl resentation;	nterpolatio rancing: y configu form cont	on display Toleranco red and rols, orie	cement e zone curved entation
UNIT-II	DATUM	IS						Classe	es: 09
Datum syste perpendicula Grouped datu rotational acc	ms: Desig r grouped um systen curacy, ge	gn of freedom, gro d datum planes; C n with spigot and re ometric analysis an	buped date brouped decess pair ad applica	um syste latum sy and tong tion.	ems, diff ystem wi gue, slot	erent types, th spigot a pair, comput	two and nd recess ation of th	three mu , pin and ransnation	itually d hole; nal and
UNIT-III	TOLER	ANCE ANALYSI	8					Classe	es: 09
Tolerance ar Cp, Cpk, Cos	nalysis: Pr st aspects,	rocess capability, n feature tolerances.	nean, vari	iance, sk	ewness,	Kurtosis, pr	ocess cap	ability m	netrics,
Geometric to different mac law.	olerances; chining pr	surface finish, re rocess, cumulative e	eview of effect of to	relations	hip bety s sure fit	veen attaina law, normal	ble tolera law and t	nce grad runcated	les and normal
UNIT-IV	TOLER	ANCE CHARTIN	G TECH	INIQUE	S			Classe	es: 09
Tolerance ch process draw features to machining co	narting tec vings for of facilitate onsideration	chniques: Operation different operations machining; datum ons, redesign for ma	sequence , toleranc features anufacture	e for typ e works , functio ed.	ical shaf heets and onal and	t type of conditional type of conditional type of the contrality and the conditional type of type of type of the conditional type of t	mponents, nalysis, e ring com	, preparat xamples, ponents	ion of design design,
UNIT-V	MEASU	RING SYSTEM I	PROCES	SING				Classe	es: 09
In Processin measurement systems of C	g or In-S t of dime CMM; Las	itu measurement on nsional features an er alignment and te	of positio d surface sting.	n of pro -mechan	cessing, ical and	point-post poptical mea	process ar suring sys	nd on ma stems; w	achine orking

Text Books:

1. R. L. Murthy, "Precision Engineering in Manufacturing", New Age International limited, 1st Edition, 1996.

2. James D. Meadows, "Geometric Dimensioning and Tolerancing", Marcel Dekker, 1st Edition, 1995.

3. Norio Taniguchi, "Nano Technology", Oxford University Press, 1st Edition, 1996.

4. Matousek, "Engineering Design-A systematic Approach", Blackie & Son Ltd., London.

5. V. C. Venkatesh, S.Izman, "Precision Engineering", Tata McGraw Hill,

Reference Books:

 Preumont, A., "Vibration Control of Active Structures", Kluwer Academic Publishers, 2002.
 F. Y. Cheng, H. Jiang, K. Lou, "Smart Structures: Innovative Systems for Seismic Response Control", CRC Press, 2008

Web References:

1.http://nptel.ac.in/courses/112104173/ 2.http://ttp.net/978-3-908451-70-9.html 3.http://iopscience.iop.org/journal/0964726

E-Text Books:

1. http://www.me.umn.edu/~wkdurfee/projects/ccefp/fp-chapter/fluid-pwr.pdf

2. http://hydraulicspneumatics.com/ebooks/fluid-power-ebook-fluid-power-basics

DESIGN FOR MANUFACTURING AND ASSEMBLY

Group I: CA	D/CAM									
Course	Code	Category	He	ours / V	Veek	Credits	Μ	aximum N	Aarks	
DOCO			L	Т	P	С	CIA	SEE	Total	
BCC2	202	Elective	3	-	-	3	30	70	100	
Contact Clas	sses: 45	Tutorial Classes	es: Nil Practical Classes: Nil Total Classes: 45							
OBJECTIVI The course s I. Understa II. Applying III. Apply th	ES: should enal anding of ba g the produ a concepts	ble the students to asic design rules fo ction processes for of design for manu	: r manu ease of	facturin f manuf ng and a	ig and m acturing assembly	aterial selec y for produc	tion. t manufac	turing.		
UNIT-I I	NTRODU	CTION TO DESI	GN	-	-			Cla	sses: 09	
Introduction: principles of for design d interrelations	ntroduction: Design philosophy steps in design process, general design rules for manufacturability, basic principles of design Ling for economical production, creativity in design; Materials selection of materials or design developments in material technology, criteria for material selection, material selection interrelationship with process selection process selection charts.									
UNIT-II I	MACHINI	NG PROCESS						Clas	sses: 09	
for machining casting: Appr for casting, ca sand casting.	g ease with aisal of var asting toler	an suitable examples rious casting process ances, use of solidi	s. Gene sses, sel fication	eral des lection	ign reco of castir ation in	mmendation ng process, g casting desi	is for mac general des gn, produ	chined part sign consid ct design r	ts; Metal derations rules for	
UNIT-III	METAL	JOINING						Cla	sses: 09	
Metal joining guidelines, pr joints; Forgin design genera Extrusion and blanking, ben	g: Appraisa re and post ng, design f al design re d sheet met iding, deep	l of various welding t treatment of weld actors for forging, commendations. al work: Design gu drawing, Keeler Go	ng proc ls, effe closed uideline	cesses, cts of t dies for es for en n formin	factors i hermal s rging des xtruded ng line d	n design of stresses in v sign, parting sections, der iagram, com	weldmen veld joints lines of d sign princ	its, genera s, design o ie drop for iples for p ssign for bl	l design of brazed rging die unching, anking.	
UNIT-IV	ASSEM	BLY ADVANTA	GES					Cla	sses: 09	
Assembly ad advantages so intermittent t	lvantages: ocial effect ransfer, ind	Development of the ts of automation, a lexing mechanisms.	ne asse automat , and op	mble p ic assent perator,	rocess, mbly tra paced fr	choice of a nsfer systen ee, transfer	assemble ns: Contin machine	method as nuous trans	ssemble sfer,	
UNIT-V	DESIGN	OF MANUAL AS	SSEME	BLY				Clas	sses: 09	
Design of ma manual asser system for m symmetry on handling time symmetry eff	anual assem nbly, devel nanual han handling e, parts req ect of chan	bly: Design for ass opment of the syst dling, classification time, effect of par puiring two hands ther design on inser	embly tematic on syste art thicl for man tion op	fits in the DFA mem for kness an ipulation	the designethodo manual nd size on, effects, estimation	n process, g logy, assem insertion a on handlin cts of comb tion of inse	general des bly efficient and fasten g time, efficient inations of rtion time.	sign guidel ency, class ing, effect ffect of w of factors,	ines for sification t of part eight on effect of	

Text Bo	oks:
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- 1. GeoffreyBoothroyd, "Assembly Automation and Product Design", CRC Press, 2nd Edition, 2013.
- 2. George E. Deiter, "Engineering Design Material & Processing Approach", Tata McGraw Hill, 2nd Edition, 2000.
- 3. Geoffrey Boothroyd, "Hand Book of Product Design", Marcel and Dekken, 1st Edition, 1990.

Reference Books:

- 1. A Delbainbre, "Computer Aided Assembly"1992.
- 2. Geoffrey Boothroyd, Peter Dewhurst, Winston. A. Knight, "Product Design for Manufacturing and Assembly", CRC Press, 3rd Edition, 2013.

Web References:

- 1. http://nptel.ac.in/courses/107103012/
- 2. http://me.gatech.edu/files/capstone/L071ME4182DFA

E-Text Books:

1. https://books.google.co.in/books/about/Assembly_Automation_and_Product_Design.html?id=XF tgaNFzMHQC

2. https://books.google.co.in/books/about/Product_Design_for_Manufacture_and_Assem.html?id=q YGgjwEACAAJ

AUTOMATION IN MANUFACTURING

Group I: CA	AD/CAM									
Course (Code	Category	Н	ours / V	Week	Credits	Ν	Maximum	Marks	
			L	Т	Р	С	CIA	SEE	Total	
BCC2	202	Elective	3	-	-	3	30	70	100	
Contact Cla	sses: 45	Tutorial Classes	: Nil	Prac	tical Cl	asses: Nil	То	otal Classe	es: 45	
OBJECTIV The course I. Understa II. Applicat III. Design c	ES: should en and of mo- tion of ma of automat	able the students to dern trends in autom terial handling syste red assembly lines w	ation a ms and ith qua	and ma l storag llity cor	nufactur e systen ntrol.	ring ns.				
UNIT-I	OVER V	IEW OF MANUFA	CTU	RING A	AND AU	UTOMATI	ON	C	Classes: 09	
Over view of automation p an automate programmab	view of manufacturing and automation: production systems, automation in production systems, ation principles and strategies, manufacturing operations, production facilities, basic elements of tomated system, levels of automation; hardware components for automation and process control, ammable logic controllers and personal computers.									
UNIT-II	MATERI	AL HANDLING A	ND ID	DENTI	FICAT	ION TECH	INOLOG	IES: C	Classes: 09	
Material han systems, per identification	ndling and formance n methods	d identification tec and location strategi , barcode technology	hnolog es, aut /, RFII	gies: M comated D.	laterial storage	handling, e systems, A	equipmer S/RS, typ	nt, analysi bes, autom	s storage atic	
UNIT-III	MANUFA LINES	ACTURING SYST	EMS A	AND A	UTOM	ATED PR(DUCTI	ON C	Classes: 09	
Manufacturin manufacturin	ng system ng system.	s and automated p Single station manu	oroduct facturi	tion lir	nes: Ma s.	nufacturing	systems	: compon	ents of a	
Manual Asse systems. Aut	embly line tomated pr	es, line balancing A roduction lines, App	Algorith lication	hms, m ns, Ana	ixed m lysis of	odel assemt transfer lin	oly lines, es.	lternative	assembly	
UNIT-IV	AUTOM	ATED ASSEMBLY	SYS	FEMS				C	Classes: 09	
Automated a part families Quantitative	assembly s, cooling, Analysis.	systems: Fundament production flow and	als, A alysis.	nalysis Group	of Ass Techno	embly syste logy and fle	ems. Cell exible Ma	ular manu nufacturin	facturing, g systems,	
UNIT-V	QUALIT	Y CONTROL ANI) SUPI	PORT	SYSTE	CMS		C	Classes: 09	
Quality cont strategies, A function dep time and lear	trol and stutomated loyment, on producti	upport systems: Qua inspection, contact v computer aided proc on.	ality ir √s non ess pla	n Desig contac anning,	n and 1 t, CMM concurr	manufacturi I. Manufact ent enginee	ng, inspe uring sup ring, shop	ction prin port syster o floor con	ciples and ns. Quality trol, just in	
Text Books:										

1. Mikell. P Groover, "Automation, Production system and computer integrated manufacturing", PHI, 3rd

Edition, 2012.

- 2. MikeJ P. Groover, "Automation, Production Systems and CIM", PHI, 1st Edition, 2001.
- 3. P. Radha Krishnan, S. Subrahamanyan, "CAD/CAM/CIM", New Age International, 1st Edition, 2005.

Reference Books:

1. Sadhu Singh, "Svstem Approach to Computer Integrated Design and Manufacturing", John wiley, 1st Edition, 1996.

2. Tien-Chien Chang, Richard A. Wysk ,Hsu-Pin Wang, "Computer Aided Manufacturing", Pearson, 1st Edition, 2009.

3. R Thomas Wright and Michael Berkeihiser, Good Heart, "Manufacturing and Automation Technology, Willcox Publishers, 1st Edition, 2012.

Web References:

1. https://www3.nd.edu/~manufact/MPEM_pdf_files/Ch14.pdf

2. http://www.journals.elsevier.com/journal-of-manufacturing-systems

E-Text Books:

1.http://www.automationmag.com/education/news/4721

2 http://www.e-booksdirectory.com/details.php?ebook=1120

INDUSTRIAL ROBOTICS

Group I: (CAD/CAM								
Cours	se Code	Category	He	ours / V	Week	Credits	Μ	laximum I	Marks
DO	COAL		L	Т	Р	С	CIA	SEE	Total
вс	C204	Elective	3	-	-	3	30	70	100
Contact C	lasses: 45	Tutorial Class	es: Nil	Prac	ctical Cla	asses: Nil	Tot	al Classes	: 45
OBJECTI The cours I. Unders II. Design III. Applyi IV. Design	VES: e should enablest stand of basic of robot with ng of robot pr of robot cell a	Die the students to automation and ro kinematic, dynan ogramming using and control in con	botic ir botic ir nic and robot la nputer a	n transf path cc anguag ided tra	er lines. ontrol. es. ansfer lir	nes.			
UNIT-I	INTRODUC	CTION TO AUT	OMAT	IC AN	D ROB	OTICS		Cla	sses: 09
Introductio volume, ro system and and feedba system.	Introduction: Automation and robotics, robot anatomy, robot configuration, motions joint notation work volume, robot drive system, control system and dynamic performance, precision of movement; Control system and components: basic concept and modais, controllers control system analysis, robot activation and feedback components, Positions sensors, velocity sensors, actuators sensors, power transmission system.								
UNIT-II	MOTION	N ANALYSIS AN	ND CO	NTRO	L			Cla	sses: 09
Motion ana homogeneo controller.	alysis and cont ous transformation	trol: Manipulator 1 ation, manipulator	kinemat path co	tics, po ontrol, 1	sition rep obot dyr	presentation namics, conf	forward t figuration	ransforma of robot	tion,
UNIT-III	END EFF	ECTORS AND	MACH	INE V	ISION			Cla	sses: 09
End effecto in gripper sensors in t Machine vi	selection and robotics. ision: function	types, operation, r design. Sensors: ns, sensing and dig	nechani Desiral gitizing	ism, for ble fear -imagin	rce analy tures, tac ng, devic	vsis, tools as ctile, proxin ces, lighting	end effect nity and r technique	etors considerange sense	deration ors, uses to digital
feature extr	raction, object	recognition, train	ing the	vision	system,	robotics app	ata reduc lication.	uon, segn	lentation
UNIT-IV	ROBOT	PROGRAMMIN	IG ANI	D ROB	OT LA	NGUAGES		Cla	sses: 09
Robot prog interpolation Textual rob	gramming: Le on, wait, signa oot languages,	ead through prog l and delay comm generation, robot	rammin ands, b languaş	ng, rob ranchin ge struc	ot progr ng capab ctures, el	ramming as ilities and li ements in fu	a path mitations inction.	in space, ; Robot lan	motion guages:
UNIT-V	ROBOT O	CELL DESIGN A	AND C	ONTR	OL			Cla	sses: 09
Robot cell in work de material tr application	design and co sign, work and ansfer, machi	ontrol: Robot cell d control, inter loo ne loading/unloa	layouts cks, erre ding, P	, robot or dete rocessi	centered ct ion, w ng opera	d cell, In-lin ork wheel c ation, assen	e robot co controller; ably and	ell, Consid Robot app inspection	erations blication: , feature

Text Books:

- 1. Mikell P. Groover, "Industrial Robotics", Tata McGraw Hill, 2nd Edition, 2012.
- 2. John. J Craig, "Introduction to Robotic Mechanics and Control", Prentice Hall, 3rd Edition, 2004.
- 3. H.Asada, J. J. E. Slotine, "Robot Analysis and Intelligence", Wiley, 1st Edition, 2013.

Reference Books:

- 1. King-Sun Fu, C. S. George Lee, "Robotics", Tata McGraw Hill, 1st Edition, 2013.
- 2. R. K. Mittal, I. J. Nagrath, "Robotics and Control", Tata McGraw Hill, 1st Edition, 2013.

Web References:

1. http://nptel.ac.in/courses/112101099/

2. http://www.journals.elsevier.com/robotics-and-computer-integrated-manufacturing

E-Text Books:

1. https://books.google.co.in/books/about/Industrial_Robotics.html?id=dr9IAI7wucUC

- 2. https://books.google.co.in/books/about/Robotics_Control_Sensing_Vis.html? id=_oYYRzSohJgC
- 3.https://books.google.co.in/books/about/Robot_Analysis_and_Control.html?id=Zz9SAAAAMAAJ&r edir_esc=y

SPECIAL MANUFACTURING PROCESSES

Group II: C	AD/CAM								
Course	Code	Category	Ho	ours / V	Week	Credits	N	laximum	Marks
BCC	205	Flooting	L	Т	P	С	CIA	SEE	Total
BCC.	205	Elective	3	-	-	3	30	70	100
Contact Cla	sses: 45	Tutorial Classe	s: Nil	Pra	ctical C	lasses: Nil	То	tal Classe	es: 45
OBJECTIV The course I. Underst II. Applyin III. Underst	ES: should enab anding the b g the advan anding of m	ble the students to basic surface treatm ced aspects in proc bodern trends in ma	: nent coa essing (nufactu	ting in of cerai	manufao mics. elds.	cturing.			
UNIT-I	SURFACE	TREATMENT						Cla	sses: 09
Surface treat methods of c ion implanta	ment: Scope coating, eco tion, diffusio	e, cleaners, method nomics of coating, on coating, diamor	ls of clo electro nd coati	eaning, formir ng and	surface ng, chem cladding	coating type iical vapor de g.	es, and ce eposition	eramic and , thermal s	l organic spraying,
UNIT-II	PROCESS	ING OF CERAM	ICS					Cla	sses: 09
elastomers, Pi elastomers, composites. UNIT-III Fabrication o lithography,	FABRIC	composites: Con plastics, metal mar CATION OF MICI etronic devices: Cry l packaging, reliabi	rix con ROELI ystal gru	E layers mposite ECTRO owth and l yield.	s, partic es, cerar DNIC D nd wafer	EVICES	, film dep	corced co es, polymo Cla position ox	mposites, er matrix asses: 09 kidation,
Printed Circu circuit econo	int boards, comics.	omputer aided desi	ign in n	nicro el	ectronic	s, surface mo	ount tech	nology, 1n	tegrated
UNIT-IV	E-MANU	FACTURING						Cla	sses: 09
E-manufactu machining.	ring: Nano	manufacturing tec	hniques	s and n	nicromac	chining, high	Speed n	nachining	and hot
UNIT-V	RAPID P	ROTOTYPING						Cla	isses: 09
Rapid protot method, appl	yping: Wor lications and	king principles, m l limitations, rapid	nethods tooling,	, stereo , techni	o lithogr ques of	aphy, laser rapid manufa	Sintering octuring	g, fused de	eposition
Text Books:									
 I Kalpakij R. A. Linc Rao. R. TI handbook", 1 Tai-Run H 2002. 	ian, "Manuf Iburg, "Proc hummala, E I st Edition, Isu, "MEMS	facturing Engineeri ess and Materials o ugene, J. Rymaszev 2013. S & Micro Systems	ng and of Manu wski, V s Desigi	Techno ufacturi an Nos n and n	ology", A ng",PHI trand nanufact	Adisson Wesl , 1 st Edition, Renihold, "N ure", Tata M	ley, 1995 1990. Aicroelec cGraw H	tronic pac [ill, 1 st Edi	kaging tion,

Reference Books:

1. Rao. R. Thummala, Eugene, J. Rymaszewski, Van Nostrand Renihold, "Microelectronic packaging handbook", 1st Edition, 2013.

2. Tai-Run Hsu, "MEMS & Micro Systems Design and manufacture", Tata McGraw Hill, 1st Edition, 2002

Web References:

1.https://www.google.co.in/#q=design+of+mems+and+microsystems+npte1 2. http://www.thelibraryofmanufacturing.com

E-Text Book:

1.http://royalmechanicalbuzz.blogspot.in/2015/04/manufacturing

ADVANCED MECHANICS OF SOLIDS

Group II: C	CAD/CAM									
Course	Code	Category	Ho	ours / V	Week	Credits	Μ	aximum	Marks	
DCC			L	Т	Р	С	CIA	SEE	Total	
BCC	206	Elective	3	-	-	3	30	70	100	
Contact Cla	asses: 45	Tutorial Classes	: Nil	Pra	ctical C	lasses: Nil	Tota	al Classes	s: 45	
OBJECTIVThe courseI.Understaenergy rII.UnderstaIII.DistinguIV.CompareUNIT-ISending ax	TES: should ena and the the elationship and the she tish bending e stresses in SHEAR C is and sh	able the students to: ory of elasticity inclus. ar force and bending g and shear stresses of n a shaft under torsio ENTRE hear center, shear	iding s mome levelop n and i center	tress, s nt diag ed in b n thin o	train, dis rams of beams of cylindric axi-syn	splacement a symmetrical various sect cal members.	nd Hooke beams. tions.	's law and Cla	l strain sses: 09 sections;	
Unsymmetri straight bear	cal bending ns due to n	g: Bending stresses is onsymmetrical bend	n beam ing.	is subje	ected to	nonsymmetr	ical bendi	ng, deflec	tion of	
UNIT-II	UNIT-IICURVED BEAM THEORYClasses: 09									
Winkler bac beams, close	ch formula ed ring subj	for circumferential ected to concentrated	stress, and u	limita niform	tions, co loads, s	prrection fact tresses in cha	tors, radia ain links.	l stress ir	n curved	
UNIT-III	TORSIO	DN						Cla	sses: 09	
Torsion of a solution, pra	cylindrica ndtl elastic	l bar of circular cros membrane (soap filr	ss secti n) anal	on; Sai ogy.	int vena	nt's semi inv	verse meth	ods, linea	r elastic	
Narrow rect thin wall tor of uniform the	angular cro sion mem hickness, d	oss section, hollow t bers with restrained iscs of uniform stren	thin wa ends a gth, rot	all tors xi-sym tating c	ion men metric p cylinders	nbers, multij problems: Ro 3.	ply connect tating disc	cted cross cs, flat dis	s section, scs, discs	
UNIT-IV	THEOR	Y OF PLATES						Cla	sses: 09	
Introduction equilibrium isotropic pla problem, sol subjected to segment, ser	: Stress re- equations : ates, strain lution of ci o concentra ni infinite l	sultants in a flat p for small displaceme energy of a plate, ircular plate problen ated load, boundary beam with concentra	late, k ent the bound n; Bear condi ted load	inematory of ary constant on ary constant on a second seco	tics: Str flat play nditions elastic f infinite its end, s	rain displace tes, stress str for plate, s oundation: g beam subje short beams.	ement rela rain tempe solution of general the ected to a	ations for erature rel f rectangu eory, infin a distribu	plates, lation for ilar plate ite beam ted load	
UNIT-V	CONTAC'	T STRESSES						Cla	sses: 09	
Introduction stresses is b bodies in p loads norma	, problem ased, expre oint contac l to area, st	of determining com- essions for principal et, stresses for two b resses for two bodies	tact str stresse odies s in line	resses, s, meth in conte e conta	assumption assumption assumption of a structure assumption of a structure assumption as a structure assumption as a structure assumption as a structure assumption as a structure as	tions on wh computing c r narrow rec al and tange	nich a sol ontact stre etangular a nt to conta	ution for esses, defl area (line ect area.	contact ection of contact),	
Text Books:										

- 1. Arthur P. Boresi, Richard, J. Schmidt, "Advanced Mechanics of materials" wiley international, 6th Edition, 2003.
- 2. J. P. Den Hortog, "Advanced strength of materials", Dover Publications, 1st Edition, 2012.
- 3. Timoshenko, "Theory of Plates", Tata McGraw Hill, 1st Edition, 2013.

Reference Books:

- 1. Stephen P. Timoshenko, S. Woinowsky Kriger, "Theory of Plates and Shells", Tata McGraw Hill, 2nd Edition, 2013.
- 2. James. O. Seely, Smith, B. Fred, "Advanced Mechanics of materials, John Willey, 1st Edition 1967.

Web References:

1.http://nptel.ac.in/courses/105106049/pdf-assignments/main.pdf 2.http://www.nptel.ac.in/syllabus/105101003/

3.http://numgeom.ams.sunysb.edu/shells/ThinPlatesAndShellsTheory

E-Text Books:

1. https://books.google.co.in/books/about/Advanced_mechanics_of_materials.html

2.http://155.207.34.6/files/Timoshenko.pdf

3. https://books.google.co.in/books/about/Strength_of_Materials.html?id=S5A-sZgcYM0C

DESIGN OPTIMIZATION

Group II: C	CAD/CAM								
Course	Code	Category	Ho	ours / V	Veek	Credits	N	Iaximum N	Marks
DCC	207		L	Т	Р	С	CIA	SEE	Total
BCC	207	Elective	3	-	-	3	30	70	100
Contact Cl	lasses: 45	Tutorial Class	es: Nil	Prac	ctical Cla	asses: Nil	То	tal Classes	: 45
OBJECTIN The course I. Underst II. Underst	ES: should ena anding the b anding pract	ble the students basic concepts tech tical use of optimi	to: hniques zation.	and apj	plications	s of design c	optimizatio	on.	
III. Applyin	g problem f	ormulation techni	ques			_			
UNIT-I	INTRODU	CTION TO DES	IGN OI	PTIMI	ZATION	N		Cla	sses: 09
General char formulation multivariabl	of objective of objective e optimization	of mechanical elements e function, design ion techniques.	ments, a constra	dequate unts, cl	e and opt assificati	on of optim	n, princip ization p	les of optin roblems, si	nization, ngle and
UNIT-II	OPTIMUM	I DESIGN PROP	BLEM I	FORM	ULATIO	DN		Cla	sses: 09
Technique of interpolation	of unconstra n methods, e	ined minimizatio equality and inequ	n, golde ality cor	en section nstraint	on, rando s.	om, pattern a	and gradie	ent search	methods,
UNIT-III	OPTIN	AUM DESIGN (CONCE	PTS				Cla	sses: 09
Direct method	ods and indi	rect methods usin	ıg penalt	ty funct	ion.				
Lagrange m	ultipliers, ge	eometric program	ming, st	ochasti	c prograi	nming, gene	etic algori	thms.	
UNIT-IV	PRACTI	CAL APPLICAT	FIONS	OF OP	TIMIZA	TION		Cla	sses: 09
Engineering cost, maxim	application um weight,	s, structural-desig design of shafts a	n applic nd torsio	ation at	xial and t bers, des	ransverse lo sign optimiz	aded mer ation of s	nbers for n prings.	ninimum
UNIT-V	OPTIMUM	I DESIGN PROF	BLEM I	FORM	ULATIO	DN		Cla	sses: 09
Dynamics a	pplications	for two degree fre	edom sy	/stem, v	ibration	absorbers, a	pplicatior	n in mechar	nisms.
Text Books	:								
1 C.Johnson 2. Goldberg Edition, 201	Ray, "Opti D. E. Addis 3.	mum Design of N son, "Genetic Alg	Iechanic orithms	cal elem in sear	nents", W ch Optim	viley, John &	& Sons, 1 ^s Machine'	^t Edition, 2 ', Wesley, 1	013. 13 th
Reference I	Books:								
 Kalyanan 2nd Edition, Jasbir S. J 	noy Deb, "(2013. Arora, "Intro	Optimization for a	Enginee um Des	ring De ign", A	esign Alg	gorithms and Press, 3rd E	d Exampl	es, Prentico 916.	e Hal,

Web References:

1. http://nptel.ac.in/courses/106104025/31 2.http://nptel.ac.in/courses/Webcoursecontents/IIScBANG/OPTIMIZATION%20METHODS/pdf/Mod ule_1/M1L2_LN.pdf

E-Text Books:

1.https://books.google.co.in/books?id=_edSAAAAMAAJ&source=gbs_navlinks_s&redir_esc=y 2.https://books.google.co.in/books/about/Optimization_for_Engineering_Design.html?id=JypoXt5hHrk C

COMPUTER AIDED PROCESS PLANNING

Group II:	CAD/CAM	/[
Cours	e Code	Category	Ho	ours / V	Veek	Credits	Max	kimum N	/larks
BCC	C208	Elective		Т	Р	C 2	CIA	SEE	Total
Contact (lasses: 45	Tutorial Classe	5 S: Nil	- Prac	- tical Cl	3 asses: Nil	30 Total	/U Classes	45
			5• I (II	Truc			1000	Clusses	
OBJECT	IVES:								
The cours	se should en	able the students	to:						
I. Under	standing the	basic concepts of puter aided process	compute	er aided	l process	planning.			
III. Under	rstanding the	e fundamental theory	ries and	techno	logies in	computer a	ided Process	planning	g.
LINUT_I	ΙΝΤΡΟΟΙ		DD		-	_		Cla	5505.00
Informatic	n requirem	ent for process	nlannin	a evete	m role	of proces	e planning	advant	ages of
convention	nal process	planning over CA	APP, st	g syste	of auto	omated proces	ess planning,	g system	n, feature
recognition	n, methods	; Generative CAP	P syste	em: Imp	portance	, principle	of generativ	e CAPF	system,
automation	n of logical	decisions, knowled	ge based	d systen	ns, infere	ence engine,	implementa	tion, ben	efits.
	RETRIEV	VAL CAPP SVST	FM AN	ID SFI	FCTIO	NOF			
UNIT-II	MANUFA	CTURING SEQU	JENCE			n or		Cla	sses: 09
Significan	ce, group t	technology, struct	ure, rel	lative a	advantag	ges, implen	nentation, an	nd appli	cations:
Selection	of manufac	turing sequence: S	Significa	ance, al	lternativ	e manufactu	uring process	ses, redu	ction of
total set up	cost for a p	barticular sequence,	quantit	ative m	ethods I	or optimal se	election.		
UNIT-III	DET	ERMINATION O	F MAC	CHININ	IG PAR	AMETERS	5	Cla	sses: 09
Reasons for surface qu	or optimal se ality.	election of machini	ing para	meters,	effect o	f parameters	s on producti	on i-ate,	cost and
Different a	approaches,	advantages of matl	hematic	al appro	oach ove	er convention	nal approach	, solving	
optimizati	on models o	of machining proces	sses.						
UNIT-IV	DETER	RMINATION OF	MANU	FACT	URING	TOLERAN	ICES:	Cla	sses: 09
Design tol integratior approach.	erances, main of design	anufacturing tolera and manufacturing	ances, 1 g tolerar	methods nces, ac	s of tol lvantage	erance allo s of integra	cation, sequ ted approach	ential ap 1 over se	pproach, equential
UNIT-V	GENERA TECHNIC	TION OF TOOL QUE FOR CAPP	PATH	AND I	MPLEN	MENTATIO	DN	Cla	sses: 09
Simulation optimal in CAPP: M system and	n of machin dex position IPLAN syst l benefits of	ing processes, NC as for executing fix tem, computer pro f CAPP, computer in	tool path ed sequ ogrammi integrate	h gener ence, qu ing lan ed plani	ation, gr uantitativ guages t ning syst	aphical imp ve method; tbr CAPP, o tems, and ca	lementation, Implementati criteria for s pacity planni	determin on techn electing ng syster	nation of iques for a CAPP m.
Text Book	S:								
1. Mikell I 3 rd Editi	P. Groover " on, 2013.	'Automation Produ	ction sy	stems a	and Com	puter Integra	ated Manufac	cturing S	ystem",

2. Sadhu Singh, "Computer Design and Manufacturing", S.K. Kataria & Sons, 1st Edition, 2013.

Reference Books:

- 1. Chang, T. C, Wysk, R. A, "An Introduction to Automated Process Planning", Prentice, 1st Edition, 1985.
- 2. Gallagher, C. C, Knight, W. A., "Group Technology: Production Method in Manufacturing", Ellis Horewood, 1st Edition, 1986.
- 3. Nilsson, N. J., "Principles of Artificial Intelligence", Springer, 1st Edition, 1982.
- 4. Cornelius, L.T, "Computer Aided and Integrated Manufacturing Systems: Manufacturing Processes" World scientific, 1st Edition, 2003.

Web References:

1. http://nptel.ac.in/courses/Webcoursecontents/IITdelhi/ComputerAidedDesign20ManufacturingII/Mo dule/p3.html

2. http://www.ignou.ac.in/upload/CRC.pdf

E-Text Books:

1.http://elsevierComputer-Aided-Process-Planning/H_P_-Wang/isbn-9780444886316/ 2.http://link.springer.com/chapter/10.1007%2F978-94-011-1250-5_15

ADVANCED AUTOMATIC CONTROL

Group III: CAD/	CAM							
Course Code	Category	Hour	rs / W	eek	Credits	Ν	laximum M	arks
		L	Т	P	С	CIA	SEE	Total
BCC209	Elective	3	-	-	3	30	70	100
Contact Classes:	45 Tutorial Cla	sses: Nil	Prac	ctical (Classes: Nil	То	tal Classes:	45
OBJECTIVES: The course shoul I. Understanding II. Applying the st systems.	d enable the studen the advanced concept tability, controllabilit	ts to: pts of state ty and obse	e space ervabil	approa lity issu	ach in control ues and synth	system. esis of ind	ustrial contro	bl
UNIT-I MATH	HEMATICAL MOI	DELS OF	LINE	CAR SY	(STEM		Class	ses: 09
Mathematical mod equations, lineariz	dels of linear system ing functions, lineari	n: Linear	systen rential	ns and equation	state equatio	ns, lineari	zation of no	n linear
UNIT-II LINE	AR ALGEBRA AN	D STATE	E VAR	IABLI	E ANALYSI	S	Class	ses: 09
degeneracy, norm analysis: State v characteristic equivariable models, s	s, GramSchmidt ort variable representati ation, eigen values, olution to state equa	honormali ion, conve eigen vec tions.	zation ersion ctors,	, subsp of st conver	aces and pro ate variable sion of trans	ojection the model t fer function	eorem; State o transfer on to canoni	variable function, cal state
UNIT-III STAF	BILITY OF CONTI OSERVABILITY	ROL SYS	TEMS	5 , CO I	NTROLLAI	BILITY	Class	ses: 09
Stability of contro of continuous data between stability t Controllability an	il systems: Bounded a system, Lyapunov ypes. d observability: Cor	input, bou stability, I ntrollability	nded o Lyapur y tests	output s nov's d for L?	stability, zero lirect method FI systems, r) input and , external s nodal cont	asymptotic stability, rela rollability ar	stability tionship nd
observability, cont	trol ability and obser	vability of	time v	varying	systems, dis	crete time	systems.	
UNIT-IV SYST	TEM REALIZATIO	ONS AND	OPT	IMAL	ESTIMATI(ON	Class	ses: 09
system realization state feedback an feedback, observe optimality, optima	s: Minimal realization ad observers: State ars, state estimator, r l estimator.	on, specifi feedback multivarial	ic real for S ble cas	ization ISO sy se, opti	, Markov par ystems, mult mal control	rameters, b ivariable o and estima	balanced real canonical for ation the prir	izations rms and nciple of
UNIT-V POLE	PLACEMENT AN	ND MODI	EL MA	ATCH	ING		Class	ses: 09
Pole Placement an multi variable unit	d Model Matching: u ty feedback system.	unity feedl	back co	onfigur	ation, implen	nentable tr	ansfer functio	on,

Text Books:

1. Katsuhiko Ogata, "Modern Control Engineering", Prentice Hall, 1st Edition, 2002.

2. F. H. Raven, "Automatic control Theory", Tata McGraw Hill, 1st Edition, 1995.

3. B. C. Kuo, "Automatic Control System", Prentice Hall, 5th Edition, 1995.

4. C. T. Chen, "Linear System Theory & Design", Oxford University Press, 3rd Edition, 1999.

Reference Books:

1. H. L. Harrison, J. G. Bollinger, "Automatic Controls", International Text Book Company, 1970.

- 2. J. S. Bay, "Fundamentals of Linear State Space Systems", Tata McGraw 1st Edition, 1999.
- 3. S. N. Norman, "Control Systems Engineering", Wiley 1st Edition, 2003.

Web References:

1.https://www.google.co.in/?gfe_rd=cr&ei=HeWGV4yuM6aM8QfPxYPIBQ&gws_rd=ssl#q=advance d+automatic+control

2. http://nptel.ac.in/syllabus/108103007/

E-Text Books:

1. https://books.google.co.in/books?id=A93AAAQBAJ&pg=PA430&lpg=PA430&dq=H.+L.+Harrison, +J.+G.+Bollinger,+"Automatic+Controls"

2. https://books.google.co.in/books/about/Modern_Control_Engineering.html?id=Wu5GpNAelzkC

DESIGN FOR MANUFACTURING OF MEMS AND MICRO SYSTEMS

Course	Code	Category	H	ours /	Week	Credits	N	Maximur	n Ma	rks		
			L	Т	P	С	CIA	SF	E	Total		
BCC	210	Elective	3	-	-	3	30	70		100		
Contact Cl	asses: 45	Tutoria	l Cla	asses: I	Nil	Nil Practical Classes: Nil Total Classe						
OBJECTIV	/ES:											
The course I. Unc II. App III. Enu	should en lerstanding blying adva merate fur	able the stud g of modern tr inced aspects adamental the	l ents rends of en ories	to: in desi abling and tee	gn and comput chnolog	manufacturing u er aided technolo ies in computer a	sing CAD/C ogies used in aided manuf	CAM. n design. acturing.				
UNIT-I	OVERV MICRO	IEW AND V SYSTEMS	VOR	KING	PRINO	CIPLES OF ME	EMS AND		Cla	asses: 09		
Overview an micro fabric MEMS in ir micro fluidi	nd working ation, mic ndustries, m es.	g principles of rosystems and nicro sensors	f men 1 mic , mic	ns and roelect ro actu	microsy ronics, ation, N	ystems: MEMS a microsystems an IEMS with micr	nd microsys nd miniaturiz o actuators 1	stems, evo zation, ap micro acc	olutic plica celerc	on of tions of ometers,		
UNIT-II ENGINEERING SCIENCE FOR MICROSYSTEMS DESIGN AND Classes: 09												
Engineering ionization, r Process, pla	science fo nolecular t sma physic	or microsyster heory of mate cs, electroche	ns de er and mistr	sign ar 1 interr y, quar	nd fabrio nolecul ntum ph	cation: Atomic st ar force, doping ysics.	ructure of m of semicond	hatter, ior luctors, d	is and iffusi	l on		
UNIT-III	ENGINI FABRIC	EERING SC CATION	IENO	CE FO	R MIC	ROSYSTEMS	DESIGN A	ND	Cla	usses: 09		
Engineering	mechanics	s for microsys	stems	design	n: Static	Bending of thin	Plates, mec	hanical v	ibrati	on.		
Thermo me	chanics fra	acture mechai	nics,	thin-fil	m mech	anics, overview	of finite eler	ment stre	ss ana	alysis		
UNIT-IV	THERM	IO FLUID E	NGI	NEER	ING A	ND MICROSYS	STEMS DE	SIGN	Cla	asses: 09		
Thermo flui meso scales computatior and nano sca solids in sub design using	d engineeri , basic equ hal fluid dy ale, overvie o micromet g finite eler	ing and micro ations in cont namics, incor ew of heat con er scale, designent method,	syste inuu npres nduct gn co desig	ms des m fluid ssible fl ion in s onsidera gn of a	ign: Ov dynam luid flov solids, ł ations, ŗ silicon	erview of basics ics, laminar fluid w in micro condu- neat conduction i process design m die for a micro p	of fluid me d flow in circ uits, fluid flo n multilayer echanical de pressure sens	chanics i cular con ow in sub red thin fi esign, me sor.	n ma duits micr lms a chan	cro and , rometer and in ical		
UNIT-V	MATER FABRIC	CATION	MEN	IS, MI	CROS	YSTEMS AND	THEIR		Cla	isses: 09		
Materials for materials, S Quartz, Piez oxidation, c	or mems an ilicon as a zoelectric C hemical an	d microsyster substrate mat Crystals and P d physical va	ns ar erial olym por d	nd their , Silico ers, Ph lepositi	fabrica n Comp otolithc on, Etcl	tion: Substrates a bounds, Silicon F bgraphy, Ion imp hing, Bulk micro	and Wafers, Piezoresistor lantation, D manufactur	Active so s, Galliun iffusion a ing, Surf	ubstra m Ars and ace	ate senide,		

Text Books:

- 1. Tai-Ran Hsu, "MEMs & Microsystems: Design & Manufacture", Tata McGraw Hill, 1st Edition, 2002.
- 2. M. Maluf, "An Introduction to Microelectromechanical Systems Engineering", Artech House,1st Edition, 2000
- 3. Trimmer, W.S.N, "Micro robots and Micromechanical Systems Sensors & Actuators", 19th Edition, 1989.

Reference Books:

- 1. Madou, M, "Fundamentals of Microfabrication", CRC Press, 1st Edition, 1997.
- Hsu, T.R, "The Finite Element Method in Thermomechanics", Alien & Unwin, London, 1st Edition, 1986.

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1. http://nptel.ac.in/courses/117105082/

2. https://www.mems-exchange.org/MEMS/what-is.html

E-Text Books:

1.http://ebooks.cawok.pro/Artech.House.Publishers.An.Introduction.to.Microelectromechanical.System s.Engineering.2nd.edition.eBook-LiB.pdf

2. http://www.springer.com/la/book/9783540850557?token=prtst0416p

INTELLEGENT MANUFACTURING SYSTEM

Course Code Category Hours / Week Credits Maximum Marks BCC211 Elective L T P C CIA SEE Total BCC211 Elective 3 - - 3 30 70 100 Contact Classes: 45 Tutorial Classes: Nil Practical Classes: Nil Total Classes: 45 OBJECTIVES: The course should enable the student to: 1 Understanding of basic computer integrated manufacturing. II. Applying the knowledge based system in manufacturing. III. Applying of machine learning and group technology in manufacturing system. Classes: 09 Computer integrated manufacturing systems structure and functional areas of CIM system, CAD, CAPP, CAM, CAQC, ASRS. Advantages of computer aided manufacturing, manufacturing communication system. Null and tala redundancy, top-down and bottom-up approach, volume of information, intelligent manufacturing systems, basic components, system architecture and data flow, system operation. Classes: 09 UNIT-II KNOWLEDGE BASED SYSTEM Classes: 09 Components of knowledge based systems, basic components of knowledge based systems, knowledge acquisition. Classes: 09 UNIT-III MACHINE LEARNING Classes: 09 Machine learning,	Group III: CAD/CAM	1											
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Automated process planning: Variant approach, generative approach, expert systems for process planning, feature recognition, phases of process planning. Knowledge based system for equipment selection, manufacturing system design. equipment selection Problem, modeling the manufacturing equipment selection problem, problem solving approach in KBSES, structure of the KRSES. UNIT-V GROUP TECHNOLOGY Classes: 09 Group technology: Models and algorithms visual method, coding Method, cluster analysis method, matrix formation, similarity coefficient method, sorting based algorithms, bond energy algorithm, cost based method, cluster identification method, extended CI Method; Knowledge based group technology, group technology in automated manufacturing system structure of knowledge based system for group	UNIT-IV SYSTEM							Cla	sses: 09				
feature recognition, phases of process planning.Knowledge based system for equipment selection, manufacturing system design. equipment selectionProblem, modeling the manufacturing equipment selection problem, problem solving approach in KBSES, structure of the KRSES.UNIT-VGROUP TECHNOLOGYClasses: 09Group technology: Models and algorithms visual method, coding Method, cluster analysis method, matrix formation, similarity coefficient method, sorting based algorithms, bond energy algorithm, cost based method, cluster identification method, extended CI Method; Knowledge based group technology, group technology in automated manufacturing system structure of knowledge based system for group	Automated process plan	ning: Variant appro	ach, gei	nerative	e approa	ch, expert s	systems for	process p	olanning,				
Knowledge based system for equipment selection, manufacturing system design. equipment selection Problem, modeling the manufacturing equipment selection problem, problem solving approach in KBSES, structure of the KRSES. UNIT-V GROUP TECHNOLOGY Classes: 09 Group technology: Models and algorithms visual method, coding Method, cluster analysis method, matrix formation, similarity coefficient method, sorting based algorithms, bond energy algorithm, cost based method, cluster identification method, extended CI Method; Knowledge based group technology, group technology in automated manufacturing system structure of knowledge based system for group	feature recognition, pha	ses of process plann	ing.										
Problem, modeling the manufacturing equipment selection problem, problem solving approach in KBSES, structure of the KRSES. UNIT-V GROUP TECHNOLOGY Classes: 09 Group technology: Models and algorithms visual method, coding Method, cluster analysis method, matrix formation, similarity coefficient method, sorting based algorithms, bond energy algorithm, cost based method, cluster identification method, extended CI Method; Knowledge based group technology, group technology in automated manufacturing system structure of knowledge based system for group.	Knowledge based syst	em for equipment	selectio	on, mar	nufacturi	ng system	design. ec	quipment	selection				
KBSES, structure of the KRSES. UNIT-V GROUP TECHNOLOGY Classes: 09 Group technology: Models and algorithms visual method, coding Method, cluster analysis method, matrix formation, similarity coefficient method, sorting based algorithms, bond energy algorithm, cost based method, cluster identification method, extended CI Method; Knowledge based group technology, group technology in automated manufacturing system structure of knowledge based system for group	Problem, modeling the	e manufacturing e	quipme	nt sele	ection pr	roblem, pr	oblem sol	ving appr	oach in				
UNIT-VGROUP TECHNOLOGYClasses: 09Group technology: Models and algorithms visual method, coding Method, cluster analysis method, matrix formation, similarity coefficient method, sorting based algorithms, bond energy algorithm, cost based method, cluster identification method, extended CI Method; Knowledge based group technology, group technology in automated manufacturing system structure of knowledge based system for group	KBSES, structure of the	e KRSES.											
Group technology: Models and algorithms visual method, coding Method, cluster analysis method, matrix formation, similarity coefficient method, sorting based algorithms, bond energy algorithm, cost based method, cluster identification method, extended CI Method; Knowledge based group technology, group technology in automated manufacturing system structure of knowledge based system for group.	UNIT-V GROUP T	ECHNOLOGY						Cla	sses: 09				
formation, similarity coefficient method, sorting based algorithms, bond energy algorithm, cost based method, cluster identification method, extended CI Method; Knowledge based group technology, group technology in automated manufacturing system structure of knowledge based system for group	Group technology: Mod	lels and algorithms	visual n	nethod,	coding	Method, clu	uster analy	sis method	l, matrix				
method, cluster identification method, extended CI Method; Knowledge based group technology, group	formation, similarity co	pefficient method, s	sorting	based a	algorithn	ns, bond ei	nergy algor	rithm, cos	t based				
THE THE TAXABLE TO ALL ADDITION TO ALL ADDITION AND A DOTATION AND A DOTATION AND ADDITION AND ADDITION AND ADDITION AND ADDITIONAL ADDITI	method, cluster identifi	cation method, extended	ended (J Metl	nod; Kno	wiedge ba	ised group	technolog	y, group				
technology (KBSCIT), data Base, knowledge base, clustering algorithm	technology (KBSCIT)	data Base knowled	syste lge hase	n, sưu e. cluste	ering alg	orithm	b based sys	stem for g	roup				

Text Books:

- 1. Andrew Kusiak, "Intelligent Manufacturing Systems", Prentice Hall, 1st Edition, 1990.
- 2. Yagna Narayana, "Artificial Neural Networks", PHI, 1st Edition, 2006.
- 3. M. P. Groover, "Automation, Production Systems and CIM", PHI, 2nd Edition, 2007.
- 4. Simon Hhaykin, "Neural networks: A comprehensive foundation", PHI, 1st Edition, 1994

Reference Books:

- 1. B.yegnanarayana, "Artificial neural networks", PHI, 1st Edition, 2004.
- 2. Li Min Fu, "Neural networks in Computer intelligence", TMH, 1st Edition, 2003.
- 3. David M. Skapura, James A. Freeman, "Neural networks", Pearson education, 1st Edition, 2004.
- 4. Jacek M. Zurada, "Introduction to Artificial Neural Systems", JAICO Publishing House 1st Edition, 2013.

Web References:

1, http://nptel.ac.in/courses/117105084/

- 2. http://prolog.univie.ac.at/teaching/LVAs/Layout_und_Design/SS09/Skript%20insel.pdf
- 3. http://nptel.ac.in/courses/106106139/
- 4. http://nptel.ac.in/courses/106106126/

E-Text Books:

 $1. https://books.google.co.in/books/about/Intelligent_manufacturing_systems.html?id=5RVUAAAAMAAJ&hl=en$

2.https://books.google.co.in/books/about/ARTIFICIAL_NEURAL_NETWORKS.html?id=RTtvUVU_xL4C

3.https://donvalebooks.com/pdf-automation-production-systems-and-cim-groover-second-edition.html

EXPERT SYSTEMS DESIGN

Group III:	CAD/CAM											
Cou	rse Code	Category	H	ours / V	Veek	Credits	Ν	laximum	Marks			
D	20212		L	Т	Р	С	CIA	Maximum SEE 70 otal Classe neering sys Cla on to expe). Cla cla cla cla cla cla cla cla c	Total			
BO	JC212	Elective	3	-	-	3	30		100			
Contact	Classes: 45	Tutorial Class	es: Nil	Pr	actical (Classes: Nil	To	tal Classe	s: 45			
OBJECTIV The course I. Underse II. Applyin III. Designi	VES: e should enable t tanding concepts ng the pattern ma ing of expert syst	he students to: , techniques and tool tching techniques. em design.	ls for de	velopin	g expert s	systems for va	rious engir	neering sys	stems.			
UNIT-I	INTRODUCT	TION TO EXPERT	SYSTE	EM DE	SIGN			Cla	asses: 09			
Introduction languages: (n: Overview: Eve CLIPS (Clanguag	olution and characted ge integrated produc	eristics ction sys	of knov tem) an	vledge ba d JESS (j	ased system; ava expert sys	Introduction stem shell)	on to expe	ert system			
UNIT-II	PATTERN MATCHING Class							30 70 10 Total Classes: 45 arious engineering systems. Classes: (Introduction to expert syst stem shell). Classes: (and control: Salience, phate Classes: (and control: Salience, phate Classes: (and control: Salience, phate Classes: (and Dangers of computation ucertainty Classes: (and Course Technology, Uclasses: (
Pattern mat and control	ching: Basic and facts, modules ar	advanced pattern in advanced pattern in a secution control	matching	g techni	ques; Mo	odular design	and control	ol: Salienc	ce, phases			
UNIT-III	KNOWLEDG	E REPRESENTA	TION					Cla	asses: 09			
Knowledge	representation: P	Productions, semanti	c nets, s	chemata	a, frames	, logic and sets	s.					
Methods of	Inferences: Infer	ence rules, resolutio	n systen	n, forwa	rd and ba	ackward chain	ing.					
UNIT-IV	REASONING	UNDER UNCER	FAINT	Y				Cla	asses: 09			
Reasoning u rationality, Markov cha probability, rules, certai	Inder Uncertainty CSUS Library vi ains, uncertainty subjective proba nty factors, Demj	y: Hubert Dreyfus fr ideo collection, hyp in inference chains ibility, Bayes' theore pster-Shafer theory.	om Socr othetica s; Proba em, inex	ates to e l reason bility-ba act or h	expert system ing and lased tech euristic r	stems: Limits backward indu niques: Objec easoning; Inex	and Dange action, tem ctive proba kact reason	ers of comporal reas ability, explicitly,	putational soning and perimental rtainty and			
UNIT-V	DESIGN OF	EXPERT SYSTEM	IS					Cla	asses: 09			
Design of e	xpert systems: Ap	pproximate reasonir	ng, fuzzy	v expert	system.							
Text Books	•											
 1.J. C. Gian 2004. A. Gonza 	ratano, G. D. Rile alez, D. Dankel, '	ey, "Expert Systems 'The Engineering of	: Princip Knowle	les and edgeBas	Programi ed Systei	ming", 4th Ed	ition., Cou Hall, 1 st Ec	rse Techn lition, 199	ology, 4.			
Reference	Books:											
1. P. Jackso 2. R. Akerk	n, "Introduction ar, P. Sajja, "Kno	to Expert Systems", wledge-Based Syste	Addisor ems", Jo	n Wesle nes & E	y, 3 rd Edi Sartlett Pu	tion, 1998. Iblishers, 1 st E	dition, 200)9.				
Web Refer	ences:											
1.http://npte	el.ac.in/courses/W	Vebcoursecontents/I	IT%20K	Charago	ur/Artific	ial%20intellig	ence/pdf/I	Lesson%2	018.pdf			

2.http://nptel.ac.in/courses/106105077/25

E-Text Books:

- 1. http://www.worldcat.org/title/expert-systems-design-and-development/oclc/622154797
- 2. https://www.cs.ru.nl/~peterl/proe.pdf

STRESS ANALYSIS AND VIBRATION

Group IV: CAD/CAN	I									
Course Code	Category	He	ours / V	Week	Credits	Μ	MaximumIASEE070Total Classe.Clan in polar coordClar plates, introducedCla· plates, introducedClaof freedomClaof freedomClaon, 1970.Claon, 1970.Claon, 1970.Claon, 2013.Edition, 2013.	Marks		
		L	Т	Р	С	CIA	MaximumZIASEE3070Total Classe1.Classe1.Classem in polar coordClasseTClasseTClasser plates, introdClassec of freedomClassec of freedomClasse <th>Total</th>	Total		
BCC213	Elective	3	-	-	3	30		100		
Contact Classes: 45	Tutorial Classes	: Nil	Pra	ctical C	lasses: Nil	Tot	al Classes: 45			
OBJECTIVES: The course should ena I. Understanding of me II. Applying vibration t	able the students to: odern trends in desig heory for engineerin	; gn and r g.	nanufa	cturing u	using CAD/C	CAM.				
UNIT-I INTRODU	JCTION OF THEC	ORY O	F ELA	STICIT	Y		Cla	sses: 09		
Two dimensional elast Thick cylinders, Rotatin	icity theory in Cartenny discs, stress conce	esian co	oordina n.	ites, plai	ne stress pro	blem in	polar coo	rdinates,		
UNIT-II STRESS A STRESSE	NALYSIS OF SYN S	MMET	RIC B	ODIES	AND CON	ГАСТ	Cla	sses: 09		
Torsion of non circular shell theory, contact str	prismatic sections, a esses.	rectang	ular an	d axi-sy	mmetric, cir	cular plat	es, introdu	uction to		
UNIT-III FREE AN	ND FORCED VIBR	RATIO	NS				Cla	sses: 09		
Single degree freedom,	two degree freedom	system	n witho	ut and w	ith damping		1			
Free and forced vibration	ons, transient vibratio	ons.								
UNIT-IV TRANSI	ENT VIBRATIONS	S					Cla	sses: 09		
Transient vibrations of applications of matrix r	f single and two d nethods, continuous	egree i system	freedor s.	n syster	ns, multi-de	gree of	freedom s	systems,		
UNIT-V CONTINU	JOUS SYSTEMS						Cla	sses: 09		
Free and forced vibrat methods.	ions of strings bars	and be	eams, p	orinciple	of orthogo	nality, cla	assical and	l energy		
Text Books:										
1. S.P. Timoshenko, J. 2. 3. J. P. Den Hartog, '	N. Goodier, "Theory 'Mechanical Vibratio	v of Ela ons", D	sticity" over Pu	, Mc Gr iblicatio	aw Hill, 3rd ns, 1 st Editio	Edition, 1 n, 2013.	970.			
Reference Books:										
1. W. T. Thomson, "Th 2. S. S. Rao, "Mechanic	eory of Vibrations w cal Vibrations", Add	vith Apj ison We	plicatic esley L	ons", CB ongman	S Publishing	, 3 rd Editi	on, 2013.			
Web References:										
1. http://nptel.ac.in/Cour 2. http://nptel.ac.in/cour	rses/11210311/ ses/112106068/									
E-Text Book:										
1.https://aerocastle.files	s.wordpress.com/201	2/10/m	echani	cal_vibr	ations_5th-e	dition_s-s	s-rao.pdf			

COMPUTER AIDED ANALYSIS OF MECHANICAL SYSTEM

Group IV: CAD/CA	AM							
Course Code	Category	H	ours / V	Veek	Credits	Μ	aximum	Marks
BCC214	Flective	L	Т	Р	C	CIA	SEE	Total
DCC214	Elective	3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes	: Nil	Pra	ictical C	lasses: Nil	Tota	al Classe	s: 45
OBJECTIVES: The course should e I. Understanding th II. Analysis of kiner III. Understanding th	enable the students to: ne computer based design to matics and dynamics of me ne concept of expert system	ools for a echanical and thei	nalysis. system. r applica	ation in (CAD.			
UNIT-I INTRO SYSTE	DUCTION TO COMPU	J TER AI	DED A	NALYS	IS OF MECH	ANICAL	Cla	asses: 09
Introduction: Introdu mechanical systems;	ction to mechanical syst Vector loop methods, vector	ems ana	ılysis, k methods	inematic	e modeling: N	Modeling t	he kiner	natics of
UNIT-II SOLU	FION OF KINEMATIC	MODEL	'S				Cla	asses: 09
Solution of Kinemat analytical solutions of method solutions of	tic Models: Solution of ki of position, velocity, accele velocity and acceleration pr	inematic ration pro roblems.	models oblems;	for disp Numerio	placements, ve cal solution of	locities, ac position pr	celeration oblem; M	ns; Direct Iatrix
UNIT-III DYNA	MIC MODELING						Cla	asses: 09
Dynamic modeling: I Newton-Euler metho to define dynamic co	Modeling the dynamics of a ods to define dynamic consonstraints between input an	mechanic straints b d output	cal syste etween links.	ms. forces, n	noments, and a	acceleration	s, energy	/ methods
UNIT-IV SOLU	FIONS OF DYMNAMIC	S MOD	ELS				Cla	asses: 09
Solution of Dynamic forward dynamics me method of integration	cs Models: Solution of inv odels using numeric integra n, Runge-Kutta methods of	verse dyr ation, mo integrati	namics r odel forn ion, mod	nodels fond nulation leling an	or joint-link fo into standard f d analysis of th	orces and to format for some Trebuch	orques, so olution, l et mechai	olution of Euler's nism.
UNIT-V ADVA	NCED DYNAMIC ANAI	LYSIS A	ND SIN	IULAT	ION		Cla	asses: 09
Advanced dynamic a equations, causality,	nalysis and simulation: Bo and simulation.	nd graph	modelin	ig of dyn	amic systems,	generation	of syster	n
Text Books:								
 Norton R., "Design Palm W. J., "Introd Nikravesh, P. E., " 	n of Machinery", McGraw duction to MATLAB 6 for Computer-Aided Analysis	Hill, 199 Engineer of Mech	02. rs", Tata anical S	McGrav ystems",	w Hill, 1 st Editi Prentice Hall,	ion, 2000. 1988.	_	
Reference Books:								
1. Haug, E. J., "Comp 1984.	puter Aided Analysis and (Optimiza	tion of $\overline{\mathbf{N}}$	Aechanic	cal System Dyr	namics", Sp	ringer-V	erlag.
2. Mukherjee, A., Ka	rmaker, R. and Samantaray	, А.К., "	Bond G	rapn 1n N	viodeling, Sim	ulation and	Fault	

identification", I & K International 1st Edition, 2007.

Web References:

1. http://nptel.ac.in/courses/106105077/

2. http://nptel.ac.in/courses/Webcourse-contents/IITKharagpur/Artificialintelligence/New_index1.html

E-Text Books:

1.http://www.ulb.ac.be/scmero/documents/Teaching/Mecah405/MecaH405_part1.pdf 2.http://link.springer.com/book/10.1007%2F978-3-642-52465-3

SIMULATION MODELING OF MANUFACTURING

Group IV: CAD/CA	М							
Course Code	Category	Hou	rs / V	Veek	Credits	M	aximum M	larks
		L	Т	Р	С	CIA	SEE	Total
BCC215	Elective	3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: Nil	Pra	actica	al Clas	ses: Nil	Tota	Maximum Mar ZIA SEE 30 70 Total Classes: 45 G thermal systems. G thermal systems. G classes tems, types of meculus, Cartesian temerical differentiation Classes tems, types of meculus, Cartesian temerical differentiation Classes uid mechanics and teristics of contir SES Classes entum and energy ystem; Dynamics o Classes colspan="2">classes rdinary differential rical simulation of Classes rdinary differential rical simulation of Classes ress. 2007. Yeress. 2007.	45
OBJECTIVES: The course should en I. Understand conce II. Apply the fluid m	able the students to: epts, techniques and too nechanics and heat transfe	ls for a er with	mode discr	ling ar ete con	nd simulatio tinuous sys	on of therr tems.	nal system	S.
UNIT-I INTRODU PRELIMI	UCTION TO MODELI INARIES	ING AI	ND M	[ATH]	EMATICA	L	Clas	ses: 09
Introduction to Mode steps in simulation st vector spaces and line and integration.	ling: Concept of system tudy; Mathematical pre ear transformations; Inte	m, con liminar erpolati	itinuc ies: on ai	ous an Review nd extr	d discrete v of vector apolation; 1	systems, calculus, Numerical	types of Cartesian differentia	models, tensors, ttion
UNIT-II DISCRET	TE AND CONTINUOU	J <mark>S SY</mark> S	STEN	MS			Clas	ses: 09
Discrete and Continu transfer; Characteristi systems based on diffe	ous systems: Continuou ics of discrete systems erential equations; Invers	us and , eiger se probl	disc valu lems;	rete sy e prol	vstems from blems; Ch	n fluid me aracteristic	echanics and solves of con	nd heat tinuous
UNIT-III MATH	EMATICAL MODELI	NG O	F TI	HERM	IAL PROC	CESSES	Clas	ses: 09
Mathematical modelin balance; Classification Dimensional analysis,	ng of thermal processes: n of governing equations model development for	Conse , bound variou	ervation lary c is the	on law conditie ermal j	vs, mass, m ons. processes a	nd system;	and energy	s of
thermo-fluid systems.	ATION OF THERMA	LSVS	TEN	AS			Clas	ses• 09
Simulation of Therma equations; Numerical steady state and dynar	l Systems: Numerical me solution of linear and non nic systems.	ethods f	for so algeb	lution praic ed	of partial ar quations; Nu	nd ordinary umerical si	differentia mulation o	al f
UNIT-V OPTIM	IZATION OF THERM	MAL S	SYST	EMS			Clas	ses: 09
Optimization of Therr constrained single and	mal Systems: Introduction d multivariable optimiza	on to o tion, d	ptimi ynam	zation ic inte	, formulation	on of objectometric pr	ctive funct	ion, g.
Text Books:								
1 Y. Jaluria, "Design a 2. Bejan, A., Tsatsaron 1995.	and Optimization of Ther nic, G., and Moran, M., "	mal Sy Therm	stems al De	s", 2nd sign ar	Edition, CH nd Optimiza	RC Press. 2 ation", John	2007. n Wiley & 1	Sons.
3. Close, C. M., and Fi 2001.	rederick, D. K., "Modelir	ng and .	Analy	sis of	DynamicSy	vstems", Jo	hn Wiley 8	z Sons.

Reference Books:

1. Jaluria, Y. "Computer Methods for Engineering with MATLAB Applications", 2nd Edition, CRC Press. 2011.

2. W. H., Teukolsky, S. A., Vetterling, W. T., Flannery, B. P., "Numerical Recipes: The Art of Scientific Computing", Third Edition, Cambridge UniversityPress, 2007.

Web References:

1.https://www.youtube.com/watch?v=-gYcZt5iKPA

2.https://www.google.co.in/#q=simulation+modelling+of+manufacturing

E-Text Book:

1. http://www.mescenter.ru/images/abook_file/ManufacturingSystems.pdf

DATA COMMUNICATION IN CAD/CAM

Group IV:	CAD/CA	М										
Course	Code	Category	Hou	irs /	/ Week	Credits	Ι	Aaximum	n Marks			
	BCC216 Elective I T P C CIA S act Classes: 45 Tutorial Classes: Nil Practical Classes: Nil Total CCTIVES: ourse should enable the students to: nderstanding the basic concepts of computer and microprocessors. Image: Computer and microprocessors. lentify the function of operating system. pplying the data communication and networking in transmission of data. '-I COMPUTERS AND MICRO PROCESSORS Giagram, register transfer language, logic and shift micro operations, instruction cool instruction cycle, input and output, interrupt design of basic computer, mably language, assembler, registers arithmetic logic unit and bus Systems, times, machine cycle and timing diagram, functional block diagrams of 8086 and mode es of pentium processors. '-II OPERATING SYSTEM AND ENVIRONMENTS c, functions, UNIX and WINDOWS NT, architecture, graphical user interfaces, con source program the phases of a compiler, cousins of the compiler, grouping of phas uction tools. '-III DATA COMMUNICATION AND NETWORKING	SEE	Total									
всс	216	Elective	3	-	-	3	30	70	100			
Contact Cl	asses: 45	Tutorial Classes: Nil	Pr	acti	cal Class	ses: Nil	Το	Maximum Marks CIA SEE Tota 30 70 100 Total Classes: 45 Classes: 0 uction code, training ar uetr, machine languagems, timing and cont and modes of operation Classes: 0 aces, compilers, analys g of phases, compiler Classes: 0 smission concepts an nication, base band Classes: 0 tandardization, Classes: 0 tandardization, Classes: 0 tem and network				
OBJECTT The course I. Unders II. Identify III. Applyi	VES: e should en tanding the y the functi ng the data	able the stude nts to: basic concepts of component of operating system. communication and netwo	uter and vorking	d mi ; in t	croproces ransmiss	ssors. ion of data.						
UNIT-I	COMPU	TERS AND MICRO P	ROCE	SSC	RS			Cl	asses: 09			
control ins assembly 1 signals, ma features of	truction cy anguage, a chine cycle pentium pr	vcle, input and output, assembler, registers arith e and timing diagram, fu occessors.	interru interru inctiona	ipt o logi al bl	design o c unit a lock diag	f basic con and bus Sy rams of 80	nputer, stems, 86 and 1	machine timing ar nodes of	language, nd control operation,			
UNIT-II	OPERA	FING SYSTEM AND E	NVIR	ON	MENTS			Cl	asses: 09			
Types, func of the sourc construction	ctions, UNI ce program n tools.	X and WINDOWS NT, the phases of a compiler	archite , cousii	ctur ns of	e, graphie f the com	cal user inte piler, group	erfaces, ing of p	compilers hases, cor	, analysis npiler			
UNIT-III	DATA C	OMMUNICATION AN	ND NE	TW	ORKIN	3		Cl	asses: 09			
Data comm terminology	nunication y guided tra	and networking, proto insmission media.	cols a	nd a	architectu	ıre, data tı	ansmiss	ion conce	epts and			
Wireless tr interface sta	ansmission andards RS	, data encoding, asynch 232C, and RS449 interfa	ronous ace.	and	synchro	nous comn	nunicatio	on, base t	and			
UNIT-IV	NETWO	RKING STRUCTURE						Cl	asses: 09			
Network str managing r	ructure, net emote syste	work architecture, OSI re ems in network, network	eferenc file sys	e mo stem	odel servi s, networ	ces, networ king in mar	k standa nufacturi	rdization, ng.				
UNIT-V	INTERN	ET						Cl	asses: 09			
Internet ser requiremen	vices, Prote ts Internet	ocols, intranet information tools, usenet, e-mail, IRC	on servi C, www	ces, , FT	mail base P, Telnet	ed service, s	system a	nd networ	k			
Text Books	5:											
 Morris M Gaonkar International Paterson 	Iano. M., " R.S., "Mic al, 1997.	Computer System Archit roprocessor Architecture	ecture" , Progr	, Pre amn	entice Ha	Il of India, 1 Application	I st Editions of 808	on, 1996. 5", Penrat	m 1 st			
J. FEIEISOII	J.L., Galvi	ii i . and Shberschaz, A.,	Opera	սшք	systems	Concepts	, Auuiso	ii westey,	, 1			

Edition, 1997.

Reference Books:

1. Alfred V. Aho, Ravi Setjhi, Jeffrey D Ullman, "Compilers Principles Techniques and Tools", Addison Wesley,

1986.

- 2. William Stallings, "Data of Computer Communications" Prentice Hall of India, 1997.
- 3. Andrew S. Tanenbanum "Computer Networks", Prentice Hall of India, 3rd Edition, 1996.
- 4. Christian Crumlish, "The ABC's of the Internet", BPB Publication, 1996.

Web References:

- 1. http://nptel.ac.in/downloads/106108100/
- 2. http://nptel.ac.in/courses/106105082/
- 3. http://nptel.ac.in/courses/106105080/2
- 4. http://nptel.ac.in/courses/ microcontrollers/micro/ui/Course_home1_1.html

E-Text Books:

1. http://www.faadooengineers.com/threads/3371-Data-communication-and-networking-Ebook-PDF-DCN-Ebook

2.https://www.google.co.in/?gfe_rd=cr&ei=Dq6SV_G6KNLk8Ae624HgCw&gws_rd=ssl#q=data+com munication+ebook

3. https://books.google.co.in/books?id=zrWQ4Bk-XHMC&redir_esc=y

DISASTER MANAGEMENT

Open Elect	tive I : CSE	/ SE / AE / ES / PE	1						
Course	e Code	Category	Ho	ours / V	Veek	Credits		Maxin	num Marks
DOT			L	Т	Р	С	CIA	SEE	Total
BSI	701	Elective	3	-	-	3	30	Maximum Mar SEE Total 70 10 Total Classes: 45 n and risk reduction ial disaster respons Classes: 09 pact of drought, retion of drought, cal, etc.). ND Classes: 09 ntal, health, psycholobal trends in disastical storms, Cumalitation disastical storms, Cumalitation classes: 09 aredness communitation Quartical raj Institutions, response of indigenous known	100
Contact C	lasses: 45	Tutorial Classes	: Nil	Prac	ctical C	lasses: Nil		Total C	lasses: 45
OBJECTT The studen I. Exposu II. Unders III. Explore IV. Enhanc V. Develo areas w	VES: nt should en re to disaste tand the rela e on Disaster e awareness p rudiment where they li	table the students t ers, their significance ationship between v r Risk Reduction (I s of institutional pro ary abilit y to resp ve, with due sensitiv	o: e and ty ulnerab ORR) aj cesses i ond to ity.	/pes. ility, di pproacl n the c their s	isasters, hes. ountry. urrounc	, disaster pre lings with j	evention potentia	and risk I disaste	reduction. r response in
UNIT-I	INTRODU	UCTION TO NAT	URAL	AND N	ANM	ADE DISAS	STERS	Clas	ses: 09
Concepts a past disaste Impacts (in	nd definition ors and drou cluding soc	ns of Disaster, Haza ght in India, its cla ial, economic. politi	ard, Vul ssificati cal, env	Inerabi on and vironme	lity, Re charac ental, h	silience, Ris eteristics. Cla ealth, psych	sks. Impa assificati osocial,	act of dro on of dro etc.).	ought, review of bught, ca us es,
UNIT-II	DISASTE FLOODS	R, DIFFERENT	IAL I	MPAC	CTS, O	CYCLONE	S ANI	Clas	ses: 09
Classificati etc. Differen urban disas Tropical cy atmospheric	ons, Causes ntial Impacts ters, panden yclones & c hazards/ d	, Impacts including in terms of caste, c nics, complex emerg Local storms, Des isasters, Cold waves	social, lass, gen gencies, struction s, Heat	econor nder, a climat n by t waves,	mic, po lge, loc le chang ropical Causes	litical, envi ation, disab ge. cyclones a of floods, F	ronment ility Glol and loca Rood haz	al, health oal trends al storms ards in I	n, psychosocial in disas ters , s, Cumulative ndia.
UNIT-III	APPROA	CHES TO DISAS	FER R	ISK R	EDUC	ΓΙΟΝ		Clas	ses: 09
Disaster cy Disaster ris Structural	cle, its analy k reduction.	rsis, phases, culture o	of safety	, preve	ention, i	mitigation ar	nd prepai	edness c	ommunity based
local bodies	s, states, cen	tre and other stake h	olders.	STOTIC		, i	unenaye		ututions, erban
UNIT-IV	INTER-R DEVELO	ELATIONSHIP PMENT	BETV	WEEN	DI	SASTERS	AN	Clas	ses: 09
Factors aff embankmen appropriate	fecting vulr nts, changes technology	nerabilities, differen in Land-use etc. (and local resources	ntial in Climate	npacts, Chang	impac ge Adaj	t of develo ptation, Rele	opment evance o	projects of indige	such as darns, nous knowledge,
UNIT-V	DISASTE	R RISK MANAGE	EMENT	r in in	NDIA			Clas	ses: 09
Hazard and Health, Wa	Vulnerabili ste Manager	ty profile of India C ment Institutional ar	Compon rangem	ents of ents (N	Disaste ⁄Iitigatio	er Relief: Wa	ater, Foo e and Pr	d, Sanita eparedne	tion, Shelter, ess, OM Act and

Policy, other related policies, plans, programmes and legislation).

Field work and case Studies to understand vulnerabilities and to work on reducing disaster risks and to build a culture of safety. Projects must be conceived creatively based on the geographic loc ation and hazard profile of the region where the institute is located.

Text Books:

- 1. Nick, "Disaster Management: A Disaster Manager's Handbook", Asian Development Bank, Manila Philippines, 1991.
- 2. Kapur, et al., "Disasters in India: Studies of Grim Reality", Rawat Publishers, Jaipur, 2005.
- 3. Pelling Mark, "The Vulnerability of Cities: Natural Disaster and Social Resilience", Earthscan Publishers, London, 2003.

Reference Books:

- 1. Sharma, V. K. (1999), "Disaster Management", National Centre for Disaster Management, IIPE, Delhi, 1999.
- 2. Anil, K. Gupta and Sreeja, S. Nair (2011), "Environmental Knowledge for Disaster Risk Management", NIDM, New Delhi, 2011.

Web References:

- 1. http://humanityroad.org/
- 2. http://www.wcpt.org/disaster-management/what-is-disaster-management
- 3. http://www.ndmindia.nic.in/
- 4. http://nidm.gov.in/default.asp
- 5. http://www.unisdr.org/2005/mdgs-drr/national-reports/India-report.pdf

Web References:

- 1. http://www.ekalavvya.com/disaster-management-in-india-volume-i-free-ebook/
- 2. http://cbse.nic.in/natural%20hazards%20&%20disaster%20management.pdf
- 3. http://www.undp.org/content/dam/india/docs/disaster_management_in_india.pdf
- 4. http://www.digitalbookindex.org/_search/search010emergencydisastera.asp

RENEWABLE ENERGY SYSTEMS

	Code	Category Hours / Week Credits Ma L T P C CIA				aximum	Marks					
BDE	701	Open Fleetive	L	Т	Р	С	CIA	SEE	Total			
BPE	/01	Open Elective	AM) / CSE / ES / SE / ST tegory Hours / Week Credits Maximum M Elective L T P C CIA SEE I Elective L T P C CIA SEE I Elective J - 3 30 70 I rial Classes: Nil Practical Classes: Nil Total Classes: voltaic power generation. tamic (MHD) and wind energy power conversion systems. I ems with low impact on environment. fuel cells. Classe POWER GENERATION SYSTEMS Classe opectral distribution of energy in solar radiation, solar cell configura hoto current and load current, practical solar cell performance, comm fications for PV systems, applications of super conducting material NERGY CONVERSION Classe tion, ideal MHD generator performance, practical MHD generator, ion: Power from wind, properties of air and wind, types of wind turf environ systems application of OTEC systems examples. Classe SION SYSTEMS AND ENVIRONMENTAL EFFECTS Classe systems: coal gasification and liquefaction, biomass conversion, geoth nversion, principles of EMF generation, co generation and energy stergy storage; Global energy position and environmental effects: energy	100								
Contact C	lasses: 45	Tutorial Classes: 1	Nil	Prac	ctical Cl	asses: Nil	Its Maximum Mari CIA SEE Total 30 70 10 il Total Classes: 45 On systems. Classes: 0 on solar cell configuration cell performance, commerce per conducting materials D POWER Classes: 1 chical MHD generator, MF wind, types of wind turbin classes: 1 oines and generators for tic aves, device applications,					
OBJECTIV This course I. Illustrat II. Discuss III. Explain IV. Design V. Underst	VES: should ena e the concep the Magnet tidal and w energy conv and the tech	ble the students to: ot of photo voltaic power o hydrodynamic (MHD) ave energy. version systems with low mology of fuel cells.	generat and wir impact	tion. nd energy on envire	y power of the power own of the power own	conversion s	ystems.					
UNIT-I	РНОТОУ	OLTAIC POWER GEN	NERAT	TON SY	STEMS			Clas	ses: 09			
Photo voltat voltage deve photo volta electrical eq	ic power ge eloped by se ic systems, uipment sys	eneration: spectral distribution olar cell, photo current a test specifications for stems.	oution c and load PV sys	of energy l current, stems, ap	y in sola practica	r radiation, al solar cell ns of super	solar cel performa conduct	l configu nce, com ing mate	rations, mercial erials in			
UNIT-II	MHD V GENERA	VIND ENERGY C TION	ONVE	RSION	AND	WIND	POWER	R Clas	sses:10			
Principles o technology; operating ch	f MHD por Wind Ener maracteristics	wer generation, ideal M gy conversion: Power fr s.	HD ger om win	nerator p nd, prope	erformat rties of	nce, practica air and winc	l MHD l, types c	generator of wind t	r, MHD urbines,			
UNIT-III	TIDALA	ND WAVE ENERGY C	ONVEI	RSION				Cla	sses:08			
Tides and ti power gener	dal power s	stations, modes of operat	tion, tid	lal projec	et examp	oles, turbines	s and ger	nerators f	or tidal			
Wave energ types of oce	y conversion an thermal e	n: Properties of waves, po energy conversion system	ower co is applic	ntent, ver cation of	rtex mot OTEC s	ion of waves systems exar	s, device and an	applicatio	ons,			
UNIT-IV	ENERGY	CONVERSION SYSTE	EMS AN	ND ENV	IRONM	IENTAL EF	FFECTS	Clas	sses:09			
Miscellaneo	us energy c mo electric ycle co gene	onversion systems: coal energy conversion, prin eration, energy storage; G	gasifica ciples c lobal e	tion and of EMF g nergy pop	liquefac generation sition an	ction, biomas on, co gener d environme	ss conver ation and ental effe	sion, geo l energy cts: energ	othermal storage,			
energy, ther combined cy global energ	y position.											

Text Books:

- 1. Ashok Desai V, Non-Conventional Energy, Wiley Eastern Ltd, 1990.
- 2. Rakosh das Begamudre, "Energy conversion systems", New age International publishers, New Delhi 2000.
- 3. Freris L.L. Prentice Hall1, "Wind energy Conversion Systems", 1990.
- 4. Spera D.A., "Wind Turbine Technology: Fundamental concepts of wind turbine technology", ASME Press, NY, 1994.

Reference Books:

- 1. Mittal K.M, Non-Conventional Energy Systems, Wheeler Publishing Co. Ltd, 1997.
- 2. Ramesh R, Kurnar K.U, Renewable Energy Technologies, Narosa Publishing House, New Delhi, 1997.
- 3. John Twidell, Tony Weir "Renewable Energy Resources", 2nd edition.
- 4. Kreith, Kreider, "Solar Energy Handbook", McGrawHill

Web References:

- 1. http://www.nrel.gov/docs/fy13osti/54909.pdf
- 2. http://www.gisday.com/resources/ebooks/renewable-energy.pdf
- 3. http://www.geni.org/globalenergy/library/energytrends/currentusage/renewable/Renewable-Energy-Potential-for-India.pdf
- 4. http://www.cerien.upc.edu/jornades/jiie2005/ponencies/power%20converters%20and%20control%20of%2 0renewable%20energy%20systems%20paper.pdf
- 5. https://www.irena.org/DocumentDownloads/Publications/RE_Technologies_Cost_Analysis-SOLAR_PV.pdf

E-Text Books:

 $1. \ http://maxwell.sze.hu/~marcsa/MegujuloEnergiaforrasok/Books/renewable\%20 energy\%20 resources.pdf$

2. http://lab.fs.uni-

- lj.si/kes/erasmus/Renewable%20Energy%20Conversion,%20Transmission,%20and%20Storage.pdf
- $3. \ http://www.landartgenerator.org/LAGI-FieldGuideRenewableEnergy-ed1.pdf$
AUTOMOTIVE DESIGN

Course	Code	Category	Ног	ırs / W	eek	Credits		Maxim	um Marks
PCC	/01	Flective	L	Т	Р	С	CIA	SEE	Total
BCC/	01	Liective	3	-	I	3	30	70	100
Contact Cla	sses: 45	Tutorial Classes	: Nil	Pra	ctical C	lasses: Nil	,	Fotal Cla	asses: 45
 OBJECTIVES: The course should enable the students to: I. Understand and Specify automotive styling and design principles of automotive exteriors. II. Analyze automotive exterior design trends. III. Design automotive exteriors using manual and digital renderings. IV. Create clay models of automotive exterior design. 									
UNIT-I	AUTOM CARS B	OTIVE DESIGN ' ASED ON BODY S	TERM STYLE	INOL	OGY,	CLASSIFIC	ATION	OF	Classes: 09
Overview, Automotive design terminology, automotive design process and factors influencing automotive design, development and history behind different body styles, micro cars, hatchback and it sub types, sedan and its sub-types, coupe and its variants, convertible and its variants, station wagon, sports utility vehicles, multi utility vehicles.									
UNIT-II	PLATFO AUTOM	ORM TECHNOI IOTIVE PACKAG	LOGY, ING]	YPES	OF CH	ASSIS,	AND	Classes: 09
Platform teo platform, be chassis, con chassis, alu definition au (engine con packaging, r	chnology, enefits of mposite c minium i nd differen npartment regulatory	types of chassis, a platform sharing onstruction, uniboo monocoque constru- nt layout sectors in), rear end (lugga requirements.	and aut and do dy con uction, packag ge spa	omotiv wnside structie carbo ging, I ce), u	e pack of pla on, tub n fibre nterior nder-bo	aging: Defi atform techn ular space monocoqu dimensions, dy, major t	nition, n nology; frame, g e constr exterior factors i	notivatio History glass-fibr uction, dimens nfluencin	n, versions of of automotive re monocoque ULSAB type ions, front end ng automotive
UNIT-III	AUTOM	IOTIVE FRONT- F	REAR I	END D	ESIGN				Classes: 09
Factors affe design them	cting the f e, regulati	ront end design, fro on for bumper desig	nt end gn.	design	for bett	er air coolin	ıg, latest	design t	rends, bumper
Evolution o design, tail l	f grille de amp, spoi	sign, grille design ler, bumper design,	as a ne overall	w brai rear d	nd imag esign fo	ge, hood des or aerodynan	ign and nics.	new tren	nds in exterior
UNIT-IV	AUTOM	OTIVE LIGHTIN	G SYSI	TEM,	AUTON	MOTIVE GI	LASSES		Classes: 09
History and development in automotive lighting, different types of optical system, light sources used in lighting, headlamp design and styling, advanced lighting technology, pedestrian friendly lights, signal lamps, latest trends in automotive lighting, different types of automotive glasses, recent development in automotive glass design, importance of glass in car design, role of glazing for car safety, developments in automotive glass design.									

UNIT-V AUTOMOTIVE EXTERIOR DESIGN, PAINTING , SURFACE PROTECTION Classes: 09

Design methodology, image boards: lifestyle board, mood board, theme board, design trends, design movements, application of design principles, product aesthetics, different types of corrosion on automotive bodies, corrosion protection methods, automotive body painting procedure, paint components and latest trends in automotive body colors.

Text Books:

1.J.Fenton, "Handbook of Automotive Body and System Design", Professional Engineering Publishing, 1st Edition, 2000.

2. Erik Eckermann, "World History of the Automobile", SAE International, 1st Edition, 2002.

Reference Books:

Stephen Newbury, "Car Design Year Book 1 to 5", Marrell, 1stEdition, London, 2007.
 Tony Lewin, "How to Design Car Like A Pro", Motorbooks International, 1st Edition, 2003

Web References:

- 1.www.carbodydesign.com
- 2. www.style4cars.com
- 3..www.cardesignnews.com

E-Text Books:

1. http://www.sciencedirect.com/science/book/9780750656924

2. http://books.sae.org/r-312/

EMBEDDED C

Open Elective I: AE / (CAD / CAM) / CSE / SE / PEED / ST I Semester: ES										
Course	e code	Category	He	ours / We	ek	Credits	May	kimum N	Iarks	
RES	001	Coro/Elective	L	Т	Р	С	CIA	SEE	Total	
DES	001	Core/Elective	3	-	-	3	30	70	100	
Contact C	lasses: 45	Tutorial Classe	es: Nil	Pract	ical Cla	sses: Nil	Tot	al Classe	es: 45	
OBJECTIVES: The course should enable the students to: I. Understand embedded C and use it for programming embedded system. II. Apply techniques for data transfer between I/O ports and memory. III. Apply object oriented programming for designing embedded system. IV. Use timers to generate time delays.										
UNIT-I	PROGRAMMING EMBEDDED SYSTEMS IN C Classes: 09								sses: 09	
Introduction should you Introduction and perfor conclusions	ntroduction, what is an embedded system, which processor should you use, which programming language hould you use, which operating system should you use, how do you develop embedded software, conclusions; ntroduction, what's in a name, the external interface of the standard 8051, reset requirements, clock frequency und performance, memory issues, I/O pins, timers, interrupts, serial interface, power consumption, conclusions.									
UNIT-II	SWITCH	ES						Class	ses: 09	
Introduction Reading an pull-up res counting go	n, basic tec d writing bi istors, Deal oats, conclus	hniques for reading ts (simple version), I ling with switch bo ions.	from po Example: ounce, Ex	rt pins; H Reading cample: F	Example: and writ Reading	Reading an ting bits (ger switch inpu	nd writing neric versi ts (basic	y bytes, o on), The code), o	example: need for example:	
UNIT-III	ADDING	STRUCTURE TO	THE CO	DE				Class	ses: 09	
Introduction	n, object orie	ented programming v	vith C, the	e project l	neader (N	MAIN.H), the	e port head	ler (POR	T.H);	
Example: Feature Example, fu	Restructuring	g the 'Hello Embed ples and conclusions	lded Wor	ld' exam	ple, Exa	mple: Restru	cturing th	ne goat-c	ounting	
UNIT-IV	MEETIN	G REAL-TIME CO	NSTRAI	NTS				Class	ses: 09	
Introduction, creating hardware delays using Timer 0 and Timer 1, example: Generating a precise 50 ms delay, example: Creating a portable hardware delay, Why not use Timer 2? The need for timeout mechanisms, creating loop timeouts and example: Testing loop timeouts, example: A more reliable switch interface, Creating hardware timeouts, example: Testing a hardware timeout, conclusions.									is delay, hanisms, Creating	
UNIT-V	CASE ST	UDY: INTRUDER	ALARM	SYSTEN	1			Class	ses: 09	
Introduction the software	Introduction, The software architecture, key software components used in this example, running the program, the software, conclusions.									

Text Books:

1. Michael J. Pont, "Embedded C", Pearson Education, 2nd Edition, 2008.

Reference Books:

1. Nigel Gardner, "The Microchip PIC in CCS C", Ccs Inc, 2nd Revision Edition, 2002.

Web References:

- 1. http://www.keil.com/forum/5973/
- 2. http://nptel.ac.in/courses/Webcourse-contents/IIT%20Kharagpur/Embedded%20systems /New_index1.html
- 3. http://nptel.iitg.ernet.in/courses/Elec_Engg/IIT%20Delhi/Embedded%20Systems%20(Video).htm
- 4. http://freevideolectures.com/Course/2999/Embedded-Systems-I/5

- 1. http://teachers.teicm.gr/kalomiros/Mtptx/e-books/eBook%20-%20PIC%20Programming%20with %20C.pdf
- 2. http://www.ecpe.nu.ac.th/ponpisut/22323006-Embedded-c-Tutorial-8051.pdf
- 3. http://dsp-book.narod.ru/CPES.pdf
- 4. http://staff.ustc.edu.cn/~shizhu/WinCE/winCE6%20Fundamentals.pdf
- 5. http://read.pudn.com/downloads167/ebook/769402/Wrox.Professional.Microsoft.Windows.Embedd
- 6. ed.CE.6.0.Nov.2008.eBook-DDU.pdf
- 7. https://syhpullpdf.files.wordpress.com/2015/05/embedded-systems-textbook-pdf.pdf

ADVANCED JAVA PROGRAMMINGAND WEB SERVICES

Open Electiv	Open Elective I: AE / (CAD/CAM) / ES / SE / PE / ST								
Course	Code	Category		Hours / We	ek	Credits	Ma	ximum I	Marks
BCS7	/01	Flective	L	Т	Р	С	CIA	SEE	Total
BCS7	01	Elective	3	-	-	3	30	70	100
Contact Cla	asses: 45	Tutorial Classes	s: Nil	Pract	ical Clas	ses: Nil	То	tal Clas	ses: 45
OBJECTIVES: The course should enable the students to : I. Understand OOPS Concepts Describe client side technologies. II. Implement database connections. III. Develop the skills to design user interfaces for web Applications.									
UNIT-I	INTROD	UCTION TO OOP	S					Clas	ses: 09
Basic concepts of OOPs: Java History, Java Features, Comparison in Java and C++, Java Virtual Machine, Java Environment, Program, Data types, operators, Control Structure, Classes and Objects, Constructors, Interfaces, Exception Handling.									
UNIT-II	APPLETS AND SWINGS Classes: 09								
Applets: Intro tag, passing Features, JC JMenu, JMen	oduction to parameters omponent, nuBar	applet, applet vs ap to applet, types of JApplet, JFrame,	plication of appl JPanno	on, applet cla lets, example el, JButtons	ass, advat es; swing , Jcheck	ntages of appl g: introduction boxes and JI	et, apple n to JF Radiobu	et lifecyc C, swing ttons, JT	le, applet g, Swing, TextField,
UNIT-III	HTMLA	ND XML						Clas	ses: 09
HTML comn objects in jav	non tags: li va script, dy	st, tables, images, inamic HTML with	forms, java sc	frames; caso ript.	cading sty	yle sheets; int	roductio	n to java	a scripts,
XML: docur processors: D	nent type d OOM and S.	lefinition, XML scl AX.	nemas,	document o	object mo	odel, presentir	ng XML	, using X	KML
UNIT-IV	WEB SEI	RVERS,SERVLEI	SANI	D JSP				Clas	ses: 09
Web servers: Tomcat server installation and testing, introduction to servelets: lifecycle of a servelet, JSDK, servelet API, javax. servelet package, reading servelet parameters, reading initialization parameters; servlets: javax, servelet HTTP package, handling http request and responses, using cookies session tracking, security issues, JSP: problem with servelet, anatomy of a JSP Page, JSP processing, JSP application design with MVC architecture, AJAX.									
UNIT-V	UNIT-V JDBC AND ODBC Classes: 09								
JDBC & ODBC :Java and JDBC , JDBC vs ODBC, JDBC driver model, JDBC driver types, two-tier architecture for data access ,three-tier architecture for data access , types of driver managers, connecting to an ODBC data source, JDBC programs									

Text Books:

- 1. WILEY Dreamtech Chris Bates, "Web Programming, building internet applications", 2nd edition.
- 2. Patrick Naughton and Herbert Schildt, "The complete Reference Java 2", TMH, 5th Edition.
- 3. Hans Bergsten, "Java Server Pages", SPD O"Reilly.

Reference Books:

- 1. Sebesta, "Programming world wide web", Pearson Core,8th Edition 2008.
- 2. Marty Hall, Larry Brown, "Servlets and Javaserver Pages", Volume 1: Core Technologies, Pearson 2nd Edition 1998.

Web References:

- 1. http://engineeringppt.blogspot.in/2010/01/advance-java-web-technology.html
- $2. \ http://www.scoopworld.in/2015/02/ajwt-ppt-lab-materials-cse.html$
- $3. \ http://jntuh.ac.in/new/bulletin_board/WEB_T ECHNOLOGIES.pdf$

- 1. http://www.freetechbooks.com/advanced-programming-for-the-java-2-platform-t36.html
- 2. https://www.mkyong.com/featured/top-5-free-java-ebooks/
- 3. http://www.e-booksdirectory.com/listing.php?category=226

INTRODUCTION TO AEROSPACE ENGINEERING

Cours	e Code	Category	H	lours / V	Veek	Credits	Max	ximum Marks	
			L	Т	Р	С	CIA	SEE	Total
BAI	E701	Elective	3	-	-	3	30	70	100
Contact C	Classes: 45	Tutorial Classes: N	il	Pract	ical Clas	ses: Nil	Total	Classes	: 45
 OBJECTIVES: The course should enable the students to: Outline different aspects of flight vehicles and their operational environment. Description of flow behavior of one-dimensional incompressible and compressible flow, two-dimensional flow and finite wing. Apprise about boundary layer effects, aerodynamic forces on airfoils, wings and high-lift systems. Analyze airplane performance, stability and control. 									
UNIT-I	NIT-I INTRODUCTION TO AERONAUTICS AND ASTRONAUTICS Classes: 08								
Historical vehicle, ae experimen	perspective prodynamic for t, wind tunne	of aeronautics and a orces; Parameters affe ls; Atmosphere: Prope	stronautiecting ae	ics, anat prodynan U.S. stan	omy of the	the airplane, : Dimension osphere, defin	anatom al analys nitions o	y of a sis; The f altitud	space ory and e.
UNIT-II	ONE DIM COMPRE FINITE W	ENSIONAL FLOW SSIBLE FLUIDS, TV ING	IN INCO VO DIM	OMPRE IENSIO	SSIBLE NAL FL	AND OW AND		Class	ses: 10
Continuity equation, Bernoulli's equation; Application of Bernoulli's equation: Airspeed indicators and wind tunnels, one dimensional compressible flow concepts, speed of sound, compressible flow equations in a variable-area stream tube, application to airspeed measurement, applications to channels and wind tunnels; Two dimensional flow and finite wing: Limitations of one dimensional flow equations; Theory of lift: circulation, Airfoil pressure distribution, Helmholtz vortex theorems, Simulating the wing with a vortex Line, downwash, elliptic lift distribution; Lift and drag: Momentum and energy, Slope of finite wing lift curve, verification of Prandtl wing theory, additional effects of wing vortices, search for reduced induced drag.									
UNIT-III	VISCOUS WINGS	S EFFECTS, DRAG AND HIGH-LIFT S	DETER SYSTEM	RMINA' IS	FION, Al	IRFOILS,		Class	ses: 10
Boundary layer, boundary layer on bluff bodies, creation of circulation, laminar and turbulent boundary layers: skin friction, nature of Reynolds number, effect of turbulent boundary layer on separation; Total Incompressible drag: Parasite drag, drag due to lift, importance of aspect ratio; Compressibility drag: Prediction of drag divergence Mach number, sweptback wings, total drag:									

Supersonic flow: Shock waves and Mach waves, supersonic wing lift and drag, area rule, supersonic aircraft, airfoils; Wings: early airfoil development, modern airfoils, supersonic airfoils, airfoil pitching moments, effects of sweepback on lift, airfoil characteristics, airfoil selection and wing design; High-lift Devices: Airfoil maximum lift coefficient, leading and trailing edge devices, effect of sweepback, deep stall, effect of Reynolds number, propulsive lift.

AIRPLANE PERFORMANCE, STABILITY AND CONTROL, UNIT-IV **AEROSPACE PROPULSION**

Classes: 09

Level flight performance, climb performance, range, endurance, energy-state approach to airplane performance, takeoff performance, landing performance; Static longitudinal stability; Dynamic longitudinal stability; Dynamic lateral stability; Control and maneuverability: Turning performance, control systems, active controls; Aerospace propulsion: Piston engines, gas turbines; Speed limitations of gas turbines: Ramjets, propellers, overall propulsion efficiency, rocket engines, rocket motor performance, propulsionairframe integration.

AIRCRAFT STRUCTURES, HYPERSONIC FLOWS, ROCKET **UNIT-V TRAJECTORIES AND ORBITS**

Classes: 08

Aircraft structures: Importance of structural weight and integrity, development of aircraft structures, importance of fatigue, materials, loads, weight estimation; Hypersonic flows: temperature effects, Newtonian theory; rocket trajectories, multistage rockets, escape velocity, circular orbital or satellite velocity, elliptical orbits, orbital maneuvers.

Text Books :

- 1. Richard S. Shevell, Fundamentals of Flight, Pearson Education Publication, 2nd Edition, 1988.
- 2. Anderson J. D, "Introduction to Flight", McGraw-Hill, 5th Edition, 1989.
- 3. Newman D, "Interactive Aerospace Engineering and Design", McGraw-Hill, 1st Edition, 2002.
- 4. Barnard R.H and Philpot. D.R, "Aircraft Flight", Pearson, 3rd Edition, 2004.

Reference Books:

- 1. Introduction to Flight, John D. Anderson, Jr., Tata McGraw-Hill Publishing Company, Fifth Edition, Fifth Edition. 2007.
- 2. Kermode, A. C, "Flight without Formulae", McGraw Hill, 4th Edition, 1997.
- 3. Swatton P. J, "Flight Planning", Blackwell Publisher, 6th Edition, 2002.

Web References:

- 1. https://fas.org/irp/doddir/army/fm3-04-203.pdf
- 2. http://www.aerospaceengineering.es/book/
- 3. http://www.ne.nasa.gov/education/
- 4. http://nptel.ac.in

E-Text Books:

1. http://www.e-booksdirectory.com/

- 2. http://www.adl.gatech.edu/extrovert/Ebooks/ebook_Intro.pdf
- 3. http://www.academia.edu/7950378/Introduction_to_Flight_-_Anderson_5th_Ed._

GEOSPATIAL TECHNIQUES

Open Electi	ve-II: CSE	/ SE / AE / ES / PE /	(CAD/	/CAM)				
Course	Code	Category	Pe	riods /	'Week	Credits	I	Aaximu	m Marks
DGT			L	Т	Р	С	CIA	SEE	Total
BS17	/02	Elective	3	-	_	3	30	70	100
Contact Cl	asses: 45	Tutorial Classes: Nil	I	Practi	cal Class	es: Nil	Т	otal Cla	sses: 45
 OBJECTIVES: The course should enable the students to: Provide technical skills to use geo-referenced data for the purpose of economic, educational, and social development. Learn the art of image interpretation and mapping. Learn the applications of geospatial technologies. 									
UNIT-I INTRODUCTION TO GEOSPATIAL DATA Classes: 0							Classes: 09		
Geospatial da three import electromagne	Beospatial data, why to study geospatial data, importance of geospatial technology, spatial data infrastructure, mee important geospatial technologies, spatial elements., coordinates and coordinate systems, basic lectromagnetic radiation.								
UNIT-II	PHOTOGRAMMETRY AND REMOTE SENSING Classes: 10								
Definition an acquisition, 1 required. Ma features.	nd scope, hi Remote sen p Vs mosai	istory of photogrammetry sing data analysis methoc c, ground control points. I	and reals, adva and reals, adva Energy	emote antage intera	sensing, s and lim ctions wi	principle, mitations, hat the atmospheric sector is the sector of the se	remote s ardware ere and e	ensing o and soft earth sur	lata ware face
UNIT-III	MAPPIN	GAND CARTOGRAPH	Y					C	Classes: 10
What is map visual interpr	and its imp retation of s	ortance, map scale and ty atellite images, and interp	pes, ele pretatio	ements on of te	s of map a errain eva	and Indexir luation.	ng, map	coordina	te systems,
Introduction cartography,	to digital d scale and pu	ata analysis, cartographic prose of a map, cartograp	e symb hic des	olizati sign, tl	on, class nematic c	ification of artography,	symbol digital d	s, colou cartograț	rs in ohy.
UNIT-IV	GEOGRA	APHIC INFORMATION	I SYST	EM				C	Classes:10
Introduction of GIS, theor spatial data, feature and d	Introduction to GIS, definition and terminology, GIS categories, components of GIS, fundamental operations of GIS, theoretical framework for GIS, GIS data structures, data collection and input overview, processing of spatial data, data Input or output, vector data model, raster data model, geometric representation of spatial feature and data structure. Spatial data and modeling, TIN, DTM, overlay, spatial measurement .								l operations ocessing of n of spatial
UNIT-V	GEOSPA	TIAL TECHNOLOGIE	S APPI	LICA	TIONS			C	Classes:09
Visual image analysis for land use / land cover mapping, land use and land cover in water resources, surface water mapping and Inventory, geological and soil mapping, agriculture applications for forestry applications, water resources applications, urban and regional planning, environmental assessment, principles of land form identification and evaluation: sedimentary, igneous and metamorphic rock terrain.									

Text Books :

- 1. John D. Bossler, "Manual of Geospatial Science and Technology" Taylor & Francis.
- 2. M. Anji Reddy, "Textbook of Remote Sensing and Geographical Information Systems", BS Publications.

Reference Books:

- 1. C. P. Lo Albert, K.W. Yonng, "Concepts and Techniques of GIS", Prentice Hall (India) Publications.
- 2. Peter A Burragh and Rachael A. Mc Donnell, "Principles of Geo- Physical Information Systems", Oxford Publishers, 2004.
- 3. M. Anji Reddy, "Geo-informatics for Environmental Management" BS Publications.

Web References:

- 1. https://www.aaas.org/content/what-are-geospatial-technologies
- 2. http://www.istl.org/10-spring/internet2.htmls

- 1. http://www.springer.com/us/book/9781441900494
- 2. https://www.amazon.com/Introduction-Geospatial-Technologies-Bradley-Shellito/dp/146413345X
- 3. http://www.springer.com/us/book/9784431555186
- 4. http://gep.frec.vt.edu/VCCS/materials/2011/Day1/Handouts/1.2-Ch.1_GIS_Intro.pdf
- 5. http://www.slideshare.net/CuteGirl11/introduction-to-geospatial-technologies-pdf

SOLAR PHOTOVOLTAIC ENERGY CONVERSION

Cours	se Code	Category	Ho	urs / We	ek	Credits	Μ	laximum	Marks
			L	Т	Р	C	CIA	SEE	Total
BP	E702	Elective	3	-	-	3	30	70	100
Contact	Classes: 45	Tutorial Clas	ses: Nil	Pract	tical Cla	asses: Nil	То	tal Class	es: 45
OBJECTIV This course I. Illustrat II. Analyze III. Design IV. Underst	YES: should enable e the operation e the characteris energy convers and the techno	the students to: of Photo voltaic p stics of solar photo ion systems with 1 logy of fuel cells.	oower gene ovoltaic po ow impact	ration. wer gene	ration. onment.				
UNIT-I	UNIT-I INTRODUCTION Classes: 09								ses: 09
Introduction: Highlights, an atomic description of silicon, the effect of light on silicon the potential barrier, the function of the barrier, the potential barrier in action the electric current.									
UNIT-II	PHYSICAL	ASPECTS OF S	OLAR CE	LL EFF	ICIEN	CY		Class	ses: 09
Physical asp electron ho degradation	bects of solar c le pairs, direc at non optimal	ell efficiency: Ref ct recombination temperatures, high	Tection light indirect r h temperate	ht with to ecombination ure losses	oo little ation, r s, low te	or too much resistance, s emperature l	n energy, self shad osses.	recombining, perf	nation of formance
UNIT-III	SINGLE CR	AYSTAL SILICON	N SOLAR	CELLS	AND A	RRAYS		Class	ses: 09
Single Crys Ribbon to r mirrors (MC component t connecting c	tal Silicon Sol ibbon (rtr) gro CM). Schottky technology high components, th	ar cells: New fab owth innovative co barrier cells, inv hlights, PV buildir e physical connect	rication ed ell designs version lay ng blocks, l ion. placin	lge, defir back su er cells, boosting g the cell	ned film rface fi cells fo voltage s;	n fed growt elds (BSF) or concentra and ampera	h (dendr and othe ted sun ge design	itic web r minorit light adv n requiren	growth, y carrier ances in nents for
Arrays: Array support, module covers, module cooling, hybrid designs, Brayton cycle, electricity production, the rmo electric generators, intercepting sunlight, arrays with relectors, arrays that follow the sun, controlling intensity, imaging optics, mirrors, lenses tracking devices, steering mechanisms, tracking device controls, optimizing the use of the spectrum, splitting the spectrum, converting the spectrum to a single color.									
UNIT-IV	SOLAR AR	RAY CONSTRU	CTIONS					Class	ses: 09
Solar array constructions: Intercepting sunlight, arrays with relectors, arrays that follow the sun, controlling intensity, imaging optics, mirrors, lenses; Tracking devices: steering mechanisms, tracking device controls, optimizing the use of the spectrum, splitting the spectrum, converting the spectrum to a single color.									

UNIT-V PV SUPPORT EQUIPMENT

PV support equipment: PV vs conventional electricity, storing PV's electricity, batteries, fuel cells, power conditioning equipment the inverter regulators other devices; system analysis, design procedure, design constraints, other considerations.

Text Books:

- 1. CS Solanki, "Solar photovoltaic's fundamentals, Technologies and Applications", PHI Learning Pvt. Ltd., 2011.
- 2. Rai. G.D, "Solar energy utilization", Khanna publishes, 1993.
- 3. Rai,G.D., "Non- conventional resources of energy", Khanna publishers, Fourth edition, 2010.

Reference Books:

- 1. Rai. G.D, "Solar energy utilization", Khanna publishes, 1993.
- 2. Pai, B. R. and Ram Prasad, "Power Generation through Renewable Sources of Energy", Tata McGraw Hill, New Delhi, 1991.
- 3. Bansal, Kleeman and Meliss, "Renewable Energy Sources and Conversion Techniques", Tata Mc Graw Hill, 1990.
- 4. Godfrey Boyl, "Renewable Energy: Power sustainable future", Oxford University Press, Third edition, 2012.
- 5. B.H. Khan, "Non-Conventional Energy Resources", The McGraw Hills, Second edition, 2009.
- 6. John W Twidell and Anthony D Weir, "Renewable Energy Resources", Taylor and Francis, 2006.

Web References:

- 1. http://www.tue.nl/fileadmin/content/faculteiten/tn/PMP/White_papers/Delft2012_-_ALD4PV.pdf
- 2. http://www.en.wikipedia.org/wiki/Photovoltaics
- 3. http://www.desware.net/Sample-Chapters/D06/D10-014.pdf
- 4. http://www.southampton.ac.uk/~solar/files/Strasbourg.pdf
- 5. http:// www.science.nasa.gov/science-news/science-at-nasa/2002/solarcells/

- 1. http://www.nrel.gov/docs/legosti/old/1448.pdf
- http://www.irena.org/DocumentDownloads/Publications/IRENAETSAP%20Tech%20Brief%20E11%20S olar%20PV.pd
- 3. http://www.opalrt.com/sites/default/files/technical_papers/SOLAR%20PHOTOVOLTAIC%20ENERGY% 20GENERATION%20AND%20CONVERSION.pdf

COMPUTER GRAPHICS

Open Elect	ive II: AE /	CSE / ES / SE / PEE	D / ST						
Course	Code	Category	Но	ours / V	Veek	Credits	Ν	Iaximum	Marks
			L	Т	Р	С	CIA	SEE	Total
BCC	702	Elective	3	-	-	3	30	70	100
Contact Cl	asses: 45	Tutorial Classes:	Nil	Pra	ctical Cl	asses: Nil	То	tal Classe	es: 45
 OBJECTIVES: The course should enable the students to: Understanding the basics of Computer Graphics needed for CAD/ CAM applications. Applying the geometrical modeling for computer graphics. III. Applying data structures in computer graphics. 									
UNIT-I	INTROD	UCTION TO COMP	UTER (GRAPI	HICS			Cla	sses: 09
Introductio design and	n: Role of graphical u	computer graphics ser interfaces, custom	in CAD	D/CAM and pa	, config rametric	uration of g programmir	raphic w 1g.	orkstatio	ns, menu
UNIT-II	-II GEOMETRIC TRANSFORMATIONS, PROJECTIONS AND FUNDAMENTALS OF 2D AND 3D TRANSFORMATIONS Classes: 09								sses: 09
Geometric coordinate and shearin	transforma systems; Fi ng, various	ations and projection undamentals of 2D an types of projections.	s: Vecto d 3D tr	or repr ansforr	esentations:	on of geome reflection, tr	tric entit anslation	ies, home	ogeneous , scaling,
UNIT-III	DEVELO	PMENT OF GEOME	ENTRIC	CAL M	ODELL	ING		Cla	sses: 09
Curves: M parametric	odeling pla equations.	anar and space curve	es, analy	ytical a	and synt	hetic approa	aches, no	n-parame	etric and
Surfaces: N surface ma	Modeling on nipulation to the second	f bi-parametric freed techniques.	om sur	faces,	Coons, 1	Bezier, B-spl	line, and	NURBS	surfaces,
UNIT-IV	GEOMEN	NTRICAL MODELIN	NG					Cla	sses: 09
Geometric hybrid mod	Modeling: lelers, featu	Geometric modeling re based, parametric	techniq and vari	ues, wi ation n	reframe	modeling, so	olid mode	eling: B I	Rep CSG,
UNIT-V	DATA ST	RUCTURES IN COM	APUTE	R GRA	PHICS			Cla	sses: 09
Data Structure in Computer Graphics: Introduction to product data standards and data structures, data- base integration for CIM.									
Text Books	5:								
1. D. F. Rogers, J. A. Adams, "Mathematical Elements for Computer Graphics", Tata McGraw Hill. 1989.									
2. I. D. Fa	ux, M. J. I	Pratt, "Computational	l Geom	etry fo	r Desigi	n and Manu	facture",	Ellis Ho	rwood,
3. Mortenson, M. E., "Geometric Modeling", 3rd Ed., Industrial Press. 2006									

Ibrahim Zeid, "CAD/CAM: Theory and Practice", Tata McGraw Hill, 1998.
 B. K. Choi, B. K., "Surface Modeling for CAD/CAM", John Wiley & Sons 1991

Reference Books:

1. C. Pozrikidis, "Introduction to Theoretical and Computational Fluid Dynamics", Oxford University Press, 2nd Edition, 2013.

2.V. Patankar, Hema shava Suhas, "Numerical heat transfer and fluid flow", Tata McGraw Hill

Web References:

1. http://nptel.ac.in/courses/106106090/

2. http://nptel.ac.in/courses/112102101/

E-Text Books:

1. http://www.freebookcentre.net/CompuScience/Free-Computer-Graphics-Books-Download.html 2.https://docs.google.com/file/d/0B_YZ665nBRhlYmNiOTU5ZDItMmU2OC00YTVmLThiNmMtMjg 3. Y2E3ZTgwZDYw/edit?hl=en_US&pref=2&pli=1

MICROCONTROLLERS FOR EMBEDDED SYSTEM DESIGN

	e Code	Category	Н	ours / We	eek	Credits	Ma	ximum N	larks	
BF	\$702	Flective	L	Т	Р	С	CIA	SEE	Total	
DE	5702	Liective	3	-	-	3	30	70	100	
Contact (Classes: 45	Tutorial Classes:	Nil	Prac	tical Cla	sses: Nil	Total	Classes: 4	15	
OBJECTIVES: The course should enable the students to: I. Understand hardware units and devices for design of embedded systems. II. Use architectures of embedded RISC processors and system on chip processor design of embedded										
systems.III. Analyze interrupt latency, context switching time, for development of device drives for timing devic es.										
UNIT-I	-I INTRODUCTION TO EMBEDDED SYSTEMS Classes: 09								sses: 09	
Overview of embedded systems, processor embedded into a system, embedded hardware units and devices in system, embedded software, complex system design, design process in embedded system, formalization of system design, classification of embedded systems.										
UNIT-II	MICROO	CONTROLLERS						Cla	sses: 09	
8051 architecture, input/output ports and circuits, external memory, counters and timers, PIC controllers; Interfacing processor 8051, PIC, memory interfacing, I/O devices, memory controller and memory arbitration schemes.										
schemes.		051, FIC, memory i	Interracing	, I/O devi	ces, men	fory controll	er and me	emory arb	itration	
schemes.	EMBEDI	DED RISC PROCH		, 1/O devi	ces, men	lory controll	er and me	emory arb	sses: 09	
UNIT-III programm digital bloc	EMBEDI able system cks, program	DED RISC PROCH on chip architectur ming of PSOC;	ESSORS res, continu	Jous time	r blocks,	switched ca	er and me	emory arb Cla locks, I/C	sses: 09 blocks,	
UNIT-III programm digital bloc Embedded overview o	EMBEDI hable system cks, program RISC proce of Instruction	DED RISC PROCH on chip architectur ming of PSOC; ssor architecture, A is.	ESSORS es, continu RM proce	uous time	r blocks, tecture, r	switched ca	pacitor bl	emory arb Cla locks, I/C operation	itration sses: 09 blocks, and	
UNIT-III programm digital bloc Embedded overview o	EMBEDI aable system eks, program RISC proce of Instruction	DED RISC PROCE on chip architectur ming of PSOC; ssor architecture, A 18.	ESSORS es, continu RM proce	uous time ssor archi	r blocks, tecture, r	switched ca	pacitor bl	emory arb Cla locks, I/C operation Cla	itration sses: 09 blocks, and sses: 09	
UNIT-III programm digital bloc Embedded overview o UNIT-IV Exceptions latency; De programma	EMBEDI aable system eks, program RISC proce of Instruction INTERR and Interru evice driver able timing o	DED RISC PROCH on chip architectur ming of PSOC; ssor architecture, A is. UPTS AND DEVIC pt handling Scheme using interrupt serv devices.	ESSORS es, continu RM proce CE DRIVI es, Contex vice routin	uous time ssor archi ERS t and peri e, serial p	r blocks, tecture, r	switched ca egisters set, : ontext switc ce driver and	pacitor bl modes of hing, dead	cla Cla locks, I/C operation Cla dline and lrivers for	itration sses: 09 blocks, and sses: 09 interrupt	
UNIT-III programm digital bloc Embedded overview c UNIT-IV Exceptions latency; De programma	EMBEDI mable system cks, program RISC proce of Instruction INTERR s and Interru evice driver able timing of NETWO	DED RISC PROCH on chip architectur ming of PSOC; ssor architecture, A ns. UPTS AND DEVIC pt handling Scheme using interrupt serv levices.	ESSORS es, continu RM proce CE DRIVI es, Contex vice routin	uous time ssor archi ERS t and peri e, serial p	r blocks, tecture, r	switched ca egisters set, i ontext switc ce driver and	pacitor bl modes of hing, dead	Cla locks, I/C operation Cla dline and lrivers for Cla	itration sses: 09 blocks, and sses: 09 interrupt r internal sses: 09	

- 1. Raj Kamal, "Embedded Systems, Architecture Programming and Design", Tata Mc Graw Hill, 2nd Edition, 2008.
- 2. Muhammad Ali Mazidi, Rolin D. Mckinaly, Danny Causy, "PIC Microcontroller and Embedded Systems", Pearson Education, 1st Edition, 2008.
- 3. Robert Ashpy, "Designers Guide to the Cypress PSOC", Elsevier, 1st Edition, 2005.

Reference Books:

- 1. Jonathan W. Valvano Brookes / Cole, "Embedded Microcomputer Systems, Real Time Interfacing", Thomas Learning, 1st Edition, 1998.
- 2. Andrew N. Sloss, Dominic Symes, Chris Wright, "ARM Systems Developers Guides, Design & Optimizing System Software", Elsevier, 1st Edition, 2004.
- 3. John B. Peatman, "Designing with PIC Microcontrollers", PH Inc, 1st Edition, 1998.

Web References:

- 1. http://nptel.ac.in/syllabus/108102045/
- 2. http://nptel.ac.in/courses/Webcoursecontents/IIT,KANPUR/microcontrollers/micro/ui/Course_home1_1.Htm

- 1. http://microcontrollershop.com/default.php?cPath=239
- 2. http://www.sciencedirect.com/science/book/9780750667555
- 3. https://books.google.co.in/books/about/Embedded_Systems_Design_with_8051_Microc.html?id=YiTa, HChn0UC&redir_esc=y
- 4. https://books.google.co.in/books/about/Microcontroller_And_Embedded_Systems.html?id=4GrXJeC6HFk C

LINUX PROGRAMMING

Open Elective II: AE / (CAD / CAM) / ES / ST / PEED										
Course Co	ode	Category	Н	lours / Wee	ĸ	Credits	Ma	ximum N	Iarks	
BCS70/	,	Floativo	L	Т	Р	С	CIA	SEE	Total	
BC5702	4	Lieuve	3	-	-	3	30	70	100	
Contact Class	ses: 45	Total Tutori	als: Nil	Total Pra	actical C	lasses: Nil	To	tal Classe	es: 45	
 OBJECTIVES: The course should enable the students to : Understand basic Linux utilities and Shell scripting language (bash) to solve Problems. Explore on implementation of linux utilities using system calls. Develop the skills necessary for systems programming IV. Illustrate the basic skills required to write inter process communication programs. 										
UNIT-I	LINUX	UTILITIES						Class	es: 09	
File handling utilities, Security by file permissions, Process utilities, Disk utilities, Networking commands, Filters, Text processing utilities and Backup utilities; Sed-Scripts, Operation, Addresses, Commands, awk-Execution, Fields and Records, Scripts, Operation, Patterns, Actions, Associative Arrays, String and Mathematical functions, System commands in awk, Applications.										
UNIT-II	SHELL	PROGRAMM	ING					Class	es: 09	
Introduction, she programming la shell commands examples, interr	ell respon inguage, s s, the env rupt proce	sibilities, pipes a shell meta chara ironment, quoti essing, debuggin	and Redir acters, file ng, test c g shell sc	ection, here e name subs ommand, co ripts.	documes stitution, ontrol str	nts, running shell variab uctures, arith	a shell so les, com nmetic in	cript, the mand sub shell, sh	shell as a ostitution, aell script	
UNIT-III	FILES A	AND DIRECTO	RIES					Class	es: 09	
Files: File types operations: oper locking: fcntl fu	, File Sys n, create, nction.	stem Structure, f read, write, clo	ile metad ose, lseek	ata: Inodes, , dup2, file	kernel si status ir	upport for filn formation:	es, syster stat fami	m calls fo ly, file an	or file I/O nd record	
File permissions - chmod, fchmod, file ownership, links: soft and hard links: symlink, link, unlink. Directories: Creating, removing and changing Directories, obtaining current working directory: getcwd, Directory contents, Scanning Directories: opendir, readdir, closedir, rewinddir functions.										
UNIT-IV	INTERI	PROCESS CON	MMUNIC	CATION AN	D MES	SAGE QUE	UES	Class	es: 09	
Introduction to IPC, IPC between processes on a single computer system, IPC between processes on different systems, pies-creation, IPC between related processes using unnamed pipes, FIFOs: creation, IPC between unrelated processes using FIFOs(Named pipes), differences between unnamed and named pipes, popen and pclose library functions, Message Queues: Kernel support for messages, APIs for message queues, client/server example. Semaphores-Kernel support for semaphores, APIs for semaphores, file locking with semaphores.										

UNIT-V SHARED MEMORY AND SOCKETS

Shared Memory: Kernel support for shared memory, APIs for shared memory, shared memory example, Sockets: Introduction to Berkeley Sockets, IPC over a network, Client-Server model, Socket address structures (unix domain and Internet domain), Socket system calls for connection oriented protocol and connectionless protocol.

Text Books:

- 1. T. Chan, "Unix System Programming using C++", PHI, 2nd Edition, 2005.
- 2. Sumitabha Das, "Unix Concepts and Applications", 4th Edition, TMH, 2011.
- 3. W. R. Stevens, "Unix Network Programming", PHI, 2nd Edition, 1999.

Reference Books:

- 1. Mathew, R. Stones, Wrox, "Beginning Linux Programming", Wiley India Edition, 4th Edition, 2008.
- 2. Graham Glass, King Ables, "Unix for programmers and users", 3rd Edition, Pearson, 2006.
- 3. Hoover, "SystemProgramming with C and Unix", Pearson, 2nd Edition ,2009.
- 4. K. A. Robbins, "Unix System Programming, Communication, Concurrency and Threads", Pearson Education, 6th Edition, 2007.

Web References:

- 1. http://www.fuky.org/abicko/beginning-linux-programming.pdf
- 2. https://www.pdc.kth.se/about/links/linux-programming-for-beginners
- 3. http://www.tutorialspoint.com/unix/unix_tutorial.pdf
- 4. http://www.rpi.edu/dept/arc/training/shell/slides.pdf

- 1. http://onlinevideolecture.com/ebooks/?subject=Linux
- 2. http://www.onlineprogrammingbooks.com/linux-succinctly/
- 3. http://ebook-dl.com/item/beginning_linux_programming_4th_edition_neil_matthew_richard_stones/

RESEARCH METHODOLOGY

Open Elective II: (CAD / CAM) / SE / CSE / ES / PEED / AE / ST										
Course	Code	Category	Но	ırs / We	eek	Credits	M	aximu	m Marl	ks
DCS'	703	Floativo	L	Т	Р	С	CIA	SI	EE	Total
БСЗ	703	Elective	3	-	-	3	30	7	0	100
Contact C	lasses: 45	Tutorial Cla	sses: Nil	Prac	tical Cla	sses: Nil	Т	otal Cl	lasses: 4	15
OBJECTIVES: The course should enable the students to: I. Identify an appropriate research problem in their interesting domain. II. Organize and conduct research project. III. Prepare a research project thesis report. IV. Understand the law of patent and copyrights. V. Adequate knowledge on process for filing Patent.										
UNIT-I	INTRODUCTION Classes: 09									
Definition, features of g	tion, types of research, research approaches, research process, validity and reliability in research, es of good design, types of research design, and basic principles of experimental design.									
UNIT-II	MEASU	REMENT AND	SCALIN	G TEC	HNIQU	ES			Classes	s: 09
Errors in m techniques,	easurement time series	t, tests of sound analysis, interp	d measure polation an	ment, so d extrap	caling ar olation.	nd scale con	nstruction t	echniq	ues, for	recasting
UNIT-III	METHO	DS OF DATA	COLLEC	ΓΙΟΝ					Classes	s: 09
Primary data Professional in science, c	a, questionr l attitude an case studies	naire and intervi nd goals, concep	ews, colle	ction of lence, e	seconda thics in s	ry data, case science and	es and scheo engineerin	dules. g, som	ne famou	ıs frauds
UNIT-IV	INTERP	RETATION O	F DATA A	ND RE	EPORT V	WRITING			Classes	s: 09
Layout of a popular lect	a research p sures to sem	baper, technique	es of inter ence, parti	pretatio cipating	n, makir g in publi	ng scientific ic debates c	c presentati on scientific	on at o issues	conferer	nces and
UNIT-VINTRODUCTION TO INTELLECTUAL PROPERTYClasses: 09										
Introduction, types of intellectual property, international organizations, agencies and treaties, importance of intellectual property rights; Law of copy rights: Fundamental of copy right law, originality of material, rights of reproduction, rights to perform the work publicly, copy right ownership issues, copy right registration, notice of copy right, international copy right law; Law of patents: Foundation of patent law, patent searching process, ownership rights and transfer.										

Text Books:

- 1. C. R. Kothari, "Research Methodology: Methods and Techniques", New Age International Publishers, 2nd Edition, 2004.
- 2. P. Gupta, "Statistical Methods", Sultan Chand and Sons, New Delhi, 1st Edition, 2005.
- 3. Richard W. Stim, "Intellectual Property: Patents, Trademarks, and Copyrights", Cengage learning, 2nd Edition, 2001.

Reference Books:

- 1. P. Narayana Reddy, G. V. R. K. Acharyulu, "Research Methodology and Statistical Tools", Excel Books, New Delhi, 1st Edition, 2008.
- 2. Prabuddha Ganguli, "Intellectual Property Right, Unleashing the Knowledge Economy", Tata Mc Graw Hill Publishing Company Ltd, 1st Edition, 2001.

Web References:

- 1. http://nptel.ac.in/courses/109103024/40
- 2. http://study.com/academy/topic/introduction-to-research-methods.html
- 3. https://www.vutube.edu.pk/vu-lectures/viewcategory/240/research-methods-sta630

- 1. http://www.metastudio.org/Science%20and%20Ethics/file/readDoc/535a76367d9d331598f49e2d/34_Hb_o n_IPR.pdf
- 2. http://www.bits-pilani.ac.in/uploads/Patent_ManualOct_25th_07.pdf
- 3. http://euacademic.org/BookUpload/9.pdf

INDUSTRIAL AERODYNAMICS AND WIND ENERGY

OPEN ELECTIVE II : (CAD/CAM) / CSE / ES / SE / PEED									
Course	Code	Category	Ho	urs / We	eek	Credits	Maxi	num Ma	ırks
BAE	702	Elective	L	Т	Р	С	CIA	SEE	Total
DAL	102	Elective	3	-	-	3	30	70	100
Contact C	lasses: 45	Tutorial Classes: Ni	il	Pra	ctical Cla	sses: Nil	Total	Classes	: 45
 OBJECTIVES: The course should enable the students to: Understand the atmospheric boundary layer and conditions. Describe the wind energy and its application in turbines. III. Familiarize with non-aeronautical uses of aerodynamics such as road vehicle, building aerodynamics and problems of flow induced vibrations. 									
UNIT-I	UNIT-I ATMOSPHERIC WINDS AND ATMOSPHERIC BOUNDARY LAYER Classes: 03								ses: 08
Causes of mountain w effects of t models, role	Causes of wind thermal drive, Coriolis effect, pressure gradient effect, Geotropic winds; Land and sea breeze, mountain winds, thermals, cause of turbulence at ground level; Atmospheric boundary layer, velocity profile laws, effects of terrain on atmospheric boundary Layer; Wind tunnels basic features and components; Wind tunnel models, role of non-dimensional groups; Creation of atmospheric boundary layer type flow in a wind tunnel.								
UNIT-II	Y-II WINDENERGY Classes: 10								
Ship propul first examp axis wind t coefficient blade eleme vertical axis	lsion, sails, le of autom urbine: Eler for all wind ent theory, s wind turbin	lift and drag translators, mo atic feedback control for ya mentary actuator disc theor turbines; Working principle conventional horizontal ax ne, merits and demerits of h	odern ya aw in 1 ry, Betz e, power cis wind orizonta	chts; Ho l6 th cent coeffic r coeffic l turbino al axis w	prizontal aury Engl ient; Def eients, tip e, savoni- rind turbin	and vertical a ish windmill inition of po speed ratio e ous vertical nes and vertica	axis wind to s, classificatower coeffice explanation axis wind cal axis wind	urbines: 1 ation. Ho cient and by intro turbine, d turbine	History, rizontal torque ductory Darries es.
UNIT-III	VEHICLE	AERODYNAMICS						Class	ses: 10
Relative im automobiles attached tra angle; Rear	portance of s, notch from insverse vor end taper.	rolling resistance and aeroc at and notch rear wind screen tex, trailing vortex, trailin	lynamic ns versu g vorte:	es resista ls stream x drag,	nce, pow nlined sha effect of	er requireme ape, causes of floor height	nts and dra f vortex for on lift, eff	g coeffic mation an ects of c	ients of 1d drag, ut bank
Side panels and steering and tucks, c	Side panels and bottom, effects of chamfering of edges and cambering of roof and side panels; Racing cars: Traction and steering strip and use of aerofoils, high cornering seed; Commercial transport vehicles: Drag reduction on buses and tucks, driver cabin and trailer combinations.								Traction n buses
UNIT-IV	BUILDIN	GAERODYNAMICS						Class	es: 09
Use of light weight components in modern buildings, pressure distribution on low-rise buildings, wind forces on buildings-aerodynamics of flat plate and circular cylinder, critical Reynold's no, sub -, super- & ultra critical Reynold's No. Role of wind tunnel requirements in determining shape factors (Drag coefficients) of building/structure shapes such as circular cylinder (chimneys & towers), rectangle, I- shape, L-shape, H-shape etc. vortex shedding & transverse oscillating loads. Slenderness ratio & correction factor. Special problems of tall buildings, interference effect of building.									

UNIT-V FLOW INDUCED VIBATIONS

Classes: 08

Classification: Vortex induced vibration and flow induced instability such as galloping and stall flutter; Effects of Reynolds number on wake formation of bluff shapes; Vortex induced vibration: Experimental determination of strouhal numbers for different shapes such as circular cylinder, square, rectangle, L-shape ect, universal strouhal number, unsteady Bernoulli equation, concept of added mass, resonance; Fluid-structure interaction: Effect of transverse cylinder motion on flow and wake, lock-in vortex shedding near resonant frequency, experimental evidence of cylindrical motion influencing flow and thereby reducing strength of shed vortices; Methods of suppression of vortex induced vibration; Galloping & Stall flutter: Motion of one degree-of-freedom, quasi steady flow assumption, aerodynamic damping; Galloping: Force in the direction of plunging (transverse motion) and positive force coefficient, critical speed, galloping of transmission wire with winter ice, stall flutter of airfoils.

Text Books :

- 1. Siraj Ahmed, "Wind Energy theory and practice", PHI learning Pvt Ltd., 3rd Edition, 2015.
- 2. R. D. Blevins, "Flow Induced Vibrations", Van Nostard, 2nd Edition, 1990.
- 3. P. Sachs, "Wind Forces in Engineering", Pergamon press, 2nd Edition, 1988.
- 4. N. G. Calvert, "Wind Power Principles", Charles Griffin & co. London, 1st Edition, 1979.

Reference Books:

- 1. R. S. Scorer, "Environmental Aerodynamics", Ellis Harword Ltd, England, 1st Edition, 1978.
- 2. M. Sorvan, "Aerodynamics Drag Mechanisms of Bluff Bodies and Road vehicles", plenum press, 2nd Edition, 1978.

Web References:

- 1. http://www.mech.canterbury.ac.nz/research/fluid%20mechanics.shtml
- 2. http://www.journals.elsevier.com/journal-of-wind-engineering-and-industrial-aerodynamics

- 1. http://www.sciencedirect.com/science/journal/01676105
- 2. https://www.scribd.com/doc/42602999/Flow-Induced-Vibration-by-Robert-D-Blevins-2nd-Ed
- 3. http://store.elsevier.com/Wind-Forces-in-Engineering/Peter-Sachs/isbn-9781483148359/

VISION AND MISSION OF THE INSTITUTE

VISION

To bring forth professionally competent and socially sensitive engineers, capable of working across cultures meeting the global standards ethically.

MISSION

To provide students with an extensive and exceptional education that prepares them to excel in their profession, guided by dynamic intellectual community and be able to face the technically complex world with creative leadership qualities.

Further, be instrumental in emanating new knowledge through innovative research that emboldens entrepreneurship and economic development for the benefit of wide spread community.

M. Tech (CAD / CAM) - PROGRAM OUTCOMES (PO's)

Upon completion of M.Tech CAD / CAM, the students will be able to:

- PO1: Apply advanced level knowledge, techniques, skills and modern tools in the field of computer aided engineering to critically assess the emerging technological issues.
- PO2: Have abilities and capabilities in developing and applying computer software and hardware to mechanical design and manufacturing fields.
- PO3: Conduct experimental and/or analytical study and analyzing results with modern mathematical / scientific methods and use of software tools.
- PO4: Function on multidisciplinary environments by working cooperatively, creatively and responsibly as a member of a team.
- PO5: Write and present a substantial technical report / document.
- PO6: Independently carry out research / investigation and development work to solve practical problems
- PO7: Design and validate technological solutions to defined problems and recognize the need to engage in lifelong learning through continuing education.

OBJECTIVES OF THE DEPARTMENT

DEPARTMENT OF MECHANICAL ENGINEERING

Programme Educational Objectives (PEO's)

The students of M.Tech CAD / CAM are prepared to:

- **PEO I** Impart essential knowledge in the latest technological topics on computer aided engineering and to prepare them for taking up further research in the areas.
- **PEO II** Create congenial environment that promotes learning, growth and imparts ability to work with inter-disciplinary groups.
- **PEO III** Broaden and deepen their capabilities in analytical and experimental methods, analysis of data, and draw relevant conclusions for scholarly writing and presentation.

MALPRACTICES RULES

DISCIPLINARY ACTION FOR / IMPROPER CONDUCT IN EXAMINATIONS

S. No	Nature of Malpractices/Improper conduct	Punishment
	If the candidate:	
1. (a)	Possesses or keeps accessible in examination hall, any paper, note book, programmable calculators, cell phones, pager, palm computers or any other form of material concerned with or related to the subject of the examination (theory or practical) in which he is appearing but has not made use of (material shall include any marks on the body of the candidate which can be used as an aid in the subject of the examination)	Expulsion from the examination hall and cancellation of the performance in that subject only.
(b)	Gives assistance or guidance or receives it from any other candidate orally or by any other body language methods or communicates through cell phones with any candidate or persons in or outside the exam hall in respect of any matter.	Expulsion from the examination hall and cancellation of the performance in that subject only of all the candidates involved. In case of an outsider, he will be handed over to the police and a case is registered against him.
2.	Has copied in the examination hall from any paper, book, programmable calculators, palm computers or any other form of material relevant to the subject of the examination (theory or practical) in which the candidate is appearing.	Expulsion from the examination hall and cancellation of the performance in that subject and all other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted to appear for the remaining examinations of the subjects of that Semester/year. The Hall Ticket of the candidate is to be cancelled and sent to the Controller of Examinations.
3.	Impersonates any other candidate in connection with the examination.	The candidate who has impersonated shall be expelled from examination hall. The candidate is also debarred and forfeits the seat. The performance of the original candidate, who has been impersonated, shall be cancelled in all the subjects of the examination (including practicals and project work) alreadyappeared and shall not be allowed to appear for examinations of the remaining subjects of that semester/year. The candidate is also debarred for two consecutive semesters from class work and all semester end examinations. The continuation of the course by the candidate is subject to the academic regulations in connection with forfeiture of seat. If the imposter is an outsider, he will be handed over to the police and a case is registered against him.

4.	Smuggles in the Answer book or additional sheet or takes out or arranges to send out the question paper during the examination or answer book or additional sheet, during or after the examination.	Expulsion from the examination hall and cancellation of performance in that subject and all the other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year. The candidate is also debarred for two consecutive semesters from class work and all semester end examinations. The continuation of the course by the candidate is subject to the academic regulations in connection with forfeiture of seat.
5.	Uses objectionable, abusive or offensive language in the answer paper or in letters to the examiners or writes to the examiner requesting him to award pass marks.	Cancellation of the performance in that subject.
6.	Refuses to obey the orders of the Controller of Examinations /Additional Controller of Examinations/any officer on duty or misbehaves or creates disturbance of any kind in and around the examination hall or organizes a walk out or instigates others to walk out, or threatens the COE or any person on duty in or outside the examination hall of any injury to his person or to any of his relations whether by words, either spoken or written or by signs or by visible representation, assaults the COE or any person on duty in or outside the examination hall or any of his relations, or indulges in any other act of misconduct or mischief which result in damage to or destruction of property in the examination hall or any part of the Institute premises or engages in any other act which in the opinion of the officer on duty amounts to use of unfair means or misconduct or has the tendency to disrupt the orderly conduct of the examination.	In case of students of the college, they shall be expelled from examination halls and cancellation of their performance in that subject and all other subjects the candidate(s) has (have) already appeared and shall not be permitted to appear for the remaining examinations of the subjects of that semester/year. The candidates also are debarred and forfeit their seats. In case of outsiders, they will be handed over to the police and a police case is registered against them.
7.	Leaves the exam hall taking away answer script or intentionally tears of the script or any part thereof inside or outside the examination hall.	Expulsion from the examination hall and cancellation of performance in that subject and all the other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year. The candidate is also debarred for two consecutive semesters from class work and all semester end examinations. The continuation of the course by the candidate is subject to the academic regulations in connection with forfeiture of seat.
8.	Possess any lethal weapon or firearm in the	Expulsion from the examination hall and

	examination hall.	cancellation of the performance in that subject and all other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year. The candidate is also debarred and forfeits the seat.
9.	If student of the college, who is not a candidate for the particular examination or any person not connected with the college indulges in any malpractice or improper conduct mentioned in clause 6 to 8.	Student of the colleges expulsion from the examination hall and cancellation of the performance in that subject and all other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year. The candidate is also debarred and forfeits the seat. Person(s) who do not belong to the College will be handed over to police and, a police case will be registered against them.
10.	Comes in a drunken condition to the examination hall.	Expulsion from the examination hall and cancellation of the performance in that subject and all other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year.
11.	Copying detected on the basis of internal evidence, such as, during valuation or during special scrutiny.	Cancellation of the performance in that subject and all other subjects the candidate has appeared including practical examinations and project work of that semester/year examinations.
12.	If any malpractice is detected which is not covered in the above clauses 1 to 11 shall be reported to the University for further action to award suitable punishment.	

FREQUENTLY ASKED QUESTIONS AND ANSWERS ABOUT AUTONOMY

1. Who grants Autonomy? UGC, Govt., AICTE or University

In case of Colleges affiliated to a university and where statutes for grant of autonomy are ready, it is the respective University that finally grants autonomy but only after concurrence from the respective state Government as well as UGC. The State Government has its own powers to grant autonomy directly to Govt. and Govt. aided Colleges.

2. Shall IARE award its own Degrees?

No. Degree will be awarded by Jawaharlal Nehru Technological University, Hyderabad with a mention of the name IARE on the Degree Certificate.

3. What is the difference between a Deemed University and an Autonomy College?

A Deemed University is fully autonomous to the extent of awarding its own Degree. A Deemed University is usually a Non-Affiliating version of a University and has similar responsibilities like any University. An Autonomous College enjoys Academic Autonomy alone. The University to which an autonomous college is affiliated will have checks on the performance of the autonomous college.

4. How will the Foreign Universities or other stake – holders know that we are an Autonomous College?

Autonomous status, once declared, shall be accepted by all the stake holders. The Govt. of Telangana mentions autonomous status during the First Year admission procedure. Foreign Universities and Indian Industries will know our status through our website.

5. What is the change of Status for Students and Teachers if we become Autonomous?

An autonomous college carries a prestigious image. Autonomy is actually earned out of our continued past efforts on academic performances, our capability of self- governance and the kind of quality education we offer.

6. Who will check whether the academic standard is maintained / improved after Autonomy? How will it be checked?

There is a built in mechanism in the autonomous working for this purpose. An Internal Committee called Academic Programme Evaluation Committee, which will keep a watch on the academics and keep its reports and recommendations every year. In addition the highest academic council also supervises the academic matters. The standards of our question papers, the regularity of academic calendar, attendance of students, speed and transparency of result declaration and such other parameters are involved in this process.

7. Will the students of IARE as an Autonomous College qualify for University Medals and Prizes for academic excellence?

No. IARE has instituted its own awards, medals, etc. for the academic performance of the students. However for all other events like sports, cultural on co-curricular organized by the University the students shall qualify.

8. Can IARE have its own Convocation?

No. Since the University awards the Degree the Convocation will be that of the University, but there will be Graduation Day at IARE.

9. Can IARE give a provisional degree certificate?

Since the examinations are conducted by IARE and the results are also declared by IARE, the college

sends a list of successful candidates with their final Grades and Grade Point Averages including CGPA to the University. Therefore with the prior permission of the University the college will be entitled to give the provisional certificate.

10. Will Academic Autonomy make a positive impact on the Placements or Employability?

Certainly. The number of students qualifying for placement interviews is expected to improve, due to rigorous and repetitive classroom teaching and continuous assessment. Also the autonomous status is more responsive to the needs of the industry. As a result therefore, there will be a lot of scope for industry oriented skill development built-in into the system. The graduates from an autonomous college will therefore represent better employability.

11. What is the proportion of Internal and External Assessment as an Autonomous College? Presently, it is 70 % external and 30% internal. As the autonomy matures the internal assessment component shall be increased at the cost of external assessment.

12. Is it possible to have complete Internal Assessment for Theory or Practicals?

Yes indeed. We define our own system. We have the freedom to keep the proportion of external and internal assessment component to choose.

13. Why Credit based Grade System?

The credit based grade system is an accepted standard of academic performance the world over in all Universities. The acceptability of our graduates in the world market shall improve.

14. What exactly is a Credit based Grade System?

The credit based grade system defines a much better statistical way of judging the academic performance. One Lecture Hour per week of Teaching Learning process is assigned One Credit. One hour of laboratory work is assigned half credit. Letter Grades like A, B,C,D, etc. are assigned for a Range of Marks. (e.g. 91% and above is A+, 80 to 90% could be A etc.) in Absolute Grading System while grades are awarded by statistical analysis in relative grading system. We thus dispense with sharp numerical boundaries. Secondly, the grades are associated with defined Grade Points in the scale of 1 to 10. Weighted Average of Grade Points is also defined Grade Points are weighted by Credits and averaged over total credits in a Semester. This process is repeated for all Semesters and a CGPA defines the Final Academic Performance

15. What are the norms for the number of Credits per Semester and total number of Credits for UG/PG programme?

These norms are usually defined by UGC or AICTE. Usually around 25 Credits per semester is the accepted norm.

16. What is a Semester Grade Point Average (SGPA)?

The performance of a student in a semester is indicated by a number called SGPA. The SGPA is the weighted average of the grade points obtained in all the courses registered by the student during the semester.

$$SGPA = \sum_{i=1}^{n} (C_i G_i) / \sum_{i=1}^{n} C_i$$

Where, C_i is the number of credits of the *i*th course and G_i is the grade point scored by the student in the *i*th course and *i* represent the number of courses in which a student registered in the concerned semester. SGPA is rounded to two decimal places.

17. What is a Cumulative Grade Point Average (CGPA)?

An up-to-date assessment of overall performance of a student from the time of his first registration is obtained by calculating a number called CGPA, which is weighted average of the grade points obtained in all the courses registered by the students since he entered the Institute.

$$CGPA = \sum_{j=1}^{n} (C_i S_i) / \sum_{j=1}^{n} C_i$$

Where, S_i is the SGPA of the i^{th} semester and C_i is the total number of credits in that semester and j represent the number of courses in which a student's is registered upto the semester. CGPA is rounded to two decimal places.

18. Is there any Software available for calculating Grade point averages and converting the same into Grades?

Yes, The institute has its own MIS software for calculation of SGPA, CGPA, etc.

19. Will the teacher be required to do the job of calculating SGPAs etc. and convert the same into Grades?

No. The teacher has to give marks obtained out of whatever maximum marks as it is. Rest is all done by the computer.

20. Will there be any Revaluation or Re-Examination System?

No. There will double valuation of answer scripts. There will be a makeup Examination after a reasonable preparation time after the End Semester Examination for specific cases mentioned in the Rules and Regulations. In addition to this, there shall be a 'summer term' (compressed term) followed by the End Semester Exam, to save the precious time of students.

21. How fast Syllabi can be and should be changed?

Autonomy allows us the freedom to change the syllabi as often as we need.

22. Will the Degree be awarded on the basis of only final year performance?

No. The CGPA will reflect the average performance of all the semester taken together.

23. What are Statutory Academic Bodies?

Governing Body, Academic Council, Examination Committee and Board of Studies are the different statutory bodies. The participation of external members in everybody is compulsory. The institute has nominated professors from IIT, NIT, University (the officers of the rank of Pro-vice Chancellor, Deans and Controller of Examinations) and also the reputed industrialist and industry experts on these bodies.

24. Who takes Decisions on Academic matters?

The Governing Body of institute is the top academic body and is responsible for all the academic decisions. Many decisions are also taken at the lower level like Boards of Studies. Decisions taken at the Board of Studies level are to be ratified at the Academic Council and Governing Body.

25. What is the role of Examination committee?

The Examinations Committee is responsible for the smooth conduct of internal, End Semester and make up Examinations. All matters involving the conduct of examinations, spot valuations, tabulations and preparation of Grade Cards etc fall within the duties of the Examination Committee.

26. Is there any mechanism for Grievance Redressal?

The institute has grievance redressal committee, headed by Dean - Student affairs and Dean - IQAC.

27. How many attempts are permitted for obtaining a Degree? All such matters are defined in Rules & Regulation

28. Who declares the result?

The result declaration process is also defined. After tabulation work wherein the SGPA, CGPA and final Grades are ready, the entire result is reviewed by the Moderation Committee. Any unusual deviations or gross level discrepancies are deliberated and removed. The entire result is discussed in the Examinations and Result Committee for its approval. The result is then declared on the institute notice boards as well put on the web site and Students Corner. It is eventually sent to the University.

29. Who will keep the Student Academic Records, University or IARE?

It is the responsibility of the Dean, Academics of the Autonomous College to keep and preserve all the records.

30. What is our relationship with the JNT University?

We remain an affiliated college of the JNT University. The University has the right to nominate its members on the academic bodies of the college.

31. Shall we require University approval if we want to start any New Courses?

Yes, It is expected that approvals or such other matters from an autonomous college will receive priority.

32. Shall we get autonomy for PG and Doctoral Programmes also?

Yes, presently our PG programs also enjoying autonomous status.



INSTITUTE OF AERONAUTICAL ENGINEERING

(Autonomous)

Dundigal, Hyderabad - 500 043

UNDERTAKING BY S TUDENT / PARENT

"To make the students attend the classes regularly from the first day of starting of classes and be aware of the College regulations, the following Undertaking Form is introduced which should be signed by both student and parent. The same should be submitted to the Dean, Academic".

I, Mr./Ms.______joining I Semester for the academic year 2016-2017 in Institute of Aeronautical Engineering, Hyderabad, do hereby undertake and abide by the following terms, and I will bring the ACKNOW LEDGEMENT duly signed by me and my parent and submit it to the Dean, Academic.

- 1. I will attend all the classes as per the timetable from the starting day of the semester specified in the institute Academic Calendar. In case, I do not turn up even after two weeks of starting of classes, I shall be ineligible to continue for the current academic year.
- 2. I will be regular and punctual to all the classes (theory/practical/drawing) and secure attendance of not less than 80% in every course as stipulated by Institute. I am fully aware that an attendance of less than 70% in more than three courses will make me lose one year.
- 3. I will compulsorily follow the dress code prescribed by the college.
- 4. I will conduct myself in a highly disciplined and decent manner both inside the classroom and on campus, failing which suitable action may be taken against me as per the rules and regulations of the institute.
- 5. I will concentrate on my studies without wasting time in the Campus/Hostel/Residence and attend all the tests to secure more than the minimum prescribed Class/Sessional Marks in each course. I will submit the assignments given in time to improve my performance.
- 6. I will not use Mobile Phone in the institute premises and also, I will not involve in any form of ragging inside or outside the campus. I am fully aware that using mobile phone to the institute premises is not permissible and involving in Ragging is an offence and punishable as per JNTUH/UGC rules and the law.
- 7. I declare that I shall not indulge in ragging, eve-teasing, smoking, consuming alcohol drug abuse or any other anti-social activity in the college premises, hostel, on educational tours, industrial visits or elsewhere.
- 8. I will pay tuition fees, examination fees and any other dues within the stipulated time as required by the Institution / authorities, failing which I will not be permitted to attend the classes.
- 9. I will not cause or involve in any sort of violence or disturbance both within and outside the college campus.
- 10. If I absent myself continuously for 3 days, my parents will have to meet the HOD concerned/ Principal.
- 11. I hereby acknowledge that I have received a copy of IARE R16 Academic Rules and Regulations, Syllabus copy and hence, I shall abide by all the rules specified in it.

ACKNOWLEDGEMENT

I have carefully gone through the terms of the undertaking mentioned above and I understand that following these are for my/his/her own benefit and improvement. I also understand that if I/he/she fail to comply with these terms, shall be liable for suitable action as per Institute/JNTUH/AICTE/UGC rules and the la w. I undertake that I/he/she will strictly follow the above terms.

Signature of Student with Date

Signature of Parent with Date Name & Address with Phone Number